

10/585699

Connecting via Winsock to STN

Welcome to STN International! Enter x:x

LOGINID:sssptaul56cxh

PASSWORD:

TERMINAL (ENTER 1, 2, 3, OR ?):2

***** Welcome to STN International *****

NEWS	1		Web Page for STN Seminar Schedule - N. America
NEWS	2	NOV 21	CAS patent coverage to include exemplified prophetic substances identified in English-, French-, German-, and Japanese-language basic patents from 2004-present
NEWS	3	NOV 26	MARPAT enhanced with FSORT command
NEWS	4	NOV 26	CHEMSAFE now available on STN Easy
NEWS	5	NOV 26	Two new SET commands increase convenience of STN searching
NEWS	6	DEC 01	ChemPort single article sales feature unavailable
NEWS	7	DEC 12	GBFULL now offers single source for full-text coverage of complete UK patent families
NEWS	8	DEC 17	Fifty-one pharmaceutical ingredients added to PS
NEWS	9	JAN 06	The retention policy for unread STNmail messages will change in 2009 for STN-Columbus and STN-Tokyo
NEWS	10	JAN 07	WPIDS, WPINDEX, and WPIX enhanced Japanese Patent Classification Data
NEWS	11	FEB 02	Simultaneous left and right truncation (SLART) added for CERAB, COMPUAB, ELCOM, and SOLIDSTATE
NEWS	12	FEB 02	GENBANK enhanced with SET PLURALS and SET SPELLING
NEWS	13	FEB 06	Patent sequence location (PSL) data added to USGENE
NEWS	14	FEB 10	COMPENDEX reloaded and enhanced
NEWS EXPRESS JUNE 27 08 CURRENT WINDOWS VERSION IS V8.3, AND CURRENT DISCOVER FILE IS DATED 23 JUNE 2008.			
NEWS HOURS	STN Operating Hours Plus Help Desk Availability		
NEWS LOGIN	Welcome Banner and News Items		
NEWS IPC8	For general information regarding STN implementation of IPC 8		

Enter NEWS followed by the item number or name to see news on that specific topic.

All use of STN is subject to the provisions of the STN Customer agreement. Please note that this agreement limits use to scientific research. Use for software development or design or implementation of commercial gateways or other similar uses is prohibited and may result in loss of user privileges and other penalties.

***** STN Columbus *****

10/585699

FILE 'HOME' ENTERED AT 14:53:05 ON 10 FEB 2009

=> file caplus		
COST IN U.S. DOLLARS	SINCE FILE	TOTAL
	ENTRY	SESSION
FULL ESTIMATED COST	0.22	0.22

FILE 'CAPLUS' ENTERED AT 14:53:17 ON 10 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 AMERICAN CHEMICAL SOCIETY (ACS)

Copyright of the articles to which records in this database refer is held by the publishers listed in the PUBLISHER (PB) field (available for records published or updated in Chemical Abstracts after December 26, 1996), unless otherwise indicated in the original publications. The CA Lexicon is the copyrighted intellectual property of the American Chemical Society and is provided to assist you in searching databases on STN. Any dissemination, distribution, copying, or storing of this information, without the prior written consent of CAS, is strictly prohibited.

FILE COVERS 1907 - 10 Feb 2009 VOL 150 ISS 7
FILE LAST UPDATED: 9 Feb 2009 (20090209/ED)

Caplus now includes complete International Patent Classification (IPC) reclassification data for the third quarter of 2008.

CAS Information Use Policies apply and are available at:

<http://www.cas.org/legal/infopolicy.html>

This file contains CAS Registry Numbers for easy and accurate substance identification.

=> s us20080286688/pn
L1 1 US20080286688/PN

=> d all

L1 ANSWER 1 OF 1 CAPLUS COPYRIGHT 2009 ACS on STN
AN 2005:697110 CAPLUS
DN 143:163099
ED Entered STN: 05 Aug 2005
TI Photosensitive resin composition with excellent photosensitivity and cured
product thereof
IN Koyanagi, Hiroo; Tanaka, Ryutaro; Kametani, Hideaki
PA Nippon Kayaku Kabushiki Kaisha, Japan
SO PCT Int. Appl., 29 pp.
CODEN: PIXXD2
DT Patent
LA Japanese

10/585699

IC ICM G03F007-027
 CC 74-5 (Radiation Chemistry, Photochemistry, and Photographic and Other
 Reprographic Processes)
 Section cross-reference(s): 76

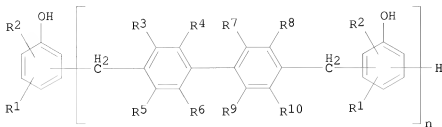
FAN.CNT 1

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	WO 2005071489	A1	20050804	WO 2005-JP761	20050121
	W: AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NA, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, YU, ZA, ZM, ZW				
	RW: BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW, AM, AZ, BY, KG, KZ, MD, RU, TJ, TM, AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IS, IT, LT, LU, MC, NL, PL, PT, RO, SE, SI, SK, TR, BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG				
	CA 2552905	A1	20050804	CA 2005-2552905	20050121
	EP 1710626	A1	20061011	EP 2005-703982	20050121
	R: CH, DE, ES, GB, IT, LI				
	CN 1910519	A	20070207	CN 2005-80003090	20050121
	KR 2007001130	A	20070103	KR 2006-716273	20060811
	US 20080286688	A1	20081120	US 2006-585699	20060824
<--					
PRAI	JP 2004-16751	A	20040126		
	WO 2005-JP761	W	20050121		

CLASS

PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
WO 2005071489	ICM	G03F007-027
	IPCI	G03F0007-027 [ICM,7]
	IPCR	G03F0007-027 [I,C*]; G03F0007-027 [I,A]; G03F0007-038 [I,C*]; G03F0007-038 [I,A]
	ECLA	G03F007/027; G03F007/038
CA 2552905	IPCI	G03F0007-027 [I,A]
	IPCR	G03F0007-027 [I,C]; G03F0007-027 [I,A]; G03F0007-038 [I,C*]; G03F0007-038 [I,A]
	ECLA	G03F007/027; G03F007/038
EP 1710626	IPCI	G03F0007-027 [ICM,7]
	IPCR	G03F0007-027 [I,C]; G03F0007-027 [I,A]; G03F0007-038 [I,C*]; G03F0007-038 [I,A]
	ECLA	G03F007/027; G03F007/038
CN 1910519	IPCI	G03F0007-027 [I,A]
	IPCR	G03F0007-027 [I,C]; G03F0007-027 [I,A]; G03F0007-038 [I,C*]; G03F0007-038 [I,A]
	ECLA	G03F007/027; G03F007/038
KR 2007001130	IPCI	G03F0007-027 [I,A]; G03F0007-004 [I,A]
US 20080286688	IPCI	G03F0007-004 [I,A]
	NCL	430/285.100; 430/286.100

GI



I

AB Disclosed is a photosensitive resin composition with excellent photosensitivity whose cured product is excellent in adhesiveness, pencil hardness, solvent resistance, acid resistance, heat resistance, gold plating resistance, HAST (highly accelerated temperature and humidity stress test) properties, flame retardance, flexibility and the like. Also disclosed is such a cured product. A photosensitive resin composition is characterized by comprising a reaction product (A) of a compound (a) represented by the formula I ($n = 1-20$; R1, R2 = H, halo, C1-4-alkyl; R3, R5, R8, R10 = H, halo, methyl; R4, R6, R7, R9 = H, methyl), a compound (b) having an ethylenically unsatd. group and a glycidyl group in a mol. and a polybasic acid anhydride (c), a crosslinking agent (B) and a photopolymn. initiator (C). Also disclosed is a cured product of such a photosensitive resin composition

ST photosensitive resin compn solder resist printed circuit board fabrication

IT Solder resists
(photoresists; photosensitive resin composition with excellent photosensitivity and cured product thereof)

IT Printed circuit boards
(photosensitive resin composition with excellent photosensitivity and cured product thereof)

IT Photoresists
(solder; photosensitive resin composition with excellent photosensitivity and cured product thereof)

IT 93294-97-4, DPCA 60
RL: RCT (Reactant); RACT (Reactant or reagent)
(crosslinking agent in photosensitive resin composition with excellent photosensitivity suitable for printed circuit board fabrication)

IT 71868-10-5, Irgacure 907 82799-44-8, DETX S
RL: CAT (Catalyst use); USES (Uses)
(photopolymn. initiator in photosensitive resin composition with excellent

10/585699

photosensitivity suitable for printed circuit board fabrication)
IT 860022-07-7P 860022-08-8P 860022-09-9P
RL: SPN (Synthetic preparation); TEM (Technical or engineered material
use); PREP (Preparation); USES (Uses)
(photosensitive resin composition with excellent photosensitivity
suitable

for printed circuit board fabrication)
RE.CNT 6 THERE ARE 6 CITED REFERENCES AVAILABLE FOR THIS RECORD
RE

- (1) Nippon Kayaku Co Ltd; JP 200382067 A 2003
- (2) Nippon Kayaku Co Ltd; JP 200382067 A 2003
- (3) Showa Highpolymer Co Ltd; JP 2002128865 A 2002 CAPLUS
- (4) Showa Highpolymer Co Ltd; JP 2002128865 A 2002 CAPLUS
- (5) Showa Highpolymer Co Ltd; JP 2002308957 A 2002 CAPLUS
- (6) Showa Highpolymer Co Ltd; JP 2002308957 A 2002 CAPLUS

=> FIL REGISTRY

COST IN U.S. DOLLARS	SINCE FILE	TOTAL
	ENTRY	SESSION
FULL ESTIMATED COST	6.12	6.34
DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)	SINCE FILE	TOTAL
	ENTRY	SESSION
CA SUBSCRIBER PRICE	-0.82	-0.82

FILE 'REGISTRY' ENTERED AT 14:53:53 ON 10 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 American Chemical Society (ACS)

Property values tagged with IC are from the ZIC/VINITI data file
provided by InfoChem.

STRUCTURE FILE UPDATES: 8 FEB 2009 HIGHEST RN 1102960-71-3
DICTIONARY FILE UPDATES: 8 FEB 2009 HIGHEST RN 1102960-71-3

New CAS Information Use Policies, enter HELP USAGETERMS for details.

TSCA INFORMATION NOW CURRENT THROUGH July 5, 2008.

Please note that search-term pricing does apply when
conducting SmartSELECT searches.

REGISTRY includes numerically searchable data for experimental and
predicted properties as well as tags indicating availability of
experimental property data in the original document. For information
on property searching in REGISTRY, refer to:

<http://www.cas.org/support/stngen/stdnoc/properties.html>

=> S 93294-97-4/RN

L2 1 93294-97-4/RN

10/585699

=> SET NOTICE 1 DISPLAY

NOTICE SET TO 1 U.S. DOLLAR FOR DISPLAY COMMAND
SET COMMAND COMPLETED

=> D L2 SQIDE 1-

YOU HAVE REQUESTED DATA FROM 1 ANSWERS - CONTINUE? Y/(N):y
THE ESTIMATED COST FOR THIS REQUEST IS 6.85 U.S. DOLLARS
DO YOU WANT TO CONTINUE WITH THIS REQUEST? (Y)/N:y

L2 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 93294-97-4 REGISTRY
CN Hexanoic acid, 6-[(1-oxo-2-propen-1-yl)oxy]-,

1,1'-[2-[(3-[(1-oxo-6-[(1-oxo-2-propen-1-yl)oxy]hexyl)oxy]-2,2-bis[[[1-oxo-6-[(1-oxo-2-propen-1-yl)oxy]hexyl)oxy]methyl]propoxy]methyl]-2-[[[1-oxo-6-[(1-oxo-2-propen-1-yl)oxy]hexyl)oxy]methyl]-1,3-propanediyl] ester (CA INDEX NAME)

OTHER CA INDEX NAMES:

CN Hexanoic acid, 6-[(1-oxo-2-propenyl)oxy]-,
2-[(3-[(1-oxo-6-[(1-oxo-2-propenyl)oxy]hexyl)oxy]-2,2-bis[[[1-oxo-6-[(1-oxo-2-propenyl)oxy]hexyl)oxy]methyl]propoxy]methyl]-2-[[[1-oxo-6-[(1-oxo-2-propenyl)oxy]hexyl)oxy]methyl]-1,3-propanediyl ester (9CI)

OTHER NAMES:

CN DPCA 60
CN Kayarad DPCA 60
DR 99241-43-7
MF C64 H94 O25
CI COM
LC STN Files: CA, CAPLUS, TOXCENTER, USPAT2, USPATFULL

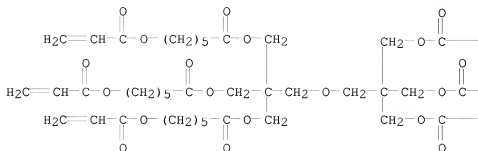
DT.CA Caplus document type: Journal; Patent

RL.P Roles from patents: BIOL (Biological study); PREP (Preparation); PROC (Process); PRP (Properties); RACT (Reactant or reagent); USES (Uses)

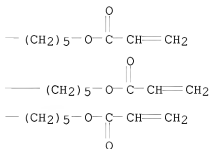
RLD.P Roles for non-specific derivatives from patents: BIOL (Biological study); PREP (Preparation); PROC (Process); PRP (Properties); USES (Uses)

RL.NP Roles from non-patents: BIOL (Biological study); PROC (Process); PRP (Properties); RACT (Reactant or reagent); USES (Uses)

PAGE 1-A



PAGE 1-B



PROPERTY DATA AVAILABLE IN THE 'PROP' FORMAT

128 REFERENCES IN FILE CA (1907 TO DATE)
 12 REFERENCES TO NON-SPECIFIC DERIVATIVES IN FILE CA
 128 REFERENCES IN FILE CAPLUS (1907 TO DATE)

=> SET NOTICE LOGIN DISPLAY

NOTICE SET TO OFF FOR DISPLAY COMMAND
 SET COMMAND COMPLETED

=>

=> FIL REGISTRY

COST IN U.S. DOLLARS	SINCE FILE ENTRY	TOTAL SESSION
FULL ESTIMATED COST	2.53	8.87
DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)	SINCE FILE ENTRY	TOTAL SESSION
CA SUBSCRIBER PRICE	0.00	-0.82

10/585699

FILE 'REGISTRY' ENTERED AT 14:54:20 ON 10 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 American Chemical Society (ACS)

Property values tagged with IC are from the ZIC/VINITI data file
provided by InfoChem.

STRUCTURE FILE UPDATES: 8 FEB 2009 HIGHEST RN 1102960-71-3
DICTIONARY FILE UPDATES: 8 FEB 2009 HIGHEST RN 1102960-71-3

New CAS Information Use Policies, enter HELP USAGETERMS for details.

TSCA INFORMATION NOW CURRENT THROUGH July 5, 2008.

Please note that search-term pricing does apply when
conducting SmartSELECT searches.

REGISTRY includes numerically searchable data for experimental and
predicted properties as well as tags indicating availability of
experimental property data in the original document. For information
on property searching in REGISTRY, refer to:

<http://www.cas.org/support/stngen/stdoc/properties.html>

=> S 860022-07-7/RN

L3 1 860022-07-7/RN

=> SET NOTICE 1 DISPLAY

NOTICE SET TO 1 U.S. DOLLAR FOR DISPLAY COMMAND
SET COMMAND COMPLETED

=> D L3 SQIDE 1-

YOU HAVE REQUESTED DATA FROM 1 ANSWERS - CONTINUE? Y/(N):y
THE ESTIMATED COST FOR THIS REQUEST IS 6.85 U.S. DOLLARS
DO YOU WANT TO CONTINUE WITH THIS REQUEST? (Y)/N:y

L3 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 860022-07-7 REGISTRY
CN 2-Propenoic acid, 4-(oxiranylmethoxy)butyl ester, polymer with MEH 7851SS
(9CI) (CA INDEX NAME)
MF (C10 H16 O4 . Unspecified)x
CI PMS
PCT Manual component, Polyacrylic, Polyether
SR CA
LC STN Files: CA, CAPLUS, USPATFULL
DT.CA Caplus document type: Patent
RL.P Roles from patents: PREP (Preparation); USES (Uses)

CM 1

CRN 363137-30-8

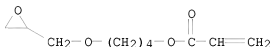
10/585699

CMF Unspecified
CCI PMS, MAN

*** STRUCTURE DIAGRAM IS NOT AVAILABLE ***

CM 2

CRN 119692-59-0
CMF C10 H16 O4



1 REFERENCES IN FILE CA (1907 TO DATE)
1 REFERENCES IN FILE CAPLUS (1907 TO DATE)

=> SET NOTICE LOGIN DISPLAY

NOTICE SET TO OFF FOR DISPLAY COMMAND
SET COMMAND COMPLETED

=>

=> FIL REGISTRY

COST IN U.S. DOLLARS	SINCE FILE	TOTAL
	ENTRY	SESSION
FULL ESTIMATED COST	2.53	11.40
DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)	SINCE FILE	TOTAL
	ENTRY	SESSION
CA SUBSCRIBER PRICE	0.00	-0.82

FILE 'REGISTRY' ENTERED AT 14:54:45 ON 10 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 American Chemical Society (ACS)

Property values tagged with IC are from the ZIC/VINITI data file
provided by InfoChem.

STRUCTURE FILE UPDATES: 8 FEB 2009 HIGHEST RN 1102960-71-3
DICTIONARY FILE UPDATES: 8 FEB 2009 HIGHEST RN 1102960-71-3

New CAS Information Use Policies, enter HELP USAGETERMS for details.

TSCA INFORMATION NOW CURRENT THROUGH July 5, 2008.

Please note that search-term pricing does apply when
conducting SmartSELECT searches.

10/585699

REGISTRY includes numerically searchable data for experimental and predicted properties as well as tags indicating availability of experimental property data in the original document. For information on property searching in REGISTRY, refer to:

<http://www.cas.org/support/stngen/stdoc/properties.html>

=> S 860022-08-8/RN

L4 1 860022-08-8/RN

=> SET NOTICE 1 DISPLAY

NOTICE SET TO 1 U.S. DOLLAR FOR DISPLAY COMMAND
SET COMMAND COMPLETED

=> D L4 SQIDE 1-

YOU HAVE REQUESTED DATA FROM 1 ANSWERS - CONTINUE? Y/(N):y
THE ESTIMATED COST FOR THIS REQUEST IS 6.85 U.S. DOLLARS
DO YOU WANT TO CONTINUE WITH THIS REQUEST? (Y)/N:y

L4 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 860022-08-8 REGISTRY
CN 2-Propenoic acid, 4-(oxiranylmethoxy)butyl ester, polymer with MEH
7851-3H and 3a,4,7,7a-tetrahydro-1,3-isobenzofurandione (9CI) (CA INDEX NAME)
MF (C10 H16 O4 . C8 H8 O3 . Unspecified)x
CI PMS
PCT Manual component, Polyacrylic, Polyester, Polyester formed, Polyother
SR CA
LC STN Files: CA, CAPLUS, USPATFULL
DI.CA Caplus document type: Patent
RL.P Roles from patents: PREP (Preparation); USES (Uses)

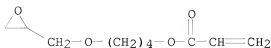
CM 1

CRN 477290-92-9
CMF Unspecified
CCI PMS, MAN

*** STRUCTURE DIAGRAM IS NOT AVAILABLE ***

CM 2

CRN 119692-59-0
CMF C10 H16 O4

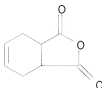


10/585699

CM 3

CRN 85-43-8

CMF C8 H8 O3



1 REFERENCES IN FILE CA (1907 TO DATE)
1 REFERENCES IN FILE CAPLUS (1907 TO DATE)

=> SET NOTICE LOGIN DISPLAY

NOTICE SET TO OFF FOR DISPLAY COMMAND
SET COMMAND COMPLETED

=>

=> FIL REGISTRY

COST IN U.S. DOLLARS	SINCE FILE ENTRY	TOTAL SESSION
FULL ESTIMATED COST	2.53	13.93
DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)	SINCE FILE ENTRY	TOTAL SESSION
CA SUBSCRIBER PRICE	0.00	-0.82

FILE 'REGISTRY' ENTERED AT 14:55:06 ON 10 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 American Chemical Society (ACS)

Property values tagged with IC are from the ZIC/VINITI data file
provided by InfoChem.

STRUCTURE FILE UPDATES: 8 FEB 2009 HIGHEST RN 1102960-71-3
DICTIONARY FILE UPDATES: 8 FEB 2009 HIGHEST RN 1102960-71-3

New CAS Information Use Policies, enter HELP USAGETERMS for details.

TSCA INFORMATION NOW CURRENT THROUGH July 5, 2008.

Please note that search-term pricing does apply when
conducting SmartSELECT searches.

REGISTRY includes numerically searchable data for experimental and
predicted properties as well as tags indicating availability of

10/585699

experimental property data in the original document. For information on property searching in REGISTRY, refer to:

<http://www.cas.org/support/stngen/stndoc/properties.html>

=> S 860022-09-9/RN

L5 1 860022-09-9/RN

=> SET NOTICE 1 DISPLAY

NOTICE SET TO 1 U.S. DOLLAR FOR DISPLAY COMMAND
SET COMMAND COMPLETED

=> D L5 SQIDE 1-

YOU HAVE REQUESTED DATA FROM 1 ANSWERS - CONTINUE? Y/(N):y
THE ESTIMATED COST FOR THIS REQUEST IS 6.85 U.S. DOLLARS
DO YOU WANT TO CONTINUE WITH THIS REQUEST? (Y)/N:y

L5 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 860022-09-9 REGISTRY
CN 2-Propenoic acid, 4-(oxiranylmethoxy)butyl ester, polymer with
dihydro-2,5-furandione and MEH 7851-3H (9CI) (CA INDEX NAME)
MF (C10 H16 O4 . C4 H4 O3 . Unspecified)x
CI PMS
PCT Manual component, Polyacrylic, Polyester, Polyester formed, Polyether
SR CA
LC STN Files: CA, CAPLUS, USPATFULL
DT.CA CAplus document type: Patent
RL.P Roles from patents: PREP (Preparation); USES (Uses)

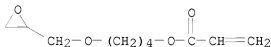
CM 1

CRN 477290-92-9
CMF Unspecified
CCI PMS, MAN

*** STRUCTURE DIAGRAM IS NOT AVAILABLE ***

CM 2

CRN 119692-59-0
CMF C10 H16 O4



CM 3

CRN 108-30-5

10/585699

CMF C4 H4 O3



1 REFERENCES IN FILE CA (1907 TO DATE)
1 REFERENCES IN FILE CAPLUS (1907 TO DATE)

=> SET NOTICE LOGIN DISPLAY

NOTICE SET TO OFF FOR DISPLAY COMMAND
SET COMMAND COMPLETED

=>

=> s 477290-92-9
L6 1 477290-92-9
(477290-92-9/RN)

=> d

L6 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 477290-92-9 REGISTRY
ED Entered STN: 20 Dec 2002
CN MEH 7851-3H (CA INDEX NAME)
ENTE A biphenyl aralkyl resin (Meiwa Kasei Co.)
MF Unspecified
CI PMS, COM, MAN
PCT Manual registration
SR CA
LC STN Files: CA, CAPLUS, USPAT2, USPATFULL

*** STRUCTURE DIAGRAM IS NOT AVAILABLE ***
10 REFERENCES IN FILE CA (1907 TO DATE)
2 REFERENCES TO NON-SPECIFIC DERIVATIVES IN FILE CA
10 REFERENCES IN FILE CAPLUS (1907 TO DATE)

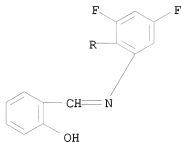
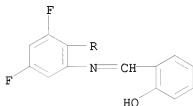
=> s phenol and biphenylene
454879 PHENOL
4849 BIPHENYLENE
L7 78 PHENOL AND BIPHENYLENE

=> d 78

L7 ANSWER 78 OF 78 REGISTRY COPYRIGHT 2009 ACS on STN
RN 340-34-1 REGISTRY
ED Entered STN: 16 Nov 1984
CN Phenol, 2,2'-[(4,4',6,6'-tetrafluoro[1,1'-biphenyl]-2,2'-
diyl)bis(nitrimethylidyne)]bis- (9CI) (CA INDEX NAME)
OTHER CA INDEX NAMES:

10/585699

CN o-Cresol, α,α' -[(4,4',6,6'-tetrafluoro-2,2'-
biphenylene)dinitrilo]di- (8CI)
MF C26 H16 F4 N2 O2
LC STN Files: BEILSTEIN*, CA, CAPLUS
(*File contains numerically searchable property data)



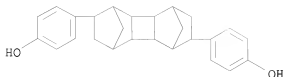
PROPERTY DATA AVAILABLE IN THE 'PROP' FORMAT

1 REFERENCES IN FILE CA (1907 TO DATE)
1 REFERENCES IN FILE CAPLUS (1907 TO DATE)

=> d 70

L7 ANSWER 70 OF 78 REGISTRY COPYRIGHT 2009 ACS on STN
RN 17605-23-1 REGISTRY
ED Entered STN: 16 Nov 1984
CN Phenol, 4,4'-(decahydro-1,4:5,8-dimethanobiphenylene-2,6-diyl) bis-
(9CI) (CA INDEX NAME)
OTHER CA INDEX NAMES:
CN 1,4:5,8-Dimethanobiphenylene, phenol deriv.
MF C26 H28 O2

10/585699



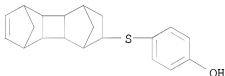
PROPERTY DATA AVAILABLE IN THE 'PROP' FORMAT

$$\Rightarrow d \mid 60$$

```

L7 ANSWER 60 OF 78 REGISTRY COPYRIGHT 2009 ACS on STN
RD 80324-73-8 REGISTRY
EN Entered STN: 16 Nov 1984
CN Phenol, 4-[(1,2,3,4,4a,4b,5,8,8a,8b-decahydro-1,4:5,8-
dimethanobiphenylen-2-yl)thio]- (9CI) (CA INDEX NAME)
OTHER CA INDEX NAMES:
CN 1,4:5,8-Dimethanobiphenylene, phenol deriv.
MF C20 H22 O S
LC STN Files: CA, CAPLUS, USPATFULL

```



PROPERTY DATA AVAILABLE IN THE 'PROP' FORMAT

1 REFERENCES IN FILE CA (1907 TO DATE)
1 REFERENCES IN FILE CAPLUS (1907 TO DATE)

```
=> file caplus\
'CAPLUS\' IS NOT A VALID FILE NAME
SESSION CONTINUES IN FILE 'REGISTRY'
Enter "HELP FILE NAMES" at an arrow prompt (=>) for a list of files
that are available. If you have requested multiple files, you can
specify a corrected file name or you can enter "IGNORE" to continue
accessing the remaining file names entered.
```

> file caplus		
COST IN U.S. DOLLARS	SINCE FILE	TOTAL
	ENTRY	SESSION
FULL ESTIMATED COST	22.39	36.32
DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)	SINCE FILE	TOTAL
	ENTRY	SESSION

10/585699

CA SUBSCRIBER PRICE

0.00

-0.82

FILE 'CAPLUS' ENTERED AT 14:56:45 ON 10 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 AMERICAN CHEMICAL SOCIETY (ACS)

Copyright of the articles to which records in this database refer is held by the publishers listed in the PUBLISHER (PB) field (available for records published or updated in Chemical Abstracts after December 26, 1996), unless otherwise indicated in the original publications. The CA Lexicon is the copyrighted intellectual property of the American Chemical Society and is provided to assist you in searching databases on STN. Any dissemination, distribution, copying, or storing of this information, without the prior written consent of CAS, is strictly prohibited.

FILE COVERS 1907 - 10 Feb 2009 VOL 150 ISS 7
FILE LAST UPDATED: 9 Feb 2009 (20090209/ED)

Caplus now includes complete International Patent Classification (IPC) reclassification data for the third quarter of 2008.

CAS Information Use Policies apply and are available at:

<http://www.cas.org/legal/infopolicy.html>

This file contains CAS Registry Numbers for easy and accurate substance identification.

=> s phenol and biphenylene
269742 PHENOL
4232 BIPHENYLENE
L8 522 PHENOL AND BIPHENYLENE

=> s l8 and glycidyl?
54626 GLYCIDYL?
L9 127 L8 AND GLYCIDYL?

=> s l9 and photo?
1639917 PHOTO?
L10 2 L9 AND PHOTO?

=> d all 1-2

L10 ANSWER 1 OF 2 CAPLUS COPYRIGHT 2009 ACS on STN
AN 2007:1442764 CAPLUS
DN 148:66148
ED Entered STN: 20 Dec 2007
TI Photosensitive polymer compositions with high sensitivity and good thermal stability
IN Oshimi, Katsuhiko; Tanaka, Ryutaro; Nakanishi, Masataka; Kurihashi, Toru
PA Nippon Kayaku Co., Ltd., Japan
SO Jpn. Kokai Tokkyo Koho, 23pp.

10/585699

CODEN: JKXXAF
 DT Patent
 LA Japanese
 CC 74-5 (Radiation Chemistry, Photochemistry, and Photographic and Other Reprographic Processes)
 Section cross-reference(s): 76

FAN.CNT 1

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	JP 2007328028	A	2007/1220	JP 2006-157443	20060606
PRAI	JP 2006-157443		20060606		

CLASS

PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
JP 2007328028	IPCI	G03F0007-004 [I,A]
	IPCR	G03F0007-004 [I,C]; G03F0007-004 [I,A]
	FTERM	2H025/AA04; 2H025/AA06; 2H025/AA07; 2H025/AA10; 2H025/AA11; 2H025/AA14; 2H025/AA20; 2H025/AB11; 2H025/AB15; 2H025/AC01; 2H025/AD01; 2H025/BC14; 2H025/BC43; 2H025/BC74; 2H025/BC85; 2H025/CA00; 2H025/CC17; 2H025/EA08; 2H025/FA17; 2H025/FA29; 2H025/FA43

AB The comps., especially useful for printed circuit boards, contain (A) aqueous alkali solution-soluble polymers, (B) crosslinkers, (C) photopolymn. initiators, and (D) crystalline epoxy resins of C6H4-m(OGly)Rm[CH2-p-C6H4-p-C6H4CH2C6H4-m(OGly)Rm]nH (n = 1.0-2.0; R = H, Cl-4 alkyl, Ph; k = 1-4; Gly = glycidyl) as curing agents. The crystalline epoxy resins may show softening point or m.p. 75-180°. The aqueous alkali solution-soluble polymers may be prepared by reacting comps. having

ST ≥2 epoxy groups with monocarboxylic acids having ethylenic unsatn., then with polybasic acid anhydrides.

ST cryst epoxy photosensitive polymer compn high sensitivity; chloromethylbiphenyl phenol polymer epichlorohydrin ether thermal stability; biphenylene epoxy acrylate tetrahydrophthalic anhydride polymer neg photoresist

IT Epoxy resins, preparation
 RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)
 (acrylates; crystalline epoxy curing agent-containing photoresist comps. with high sensitivity and good thermal stability)

IT Negative photoresists
 Printed circuit boards
 (crystalline epoxy curing agent-containing photoresist comps. with high sensitivity and good thermal stability)

IT 29570-58-9, DPHA 93294-97-4, DPCA 60
 RL: TEM (Technical or engineered material use); USES (Uses)
 (crosslinker; crystalline epoxy curing agent-containing photoresist comps. with high sensitivity and good thermal stability)

IT 959857-96-6P
 RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)
 (crystalline epoxy curing agent-containing photoresist comps. with high sensitivity and good thermal stability)

10/585699

IT 208254-04-ODP, reaction product with epichlorohydrin 872507-70-5DP,
reaction product with epichlorohydrin
RL: IMF (Industrial manufacture); TEM (Technical or engineered material
use); PREP (Preparation); USES (Uses)
(curing agent; crystalline epoxy curing agent-containing photoresist
comps. with high sensitivity and good thermal stability)
IT 71868-10-5, Irgacure 907 82799-44-8, DETX-S
RL: CAT (Catalyst use); USES (Uses)
(photopolymn. initiator; crystalline epoxy curing agent-containing
photoresist comps. with high sensitivity and good thermal
stability)

L10 ANSWER 2 OF 2 CAPLUS COPYRIGHT 2009 ACS on STN
AN 2003:532372 CAPLUS
DN 139:101552
ED Entered STN: 11 Jul 2003
TI Bifunctional phenylene ether oligomer, its derivatives, prepreg and
lamine use, and production
IN Amagai, Akikazu; Ishii, Kenzi; Hiramatsu, Kiyonari; Miyamoto, Makoto;
Ohno, Daisuke; Yamazaki, Katsutoshi; Norisue, Yasumasa
PA Mitsubishi Gas Chemical Company, Inc., Japan
SO U.S. Pat. Appl. Publ., 34 pp.
CODEN: USXXCO
DT Patent
LA English
IC ICM C08C019-00
INCL 525370000
CC 35-7 (Chemistry of Synthetic High Polymers)
FAN.CNT 4

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	US 20030130438	A1	20030710	US 2002-180507	20020627
	US 6794481	B2	20040921		
	JP 2003012796	A	20030115	JP 2001-196569	20010628
	JP 2003155340	A	20030527	JP 2001-353194	20011119
	JP 3874089	B2	20070131		
	JP 2003183350	A	20030703	JP 2001-387968	20011220
	JP 3900258	B2	20070404		
	JP 2003206333	A	20030722	JP 2002-6211	20020115
	JP 3962901	B2	20070822		
	JP 2003238655	A	20030827	JP 2002-38432	20020215
	JP 3959615	B2	20070815		
	JP 2003252983	A	20030910	JP 2002-53653	20020228
	JP 3879832	B2	20070214		
	JP 2003261743	A	20030919	JP 2002-65735	20020311
	US 20040214004	A1	20041028	US 2004-851290	20040524
	US 6962744	B2	20051108		
	US 20050186430	A1	20050825	US 2005-110917	20050421
	US 7247682	B2	20070724		
	US 20070265423	A1	20071115	US 2007-812892	20070622
	US 7388057	B2	20080617		
	US 20080154006	A1	20080626	US 2008-68925	20080213
	US 7446154	B2	20081104		
PRAI	JP 2001-196569	A	20010628		
	JP 2001-353194	A	20011119		

JP 2001-387968	A	20011220
JP 2002-6211	A	20020115
JP 2002-38432	A	20020215
JP 2002-53653	A	20020228
JP 2002-65735	A	20020311
US 2002-180507	A3	20020627
US 2004-851290	A3	20040524
US 2005-110917	A3	20050421
US 2007-812892	A3	20070622

CLASS

PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
US 20030130438	ICM	C08C019-00
	INCL	525370000
	IPCI	C08C0019-00 [ICM,7]
	IPCR	C08G0065-00 [I,C*]; C08G0065-44 [I,A]; C08G0065-48 [I,A]; H05K0001-03 [N,C*]; H05K0001-03 [N,A]; C08G0065-38 [I,A]
	NCL	525/370.000; 528/219.000; 428/297.400; 525/481.000; 525/504.000; 525/508.000; 525/523.000; 525/533.000; 525/534.000; 528/087.000; 528/102.000; 528/205.000
	ECLA	C08G065/44; C08G065/48B; T05K
JP 2003012796	IPCI	C08G0065-44 [ICM,7]; C08G0065-00 [ICM,7,C*]; C07C0041-50 [ICS,7]; C07C0041-00 [ICS,7,C*]; C07C0043-295 [ICS,7]; C07C0043-00 [ICS,7,C*]
	IPCR	C07C0041-00 [I,C*]; C07C0041-50 [I,A]; C07C0043-00 [I,C*]; C07C0043-295 [I,A]; C08G0065-00 [I,C*]; C08G0065-44 [I,A]
JP 2003155340	IPCI	C08G0065-48 [I,A]; C08G0065-00 [I,C*]
	IPCR	C08G0065-00 [I,C*]; C08G0065-48 [I,A]
JP 2003183350	IPCI	C08G0059-17 [I,A]; C08G0059-00 [I,C*]; C07C0069-54 [I,A]; C07C0069-00 [I,C*]; C08F0299-02 [I,A]; C08F0299-00 [I,C*]
	IPCR	C07C0069-00 [I,C*]; C07C0069-54 [I,A]; C08F0299-00 [I,C*]; C08F0299-02 [I,A]; C08G0059-00 [I,C*]; C08G0059-17 [I,A]
JP 2003206333	IPCI	C08G0059-22 [I,A]; C08G0059-00 [I,C*]; H01L0023-29 [I,A]; H01L0023-31 [I,A]; H01L0023-28 [I,C*]
	IPCR	C08G0059-00 [I,C*]; C08G0059-22 [I,A]; H01L0023-28 [I,C*]; H01L0023-29 [I,A]; H01L0023-31 [I,A]
JP 2003238655	IPCI	C08G0059-24 [I,A]; C08G0059-00 [I,C*]; C08J0005-24 [I,A]; C08L0063-00 [I,A]; C08L0079-00 [I,A]; H05K0001-03 [I,A]
	IPCR	C08J0005-24 [I,C*]; C08J0005-24 [I,A]; C08G0059-00 [I,C*]; C08G0059-24 [I,A]; C08L0063-00 [I,C*]; C08L0063-00 [I,A]; C08L0079-00 [I,C*]; C08L0079-00 [I,A]; H05K0001-03 [I,C*]; H05K0001-03 [I,A]
JP 2003252983	IPCI	C08G0065-48 [I,A]; C08G0065-00 [I,C*]; C08F0220-30 [I,A]; C08F0220-00 [I,C*]; C08F0290-06 [I,A]; C08F0290-00 [I,C*]
	IPCR	C08G0065-00 [I,C*]; C08G0065-48 [I,A]; C08F0220-00 [I,C*]; C08F0220-30 [I,A]; C08F0290-00 [I,C*]; C08F0290-06 [I,A]
JP 2003261743	IPCI	C08L0063-00 [ICM,7]; B32B0015-08 [ICS,7]; C08J0005-24 [ICS,7]; C08L0079-00 [ICS,7]; H05K0001-03 [ICS,7]

	IPCR	C08J0005-24 [I,C*]; C08J0005-24 [I,A]; B32B0015-08 [I,C*]; B32B0015-08 [I,A]; C08L0063-00 [I,C*]; C08L0063-00 [I,A]; C08L0079-00 [I,C*]; C08L0079-00 [I,A]; H05K0001-03 [I,C*]; H05K0001-03 [I,A]
US 20040214004	IPCI	B32B0027-38 [ICM,7]; C08G0065-38 [ICS,7]; C08G0065-48 [ICS,7]; C08G0065-00 [ICS,7,C*]; C08L0063-00 [ICS,7]; B32B0017-04 [ICS,7]
	IPCR	C08G0065-00 [I,C*]; C08G0065-44 [I,A]; C08G0065-48 [I,A]; H05K0001-03 [N,C*]; H05K0001-03 [N,A]
	NCL	428/413.000; 428/297.400; 525/481.000; 525/504.000; 525/508.000; 525/523.000; 525/533.000; 525/534.000; 528/062.000; 528/087.000; 528/205.000; 528/219.000
	ECLA	C08G065/44; C08G065/48B; T05K
US 20050186430	IPCI	B32B0027-04 [I,A]; B32B0027-38 [I,A]; C08G0065-48 [I,A]; C08G0065-00 [I,C*]; C08L0063-00 [I,A]; C08L0071-12 [I,A]; C08L0071-00 [I,C*]
	IPCR	C08G0065-00 [I,C*]; C08G0065-44 [I,A]; C08G0065-48 [I,A]; H05K0001-03 [N,C*]; H05K0001-03 [N,A]; B32B0027-04 [I,C]; B32B0027-04 [I,A]; B32B0027-38 [I,C]; B32B0027-38 [I,A]; C08L0063-00 [I,C]; C08L0063-00 [I,A]; C08L0071-00 [I,C]; C08L0071-12 [I,A]
	NCL	428/413.000; 528/104.000; 525/396.000; 174/255.000; 428/297.400; 525/390.000; 525/391.000; 528/219.000
	ECLA	C08G065/44; C08G065/48B; T05K
US 20070265423	IPCI	C08G0063-66 [I,A]; C08G0063-00 [I,C*]; C07C0069-52 [I,A]; C07C0069-62 [I,A]; C07C0069-00 [I,C*]; C08G0065-44 [I,A]; C08G0065-48 [I,A]; C08G0065-00 [I,C*]; C08L0071-12 [I,A]; C08L0071-00 [I,C*]
	IPCR	C08G0063-00 [I,C]; C08G0063-66 [I,A]; C07C0069-00 [I,C]; C07C0069-52 [I,A]; C07C0069-62 [I,A]; C08G0065-00 [I,C]; C08G0065-44 [I,A]; C08G0065-48 [I,A]; C08L0071-00 [I,C]; C08L0071-12 [I,A]
	NCL	528/361.000; 560/219.000; 560/220.000; 525/391.000; 525/390.000; 525/396.000
US 20080154006	IPCI	C08F0020-06 [I,A]; C08F0020-00 [I,C*]; C07D0303-12 [I,A]; C07D0303-00 [I,C*]; C08G0065-44 [I,A]; C08G0065-48 [I,A]; C08G0065-00 [I,C*]; C08L0071-12 [I,A]; C08L0071-00 [I,C*]
	NCL	526/317.100; 549/561.000
AB	A bifunctional phenylene ether oligomer H(OY)a(OX)(YO)bH is obtained by oxidation polymerization of bivalent phenol HOXOH and a monovalent phenol YOY, where X is (substituted) biphenylene, and Y is (substituted) Ph. The 2,6-dimethylphenol-2,2',3,3',5,5'-hexamethyl[1,1'-biphenyl]-4,4'-diol copolymer was end group modified with cyanogen chloride, allyl bromide, or epichlorohydrin followed by acrylic acid, the latter cured acrylate product having a glass transition temperature	
	198°, dielec. constant (1 GHz) 2.74, and loss tangent (1 GHz) 0.018.	
ST	phenylene ether oligomer precursor epoxy acrylate thermoset prepreg laminate	
IT	Laminated materials (copper-clad; phenylene ether oligomer precursor for epoxy acrylate thermosets and photocurable resins with thermal resistance, low dielec. constant, and loss tangent)	

- IT Polyoxyphenylenes
 RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)
 (epoxy, acrylates; phenylene ether oligomer precursor for epoxy acrylate thermosets and photocurable resins with thermal resistance, low dielec. constant, and loss tangent)
- IT Polymerization
 (oxidative; of (substituted) biphenylene diol and (substituted) phenol)
- IT Sealing compositions
 (phenylene ether oligomer precursor for epoxy acrylate thermosets and photocurable resins with thermal resistance, low dielec. constant, and loss tangent)
- IT Epoxy resins, preparation
 RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)
 (polyoxyphenylene-, acrylates; phenylene ether oligomer precursor for epoxy acrylate thermosets and photocurable resins with thermal resistance, low dielec. constant, and loss tangent)
- IT Reinforced plastics
 RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)
 (prepregs; phenylene ether oligomer precursor for epoxy acrylate thermosets and photocurable resins with thermal resistance, low dielec. constant, and loss tangent)
- IT 139615-22-8, Kayahard NHN
 RL: POF (Polymer in formulation); TEM (Technical or engineered material use); USES (Uses)
 (Kayahard NHN; blend with phenylene ether oligomer precursor for epoxy acrylate thermosets and photocurable resins with thermal resistance, low dielec. constant, and loss tangent)
- IT 26834-02-6, Milex 225-3L
 RL: POF (Polymer in formulation); TEM (Technical or engineered material use); USES (Uses)
 (Milex 225-3L; blend with phenylene ether oligomer precursor for epoxy acrylate thermosets and photocurable resins with thermal resistance, low dielec. constant, and loss tangent)
- IT 25722-66-1, 2,2-Bis(4-cyanatophenyl)propane polymer 33294-14-3, Epiclone 153 96231-83-3, Sumiepoxy ESCN 195XL 171759-10-7, YX400H
 RL: POF (Polymer in formulation); TEM (Technical or engineered material use); USES (Uses)
 (blend with phenylene ether oligomer precursor for epoxy acrylate thermosets and photocurable resins with thermal resistance, low dielec. constant, and loss tangent)
- IT 101-77-9, 4,4'-Diaminodiphenylmethane
 RL: TEM (Technical or engineered material use); USES (Uses)
 (crosslinker; blend with phenylene ether oligomer precursor for epoxy acrylate thermosets and photocurable resins with thermal resistance, low dielec. constant, and loss tangent)
- IT 106-89-8DP, Epichlorohydrin, reaction products with phenylene ether oligomer 506-77-4DP, Cyanogen chloride, reaction products with phenylene ether oligomer 4286-55-9DP, 6-Bromo-1-hexanol, reaction products with phenylene ether oligomer 560077-74-9DP, 2,6-Dimethylphenol-2,2',3,3',5,5'-hexamethyl[1,1'-biphenyl]-4,4'-diol

copolymer, allyl ether 560077-74-9DP, allyl ether, homopolymer
 560077-74-9DP, glycidyl ethers 561002-51-5P, Ethylene
 oxide-2,6-dimethylphenol-2,2',3,3',5,5'-hexamethyl[1,1'-biphenyl]-4,4'-
 diol copolymer acrylate homopolymer 561002-53-7P,
 2,6-Dimethylphenol-2,2',3,3',5,5'-hexamethyl[1,1'-biphenyl]-4,4'-diol-
 propylene oxide copolymer acrylate homopolymer
 RL: IMF (Industrial manufacture); PREP (Preparation)
 (phenylene ether oligomer precursor for epoxy acrylate thermosets and
 photocurable resins with thermal resistance, low dielec.
 constant, and loss tangent)

IT 560077-74-9P,
 2,6-Dimethylphenol-2,2',3,3',5,5'-hexamethyl[1,1'-biphenyl]-
 4,4'-diol copolymer 560077-77-2P 560077-82-9P 560077-85-2P
 561002-47-9P, Ethylene oxide-2,6-dimethylphenol-2,2',3,3',5,5'-
 hexamethyl[1,1'-biphenyl]-4,4'-diol copolymer acrylate 561002-49-1P,
 2,6-Dimethylphenol-2,2',3,3',5,5'-hexamethyl[1,1'-biphenyl]-4,4'-diol-
 propylene oxide copolymer acrylate
 RL: IMF (Industrial manufacture); RCT (Reactant); PREP (Preparation);

RACT
 (Reactant or reagent)
 (phenylene ether oligomer precursor for epoxy acrylate thermosets and
 photocurable resins with thermal resistance, low dielec.
 constant, and loss tangent)

IT 79-10-7DP, Acrylic acid, reaction products with phenylene ether oligomer
 glycidyl ethers 85-43-8DP, Tetrahydrophthalic acid anhydride,
 reaction products with epoxy acrylates
 RL: IMF (Industrial manufacture); TEM (Technical or engineered material
 use); PREP (Preparation); USES (Uses)
 (phenylene ether oligomer precursor for epoxy acrylate thermosets and
 photocurable resins with thermal resistance, low dielec.
 constant, and loss tangent)

RE.CNT 3 THERE ARE 3 CITED REFERENCES AVAILABLE FOR THIS RECORD

RE
 (1) Anon; EP 921158 A2 1999 CAPLUS
 (2) Ishii; US 6689920 B2 2004 CAPLUS
 (3) Pfaender; US 5270435 A 1993 CAPLUS

=> d his

(FILE 'HOME' ENTERED AT 14:53:05 ON 10 FEB 2009)

FILE 'CAPLUS' ENTERED AT 14:53:17 ON 10 FEB 2009

L1 1 S US20080286688/PN

FILE 'REGISTRY' ENTERED AT 14:53:53 ON 10 FEB 2009

L2 1 S 93294-97-4/RN
 SET NOTICE 1 DISPLAY
 SET NOTICE LOGIN DISPLAY

FILE 'REGISTRY' ENTERED AT 14:54:20 ON 10 FEB 2009

L3 1 S 860022-07-7/RN
 SET NOTICE 1 DISPLAY
 SET NOTICE LOGIN DISPLAY

10/585699

coverage of complete UK patent families
NEWS 8 DEC 17 Fifty-one pharmaceutical ingredients added to PS
NEWS 9 JAN 06 The retention policy for unread STNmail messages
will change in 2009 for STN-Columbus and STN-Tokyo
NEWS 10 JAN 07 WPIDS, WPINDEX, and WPIX enhanced Japanese Patent
Classification Data
NEWS 11 FEB 02 Simultaneous left and right truncation (SLART) added
for CERAB, COMPUAB, ELCOM, and SOLIDSTATE
NEWS 12 FEB 02 GENBANK enhanced with SET PLURALS and SET SPELLING
NEWS 13 FEB 06 Patent sequence location (PSL) data added to USGENE
NEWS 14 FEB 10 COMPENDEX reloaded and enhanced

NEWS EXPRESS JUNE 27 08 CURRENT WINDOWS VERSION IS V8.3,
AND CURRENT DISCOVER FILE IS DATED 23 JUNE 2008.

NEWS HOURS STN Operating Hours Plus Help Desk Availability
NEWS LOGIN Welcome Banner and News Items
NEWS IPC8 For general information regarding STN implementation of IPC 8

Enter NEWS followed by the item number or name to see news on that
specific topic.

All use of STN is subject to the provisions of the STN Customer
agreement. Please note that this agreement limits use to scientific
research. Use for software development or design or implementation
of commercial gateways or other similar uses is prohibited and may
result in loss of user privileges and other penalties.

* * * * * STN Columbus * * * * *

FILE 'HOME' ENTERED AT 15:07:06 ON 10 FEB 2009

=> file caplus
COST IN U.S. DOLLARS

	SINCE FILE	TOTAL
	ENTRY	SESSION
FULL ESTIMATED COST	0.22	0.22

FILE 'CAPLUS' ENTERED AT 15:07:23 ON 10 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 AMERICAN CHEMICAL SOCIETY (ACS)

Copyright of the articles to which records in this database refer is
held by the publishers listed in the PUBLISHER (PB) field (available
for records published or updated in Chemical Abstracts after December
26, 1996), unless otherwise indicated in the original publications.
The CA Lexicon is the copyrighted intellectual property of the
American Chemical Society and is provided to assist you in searching
databases on STN. Any dissemination, distribution, copying, or storing
of this information, without the prior written consent of CAS, is
strictly prohibited.

FILE COVERS 1907 - 10 Feb 2009 VOL 150 ISS 7
FILE LAST UPDATED: 9 Feb 2009 (20090209/ED)

10/585699

Caplus now includes complete International Patent Classification (IPC) reclassification data for the third quarter of 2008.

CAS Information Use Policies apply and are available at:

<http://www.cas.org/legal/infopolicy.html>

This file contains CAS Registry Numbers for easy and accurate substance identification.

=> s us3042655/pn

L1 1 US3042655/PN

=> d all

L1 ANSWER 1 OF 1 CAPLUS COPYRIGHT 2009 ACS on STN

AN 1962:469722 CAPLUS

DN 57:69722

OREF 57:13916b-d

ED Entered STN: 22 Apr 2001

TI Novolak

IN Massengale, John T.; Bender, Frederick C.

PA American Viscose Corp.

SO 4 pp.

DT Patent

LA Unavailable

CC 43 (Organic Coatings, Inks, and Related Products)

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
US 3042655		19620703	US 1960-4009	19600122

<--

CLASS

PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
US 3042655	IPCR	C08G0008-00 [I,C*]; C08G0008-00 [I,A]
	NCL	525/503.000; 525/508.000; 528/137.000; 528/140.000; 528/141.000; 528/143.000; 528/144.000; 528/145.000; 528/212.000; 528/217.000

AB A novolak which differs from the conventional Bakelite type has the formula I in which n is 4-10. The substance is made by treating phenol dissolved in an organic solvent with 4,4'-bis(chloromethyl)biphenyl dissolved in the same solvent in the presence of a metal halide catalyst, preferably ZnCl₂. HCl is evolved; after washing with H₂O and distilling the solvent, the novolak is obtained as a residue. For a molding or coating, thermosetting resin, the novolak (in powder form) is mixed with an aldehyde in an organic solvent, and a curing agent solution is slowly added. On heat-drying of the reaction mixture, a solid, brittle resin is obtained. This resin is suitable for molding; fillers, a molding catalyst, and a lubricant may be

10/585699

added. The molded thermoset products compare favorably with a Bakelite phenol-HCHO resin with respect to resistance to chemical attack.

IT Coating(s)
(from phenol condensation products, with
4,4'-bis(chloromethyl)biphenyl, chemical- and heat-resistant)

IT Phenol condensation products
(novolaks, with α,α' -dichloro-p,p'-bitolyl and chemical-and
heat-resistant molded products therefrom)

IT 1667-10-3, p,p'-Bitolyl, α,α' -dichloro-
(reaction product with phenol)

=> FIL REGISTRY

COST IN U.S. DOLLARS	SINCE FILE ENTRY	TOTAL SESSION
FULL ESTIMATED COST	6.12	6.34
DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)	SINCE FILE ENTRY	TOTAL SESSION
CA SUBSCRIBER PRICE	-0.82	-0.82

FILE 'REGISTRY' ENTERED AT 15:07:53 ON 10 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 American Chemical Society (ACS)

Property values tagged with IC are from the ZIC/VINITI data file
provided by InfoChem.

STRUCTURE FILE UPDATES: 8 FEB 2009 HIGHEST RN 1102960-71-3
DICTIONARY FILE UPDATES: 8 FEB 2009 HIGHEST RN 1102960-71-3

New CAS Information Use Policies, enter HELP USAGETERMS for details.

TSCA INFORMATION NOW CURRENT THROUGH July 5, 2008.

Please note that search-term pricing does apply when
conducting SmartSELECT searches.

REGISTRY includes numerically searchable data for experimental and
predicted properties as well as tags indicating availability of
experimental property data in the original document. For information
on property searching in REGISTRY, refer to:

<http://www.cas.org/support/stngen/stndoc/properties.html>

=> S 1667-10-3/RN

L2 1 1667-10-3/RN

=> SET NOTICE 1 DISPLAY

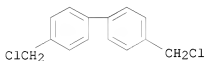
NOTICE SET TO 1 U.S. DOLLAR FOR DISPLAY COMMAND
SET COMMAND COMPLETED

10/585699

=> D L2 SQIDE 1-

YOU HAVE REQUESTED DATA FROM 1 ANSWERS - CONTINUE? Y/(N):y
THE ESTIMATED COST FOR THIS REQUEST IS 6.85 U.S. DOLLARS
DO YOU WANT TO CONTINUE WITH THIS REQUEST? (Y)/N:y

L2 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 1667-10-3 REGISTRY
CN 1,1'-Biphenyl, 4,4'-bis(chloromethyl)- (CA INDEX NAME)
OTHER CA INDEX NAMES:
CN p,p'-Bitolyl, a,a'-dichloro- (6CI, 7CI, 8CI)
OTHER NAMES:
CN 4,4'-Bis(chloromethyl)-1,1'-biphenyl
CN 4,4'-Bis(chloromethyl)biphenyl
CN 4,4'-Bis(chloromethyl)diphenyl
CN NSC 74077
CN p,p'-Bis(chloromethyl)biphenyl
MF C14 H12 Cl2
CI COM
LC STN Files: BEILSTEIN*, CA, CAPLUS, CASREACT, CHEMCATS, CHEMINFORMRX,
CHEMLIST, CSCHEM, IFICDB, IFIPAT, IFIUDB, TOXCENTER, USPAT2, USPATFULL,
USPATOLD
(*File contains numerically searchable property data)
Other Sources: EINECS**
(*Enter CHEMLIST File for up-to-date regulatory information)
DT.CA Caplus document type: Journal; Patent; Report
RL.P Roles from patents: PREP (Preparation); PRP (Properties); RACT
(Reactant or reagent); USES (Uses); NORL (No role in record)
RLD.P Roles for non-specific derivatives from patents: PREP (Preparation);
PRP (Properties); USES (Uses)
RL.NP Roles from non-patents: ANST (Analytical study); PREP (Preparation);
PROC (Process); PRP (Properties); RACT (Reactant or reagent); USES
(Uses); NORL (No role in record)
RLD.NP Roles for non-specific derivatives from non-patents: PREP
(Preparation); PRP (Properties); USES (Uses)



PROPERTY DATA AVAILABLE IN THE 'PROP' FORMAT

228 REFERENCES IN FILE CA (1907 TO DATE)
5 REFERENCES TO NON-SPECIFIC DERIVATIVES IN FILE CA
230 REFERENCES IN FILE CAPLUS (1907 TO DATE)

=> SET NOTICE LOGIN DISPLAY

10/585699

NOTICE SET TO OFF FOR DISPLAY COMMAND
SET COMMAND COMPLETED

=>

=> file caplus

COST IN U.S. DOLLARS

SINCE FILE	TOTAL
ENTRY	SESSION

FULL ESTIMATED COST

2.53	8.87
------	------

DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)

SINCE FILE	TOTAL
ENTRY	SESSION

CA SUBSCRIBER PRICE

0.00	-0.82
------	-------

FILE 'CAPLUS' ENTERED AT 15:08:34 ON 10 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 AMERICAN CHEMICAL SOCIETY (ACS)

Copyright of the articles to which records in this database refer is held by the publishers listed in the PUBLISHER (PB) field (available for records published or updated in Chemical Abstracts after December 26, 1996), unless otherwise indicated in the original publications. The CA Lexicon is the copyrighted intellectual property of the American Chemical Society and is provided to assist you in searching databases on STN. Any dissemination, distribution, copying, or storing of this information, without the prior written consent of CAS, is strictly prohibited.

FILE COVERS 1907 - 10 Feb 2009 VOL 150 ISS 7
FILE LAST UPDATED: 9 Feb 2009 (20090209/ED)

Caplus now includes complete International Patent Classification (IPC) reclassification data for the third quarter of 2008.

CAS Information Use Policies apply and are available at:

<http://www.cas.org/legal/infopolicy.html>

This file contains CAS Registry Numbers for easy and accurate substance identification.

=> s l2 and phenol

230 L2

269742 PHENOL

L3

13 L2 AND PHENOL

=> d all 1-13

L3 ANSWER 1 OF 13 CAPLUS COPYRIGHT 2009 ACS on STN

AN 2008:1012787 CAPLUS

DN 149:289372

ED Entered STN: 22 Aug 2008

TI High refractive index monomers and transparent polymer compositions for production of optical materials
 IN Craciun, Liliana; Polishchuk, Orest; Schriver, George William; Hainz, Rudiger
 PA USA
 SO U.S. Pat. Appl. Publ., 32pp.
 CODEN: USXXCO
 DT Patent
 LA English
 INCL 522166000; 525451000
 CC 37-2 (Plastics Manufacture and Processing)
 Section cross-reference(s): 73

FAN.CNT 1

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	US 20080200582	A1	20080821	US 2008-70183	20080214
	WO 2008101806	A2	20080828	WO 2008-EP51438	20080206
	W:				
	AE, AG, AL, AM, AO, AT, AU, AZ, BA, BB, BG, BH, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DO, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, GT, HN, HR, HU, ID, IL, IN, IS, JP, KE, KG, KM, KN, KP, KR, KZ, LA, LC, LK, LR, LS, LT, LU, LY, MA, MD, ME, MG, MK, MN, MW, MX, MY, MZ, NA, NG, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RS, RU, SC, SD, SE, SG, SK, SL, SM, SV, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, ZA, ZM, ZW				
	RW:				
	AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HR, HU, IE, IS, IT, LT, LU, LV, MC, MT, NL, NO, PL, PT, RO, SE, SI, SK, TR, BF, BJ, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG, BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW, AM, AZ, BY, KG, KZ, MD, RU, TJ, TM				
PRAI	US 2007-902530P	P	20070220		
	US 2007-997942P	P	20071005		

CLASS

PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
US 20080200582	INCL	522166000; 525451000
	IPCI	C08J0003-28 [I,A]; C08G0063-688 [I,A]; C08G0063-00 [I,C*]
	NCL	522/166.000; 525/451.000
WO 2008101806	IPCI	C07D0333-18 [I,A]; C07D0333-00 [I,C*]; C07C0321-20 [I,A]; C07C0321-28 [I,A]; C07C0321-30 [I,A]; C07C0321-00 [I,C*]

AB The invention relates to novel sulfur-containing (meth)acrylic monomers and

comps. thereof characterized by high refractive index and useful for optical and industrial applications. The invention also relates to a method for preparing high refractive index polymeric materials and more specifically to a method for formation of UV cast optical lenses and comps. thereof comprising the sulfur-containing (meth)acrylic monomers. Thus, a composition comprising 4-(methylthio)benzyl methacrylate (2.0 g), 2-hydroxyethyl methacrylate (0.62 g), zirconium isopropoxide (70% in isopropanol, 0.55 g), and Irgacure 651 (35 mg) was cast and UV cured to give clear hard plastic parts.

ST sulfur functional arom acrylate monomer transparent polymer optical material

IT Polyoxoalkylenes, reactions

RL: RCT (Reactant); RACT (Reactant or reagent)
(acrylate-terminated; high refractive index monomers and transparent polymer comps. for production of optical materials)

IT Monomers
RL: IMF (Industrial manufacture); RCT (Reactant); PREP (Preparation); RACT (Reactant or reagent)
(acrylic, aromatic and sulfur-containing; high refractive index monomers and transparent polymer comps. for production of optical materials)

IT Analytical apparatus
Eyeglass lenses
Eyeglasses
Lenses
Medical goods
Optical ROM disks
Optical films
Optical imaging devices
Optical materials
Safety devices
(high refractive index monomers and transparent polymer comps. for production of)

IT Organic glass
RL: TEM (Technical or engineered material use); USES (Uses)
(high refractive index monomers and transparent polymer comps. for production of)

IT Molding of plastics and rubbers
Nanoparticles
Plastic films
Transparent materials
(high refractive index monomers and transparent polymer comps. for production of optical materials)

IT Molded plastics, uses
RL: TEM (Technical or engineered material use); USES (Uses)
(high refractive index monomers and transparent polymer comps. for production of optical materials)

IT Crosslinking
(photochem.; high refractive index monomers and transparent polymer comps. for production of optical materials)

IT Polymerization
(photopolymn.; high refractive index monomers and transparent polymer comps. for production of optical materials)

IT 1048374-08-8P
RL: IMF (Industrial manufacture); POF (Polymer in formulation); PRPH (Prophetic); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)
(high refractive index monomers and transparent polymer comps. for production of optical materials)

IT 104609-62-3P 392229-82-2P 1048374-10-2P 1048374-13-5P
1048374-16-8P 1048374-18-0P
RL: IMF (Industrial manufacture); PRP (Properties); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)
(high refractive index monomers and transparent polymer comps. for production of optical materials)

IT 765-50-4P, 2-Chloromethylthiophene

RL: BYP (Byproduct); IMF (Industrial manufacture); PREP (Preparation)
(in preparation of monomers; high refractive index monomers and transparent
polymer compns. for production of optical materials)

IT 1568-80-5P 6178-58-1P, 2-Phenyl-2-(phenylthio)ethanol 7321-13-3P
13222-17-8P 28569-48-4P, 2,5-Bis(chloromethyl)thiophene 53680-66-3P
117420-69-6P 133921-80-9P 134484-17-6P 194366-17-1P,
2,5-Bis[(2-hydroxyethyl)thiomethyl]thiophene 1048373-58-5P
1048373-62-1P 1048373-64-3P 1048373-66-5P 1048373-73-4P
1048373-81-4P 1048373-83-6P 1048373-88-1P 1048373-91-6P
RL: IMF (Industrial manufacture); RCT (Reactant); PREP (Preparation);

RACT
(Reactant or reagent)
(in preparation of monomers; high refractive index monomers and transparent
polymer compns. for production of optical materials)

IT 50-00-0, Formaldehyde, reactions 60-24-2, 2-Mercaptoethanol 79-41-4,
Methacrylic acid, reactions 80-05-7, Bisphenol A, reactions 80-07-9,
4,4'-Dichlorodiphenyl sulfone 80-62-6, Methyl methacrylate 91-13-4,
1,2-Bis(bromomethyl)benzene 96-09-3, Styrene oxide 100-53-8,
Benzylthiol 107-07-3, 2-Chloroethanol, reactions 108-98-5,
Thiophenol,
reactions 109-64-8, 1,3-Dibromopropane 110-02-1, Thiophene
122-60-1,
Phenyl glycidyl ether 149-30-4, 2-Mercaptobenzothiazole 540-63-6,
1,2-Dimercaptoethane 623-24-5, 1,4-Bis(bromomethyl)benzene 699-12-7,
2-Phenylthioethanol 760-93-0, Methacrylic anhydride 814-68-6,

Acryloyl
chloride 920-46-7, Methacryloyl chloride 1073-72-9, 4-(Methylthio)
phenol 1667-10-3 1888-94-4, 2-Chloroethyl methacrylate
3120-74-9, 3-Methyl-4-(methylthio)phenol 3446-90-0,
4-(Methylthio)benzyl alcohol 19362-77-7 27205-03-4 30674-80-7,
2-Isocyanatoethyl methacrylate 37482-11-4, 2-Mercaptoethanol sodium
salt
109240-75-7 150909-91-4
RL: RCT (Reactant); RACT (Reactant or reagent)
(in preparation of monomers; high refractive index monomers and transparent
polymer compns. for production of optical materials)

IT 7647-01-0, Hydrochloric acid, reactions 10026-13-8, Phosphorus
pentachloride
RL: RGT (Reagent); RACT (Reactant or reagent)
(in preparation of monomers; high refractive index monomers and transparent
polymer compns. for production of optical materials)

IT 39667-73-7P 54667-28-6P 89373-29-5P 95175-52-3P 104609-61-2P
112503-98-7P, preparation 117675-95-3P 137683-15-9P 139439-84-2P
154865-01-7P 345290-67-7P 1021297-22-2P 1021297-32-4P
1021297-37-9P 1048373-30-3P 1048373-32-5P 1048373-34-7P
1048373-36-9P 1048373-38-1P 1048373-39-2P 1048373-41-6P
1048373-42-7P 1048373-44-9P 1048373-46-1P 1048373-48-3P
RL: IMF (Industrial manufacture); RCT (Reactant); PREP (Preparation);

RACT
(Reactant or reagent)
(monomer; high refractive index monomers and transparent polymer

- comps. for production of optical materials)
- IT 41637-38-1, Ethoxylated bisphenol A dimethacrylate 64401-02-1,
Ethoxylated bisphenol A diacrylate
RL: RCT (Reactant); RACT (Reactant or reagent)
(monomer; high refractive index monomers and transparent polymer
comps. for production of optical materials)
- IT 1306-38-3, Ceria, uses 1314-23-4, Zirconia, uses 7440-32-6, Titanium,
uses 7440-45-1, Cerium, uses 7440-67-7, Zirconium, uses 13463-67-7,
Titania, uses
RL: TEM (Technical or engineered material use); USES (Uses)
(nanoparticles; high refractive index monomers and transparent polymer
comps. for production of optical materials)
- L3 ANSWER 2 OF 13 CAPLUS COPYRIGHT 2009 ACS on STN
AN 2007:653854 CAPLUS
DN 149:340634
ED Entered STN: 18 Jun 2007
- TI A fibrous hypercrosslinked sorbent prepared on PP-ST-DVB matrix via
post-crosslinking reaction
- AU Liu, Feng; Yuan, Si Guo; Wang, Xiao Li; Polikarpov, A. P.; Shunkevich, A.
A.
- CS School of Chemical Engineering, Zhengzhou University, Zhengzhou, 450002,
Peop. Rep. China
- SO Chinese Chemical Letters (2007), 18(5), 588-590
CODEN: CCLEE7; ISSN: 1001-8417
- PB Chinese Chemical Society
DT Journal
LA English
CC 66-3 (Surface Chemistry and Colloids)
Section cross-reference(s): 37
- AB A fibrous sorbent possessing abundant micropore structure was firstly
prepared via post-crosslinking reaction on the
polypropylene-(g)styrene-divinylbenzene (PP-ST-DVB) original fiber. Its
micromorphol. and sorptive properties were studied, and the novel fibrous
hypercroslinked sorbent has narrow pore-size distribution, small average
porous radius (1.90 nm), high sp. surface area (362.31 m²/g), and fine
sorpitive properties for small organic mols.
- ST polypropylene polystyrene divinylbenzene fibrous hypercrosslinked sorbent
- IT Pore size distribution
Surface area
(fibrous hypercrosslinked sorbent prepared on
polypropylene-styrene-divinylbenzene matrix via post-crosslinking
reaction)
- IT Sorbents
(fibrous; fibrous hypercrosslinked sorbent prepared on
polypropylene-styrene-divinylbenzene matrix via post-crosslinking
reaction)
- IT Fibrous materials
(sorbents; fibrous hypercrosslinked sorbent prepared on
polypropylene-styrene-divinylbenzene matrix via post-crosslinking
reaction)
- IT 108-88-3, Toluene, properties 108-95-2, Phenol, properties
RL: ANT (Analyte); PRP (Properties); ANST (Analytical study)
(fibrous hypercrosslinked sorbent prepared on
polypropylene-styrene-divinylbenzene matrix via post-crosslinking

reaction)
 IT 7646-78-8, Tin chloride (SnCl₄), uses
 RL: CAT (Catalyst use); USES (Uses)
 (fibrous hypercrosslinked sorbent prepared on
 polypropylene-styrene-divinylbenzene matrix via post-crosslinking
 reaction)
 IT 106055-97-4
 RL: PRP (Properties); RCT (Reactant); TEM (Technical or engineered
 material use); RACT (Reactant or reagent); USES (Uses)
 (fibrous hypercrosslinked sorbent prepared on
 polypropylene-styrene-divinylbenzene matrix via post-crosslinking
 reaction)
 IT 1667-10-3
 RL: RCT (Reactant); RACT (Reactant or reagent)
 (fibrous hypercrosslinked sorbent prepared on
 polypropylene-styrene-divinylbenzene matrix via post-crosslinking
 reaction)

RE.CNT 3 THERE ARE 3 CITED REFERENCES AVAILABLE FOR THIS RECORD

RE

- (1) Sherrington, D; J Polym Sci Polym Chem 2001, V39, P2364 CAPLUS
- (2) Tsyurupa, M; Reactive Funct Polym 2002, V53, P193 CAPLUS
- (3) Tsyurupa, M; Reactive Funct Polym 2006, V66, P768 CAPLUS

L3 ANSWER 3 OF 13 CAPLUS COPYRIGHT 2009 ACS on STN

AN 2007:229651 CAPLUS

DN 146:521309

ED Entered STN: 02 Mar 2007

TI Reaction of 4,4'-bis(chloromethyl)-1,1'-biphenyl and phenol in
 two-phase medium via phase-transfer catalysis

AU Wang, Maw-Ling; Lee, Ze-Fa

CS Department of Environmental Engineering, Hung Kuang University, Taichung
 County, Taichung, Shalu, 433, Taiwan

SO Journal of Molecular Catalysis A: Chemical (2007), 264(1-2), 119-127
 CODEN: JMCCF2; ISSN: 1381-1169

PB Elsevier B.V.

DT Journal

LA English

CC 22-4 (Physical Organic Chemistry)

Section cross-reference(s): 67

OS CASREACT 146:521309

AB Kinetic study of the phase-transfer catalyzed etherification of
 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in an alkaline
 solution of KOH/organic solvent two-phase medium was investigated. The
 reaction

was carried out in a stirred batch reactor under mild operating
 conditions. During or after completing the reaction, the

mono-substituted

product [4,4'-(chloromethyl)(phenoxymethyl)-1,1'-biphenyl] and the
 disubstituted product [4,4'-bis(phenoxymethyl)-1,1'-biphenyl] are both
 produced. Effects on the reaction due to various operating conditions,
 such as agitation speed, amount of water, amount of organic solvent,

amount of

phase-transfer catalyst, amount of potassium hydroxide, kind of
 phase-transfer catalyst, kind of organic solvent, inorg. salt and
 temperature were

- studied in detail. A rational mechanism of the etherification was proposed based on the exptl. observation and a kinetic model was developed. In examining nine kinds of phase-transfer catalyst, tetrabutylammonium bromide was found to be the best for increasing the reaction rate. The inorg. salts, such as potassium iodide or sodium iodide play an important role in enhancing the reaction rate. Hoffmann elimination is used to explain the peculiar behavior in studying the effect of the KOH on the apparent rate consts. The apparent activation energies for the etherification were $E_{a1} = 23.7$ kcal/mol and $E_{a2} = 31.5$ kcal/mol, resp., using tetra-n-butyl-ammonium bromide (TBAB) as the catalyst.
- ST phase transfer catalyzed etherification chloromethylbiphenyl phenol kinetics
- IT Counterions
(counterion effects of quaternary ammonium phase transfer catalysts; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT Etherification
Etherification kinetics
(etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT Polyoxymethylenes, uses
RL: CAT (Catalyst use); PEP (Physical, engineering or chemical process); PROC (Process); USES (Uses)
(etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT Phase transfer catalysts
(etherification; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT Activation energy
(for etherification; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT Salt effect
(of KI and NaI promotes etherification; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT Mass transfer
(of lipophilic phenoxide ion pairs; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT Solvent effect
(of organic solvents; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT Etherification catalysts
(phase transfer; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT Quaternary ammonium compounds, uses
RL: CAT (Catalyst use); PEP (Physical, engineering or chemical process); PROC (Process); USES (Uses)
(phase-transfer catalysts; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase

- medium via phase-transfer catalysis)
- IT Quaternary ammonium compounds, uses
 RL: CAT (Catalyst use); PEP (Physical, engineering or chemical process);
 PROC (Process); USES (Uses)
 (tri-C8-10-alkylmethyl, chlorides, Aliquat 336, phase-transfer catalyst; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT 25322-68-3, Polyethylene glycol
 RL: CAT (Catalyst use); PEP (Physical, engineering or chemical process);
 PROC (Process); USES (Uses)
 (PEG 600, phase-transfer catalyst; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT 15178-76-4, SB 8
 RL: CAT (Catalyst use); PEP (Physical, engineering or chemical process);
 PROC (Process); USES (Uses)
 (SB 8, phase-transfer catalyst, low activity; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT 7681-11-0, Potassium iodide, uses 7681-82-5, Sodium iodide, uses
 RL: CAT (Catalyst use); USES (Uses)
 (catalytic salt effect; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT 63405-62-9P, 4,4'-Bis(phenoxyethyl)-1,1'-biphenyl
 RL: SPN (Synthetic preparation); PREP (Preparation)
 (etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT 934336-64-8P, 4-(Chloromethyl)-4'-(phenoxyethyl)-1,1'-biphenyl
 RL: PEP (Physical, engineering or chemical process); PRP (Properties);
- RCT
 (Reactant); SPN (Synthetic preparation); PREP (Preparation); PROC (Process); RACT (Reactant or reagent)
 (etherification; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT 1667-10-3, 4,4'-Bis(chloromethyl)-1,1'-biphenyl
 RL: PRP (Properties); RCT (Reactant); RACT (Reactant or reagent)
 (etherification; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT 17455-13-9, 18-Crown-6
 RL: CAT (Catalyst use); PEP (Physical, engineering or chemical process);
 PROC (Process); USES (Uses)
 (phase-transfer catalyst, poor activity; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)
- IT 311-28-4, Tetrabutylammonium iodide 1112-67-0, Tetrabutylammonium chloride 1643-19-2, Tetrabutylammonium bromide 4328-13-6, Tetraoctylammonium bromide 14866-33-2, Tetraoctylammonium bromide
 RL: CAT (Catalyst use); PEP (Physical, engineering or chemical process);
 PROC (Process); USES (Uses)
 (phase-transfer catalyst; etherification of 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase medium via phase-transfer catalysis)

- IT 108-95-2, Phenol, reactions
 RL: PRP (Properties); RCT (Reactant); RACT (Reactant or reagent)
 (precursor for phenoxide in situ; etherification of
 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase
 medium via phase-transfer catalysis)
- IT 1310-58-3, Potassium hydroxide, reactions
 RL: RCT (Reagent); RACT (Reactant or reagent)
 (reagent for phenoxide formation in situ; etherification of
 4,4'-bis(chloromethyl)-1,1'-biphenyl with phenol in two-phase
 medium via phase-transfer catalysis)
- RE.CNT 18 THERE ARE 18 CITED REFERENCES AVAILABLE FOR THIS RECORD
 RE
- (1) Anon; Handbook of Phase Transfer Catalysis 1997
 - (2) Bose, A; Tetrahedron Lett 2005, V46, P3011 CAPLUS
 - (3) Choudary, B; Catal Today 2000, V57, P17 CAPLUS
 - (4) Chu, W; Catal Today 2004, V90, P349 CAPLUS
 - (5) Dantas Ramos, A; Appl Catal A: Gen 2004, V277, P71 CAPLUS
 - (6) Dehmloew, E; Phase Transfer Catalysis, 3rd ed 1993
 - (7) Gills, J; Expert Opin Investig Drugs 2004, V7, P787
 - (8) Jarrouse, J; C R Hebd Seances Acad Sci Ser C 1951, V232, P1424
 - (9) Jones, R; Quaternary Ammonium Salts: Their Use in Phase-Transfer Catalysed Reactions 2001
 - (10) Kotha, S; Bioorg Med Chem Lett 2002, V15, P1039
 - (11) Lopez, A; J High Res Chrom 1989, V12, P503 CAPLUS
 - (12) Memoli, S; Chemosphere 2001, V43, P115 CAPLUS
 - (13) Milton, N; Neurosci Lett 2002, V332, P127 CAPLUS
 - (14) Raboisson, P; Eur J Med Chem 2003, V38, P199 CAPLUS
 - (15) Sakai, T; Anal Chim Acta 1977, V93, P357 CAPLUS
 - (16) Scheunemann, M; Bioorg Med Chem 2004, V12, P1459 CAPLUS
 - (17) Starks, C; Phase-Transfer Catalysis: Fundamentals, Applications and Industrial Perspectives 1994
 - (18) Tirronen, E; Chem Eng J 2003, V91, P103 CAPLUS

L3 ANSWER 4 OF 13 CAPLUS COPYRIGHT 2009 ACS on STN
 AN 2006:1173064 CAPLUS
 DN 145:480451
 ED Entered STN: 09 Nov 2006
 TI Antireflective hardmask composition and methods for using same
 IN Uh, Dong Seon; Oh, Chang Il; Kim, Do Hyeon; Lee, Jin Kuk; Nam, Irina
 PA S. Korea
 SO U.S. Pat. Appl. Publ., 13pp.
 CODEN: USXXCO
 DT Patent
 LA English
 INCL 430270100
 CC 74-5 (Radiation Chemistry, Photochemistry, and Photographic and Other Reprographic Processes)
 Section cross-reference(s): 35, 37

FAN.CNT 1

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	US 20060251990	A1	20061109	US 2006-348203	20060206
	KR 2006116133	A	20061114	KR 2005-68348	20050727
	KR 671116	B1	20070117	KR 2005-68890	20050728
	KR 671114	B1	20070117	KR 2005-68891	20050728

KR 671117	B1	20070117	KR 2005-68892	20050728
KR 671120	B1	20070117	KR 2005-68893	20050728
WO 2006121242	A1	20061116	WO 2006-KR909	20060314

W: AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KM, KN, KP, KZ, LC, LK, LR, LS, LT, LU, LV, LY, MA, MD, MG, MN, MW, MX, MZ, NA, NG, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, SM, SY, TJ, TM, TN, TR, TT, UA, UG, US, UZ, VC, VN, YU, ZA, ZM, ZW

RW: AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IS, IT, LT, LU, LV, MC, NL, PL, PT, RO, SE, SI, SK, TR, BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG, BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW, AM, AZ, BY, KG, KZ, MD, RU, TJ, TM

PRAI KR 2005-38406 A 20050509
KR 2005-68348 A 20050727

CLASS

PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
US 20060251990	INCL	430270100
	IPCI	G03C0001-00 [I,A]
	IPCR	G03C0001-00 [I,C]; G03C0001-00 [I,A]
	NCL	430/270.100; 430/271.100
	ECLA	G03F007/09A
KR 2006116133	IPCI	G03F0007-039 [I,A]; G03F0007-004 [I,A]
KR 671116	IPCI	G03F0007-039 [I,A]; G03F0007-00 [I,A]
KR 671114	IPCI	G03F0007-004 [I,A]; G03F0007-039 [I,A]
KR 671117	IPCI	G03F0007-039 [I,A]; G03F0007-004 [I,A]
KR 671120	IPCI	C08G0061-02 [I,A]; C08G0061-00 [I,A]
WO 2006121242	IPCI	G03F0007-039 [I,A]; G03F0007-004 [I,A]
	IPCR	G03F0007-039 [I,C]; G03F0007-039 [I,A]; G03F0007-004 [I,C]; G03F0007-004 [I,A]
	ECLA	G03F007/09A

OS CASREACT 145:480451

AB Hardmask compns. having antireflective properties useful in lithog. processes, methods of using the same, and semiconductor devices fabricated by such methods, are provided. In some embodiments of the present invention, antireflective hardmask compns. include: (a) a polymer component, which includes one or more of the monomeric units : (b) a crosslinking component; and (c) an acid catalyst.

ST antireflective hardmask polymer synthesis semiconductor fabrication

IT Antireflective films

Etching masks

Photomasks (lithographic masks)

(antireflective hardmask composition and methods for using same)

IT Aminoplasts

RL: RGT (Reagent); TEM (Technical or engineered material use); RACT (Reactant or reagent); USES (Uses)

(antireflective hardmask composition and methods for using same)

IT Semiconductor device fabrication

(hard masks; antireflective hardmask composition and methods for using same)

IT Coating materials

(masking; antireflective hardmask composition and methods for using same)

IT 64-67-5, Diethyl sulfate 104-15-4, p-Toluenesulfonic acid, uses
 RL: CAT (Catalyst use); USES (Uses)
 (antireflective hardmask composition and methods for using same)

IT 9003-35-4P 26834-02-6P 138746-72-2P 875290-68-9P 914090-75-8P
 914090-76-9P
 RL: DEV (Device component use); SPN (Synthetic preparation); TEM
 (Technical or engineered material use); PREP (Preparation); USES (Uses)
 (antireflective hardmask composition and methods for using same)

IT 7440-21-3, Silicon, uses
 RL: DEV (Device component use); TEM (Technical or engineered material
 use); USES (Uses)
 (antireflective hardmask composition and methods for using same)

IT 90-02-8, 2-Hydroxybenzaldehyde, reactions 90-15-3, 1-Naphthol
 108-95-2, Phenol, reactions 1667-10-3,
 4,4'-Bis(chloromethyl)-1,1'-biphenyl 3236-71-3,
 4,4'-(9-Fluorenylidene)diphenol 6770-38-3,
 1,4-Bis(methoxymethyl)benzene
 RL: RCT (Reactant); RACT (Reactant or reagent)
 (antireflective hardmask composition and methods for using same)

IT 96-48-0, γ -Butyrolactone
 RL: RGT (Reagent); RACT (Reactant or reagent)
 (antireflective hardmask composition and methods for using same)

IT 9003-08-1, Cymel 303 17464-88-9, Powderlink 1174
 RL: RGT (Reagent); TEM (Technical or engineered material use); RACT
 (Reactant or reagent); USES (Uses)
 (antireflective hardmask composition and methods for using same)

L3 ANSWER 5 OF 13 CAPLUS COPYRIGHT 2009 ACS on STN
 AN 2006:1147322 CAPLUS
 DN 145:480508
 ED Entered STN: 02 Nov 2006
 TI Thermal printing material using phenol-biphenyl condensate as
 color developer
 IN Tsugawa, Hiroaki; Yoshifuji, Mitsuo; Oshimi, Katsuhiko
 PA Nippon Kayaku Co., Ltd., Japan
 SO Jpn. Kokai Tokkyo Koho, 10pp.
 CODEN: JKXXAF
 DT Patent
 LA Japanese
 CC 74-7 (Radiation Chemistry, Photochemistry, and Photographic and Other
 Reprographic Processes)

FAN.CNT 1

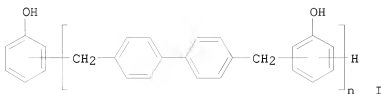
	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	JP 2006297783	A	20061102	JP 2005-123675	20050421
PRAI	JP 2005-123675		20050421		

CLASS

PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
JP 2006297783	IPC1	B41M0005-333 [I,A]; B41M0005-30 [I,C*]
	IPCR	B41M0005-30 [I,C]; B41M0005-333 [I,A]
	FTERM	2H026/AA07; 2H026/AA28; 2H026/BB12; 2H026/BB28; 2H026/BB32; 2H026/DD13; 2H026/DD17

10/585699

GI



AB The material has a heat-sensitive layer containing a colorless color-former

and I (n = 1.0-1.8) as a color-developer. The material gives high d. image with heat, water, and plasticizer resistance.

ST thermal printing material phenol biphenyl condensate color developer

IT Thermal printing materials
(thermal printing material using phenol-biphenyl condensate as color developer)

IT 108-95-2DP, Phenol, reaction products with chloromethylbiphenyl 1667-10-3DP, 4,4'-Bischloromethyl-1,1'-biphenyl, reaction products with phenol

RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)

(thermal printing material using phenol-biphenyl condensate as color developer)

L3 ANSWER 6 OF 13 CAPLUS COPYRIGHT 2009 ACS on STN

AN 2004:744998 CAPLUS

DN 141:395535

ED Entered STN: 13 Sep 2004

TI Design and synthesis of ninhydrin-based cyclophanes as potential neutral receptors for quaternary ammonium cations

AU Na, Jeong Eun; Lee, Shim Sung; Kim, Jae Nyoung

CS Department of Chemistry and Institute of Basic Sciences, Chonnam National University, Kwangju, 500-757, S. Korea

SO Tetrahedron Letters (2004), 45(40), 7435-7440

CODEN: TELEAY; ISSN: 0040-4039

PB Elsevier B.V.

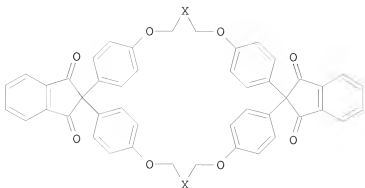
DT Journal

LA English

CC 28-23 (Heterocyclic Compounds (More Than One Hetero Atom))

OS CASREACT 141:395535

GI



I

- AB Four ninhydrin-based cyclophanes, two rectangular type cyclophanes I (X = 1,4-phenylene, 1,1-diphen-4,4'-diyl) and two square type cyclophanes, were designed and synthesized in 8-43% yields.
- ST cyclophane ninhydrin based rectangular square prepn; crown ether cyclophane ninhydrin prepn
- IT Crown ethers
 RL: SPN (Synthetic preparation); PREP (Preparation)
 (benzo; preparation of rectangular and square ninhydrin-based cyclophanes as potential neutral receptors for quaternary ammonium cations)
- IT Cyclophanes
 RL: SPN (Synthetic preparation); PREP (Preparation)
 (heterophanes; preparation of rectangular and square ninhydrin-based cyclophanes as potential neutral receptors for quaternary ammonium cations)
- IT Macrocyclization
 (preparation of rectangular and square ninhydrin-based cyclophanes as potential neutral receptors for quaternary ammonium cations)
- IT 108-95-2, Phenol, reactions
 RL: RCT (Reactant); RACT (Reactant or reagent)
 (Friedel-Crafts alkylation; preparation of rectangular and square ninhydrin-based cyclophanes as potential neutral receptors for quaternary ammonium cations)
- IT 786681-08-1
 RL: PRP (Properties)
 (crystal structure; preparation of rectangular and square ninhydrin-based cyclophanes as potential neutral receptors for quaternary ammonium cations)
- IT 623-24-5, 1,4-Bis(bromomethyl)benzene 1667-10-3
 RL: RCT (Reactant); RACT (Reactant or reagent)
 (macrocyclization; preparation of rectangular and square ninhydrin-based cyclophanes as potential neutral receptors for quaternary ammonium cations)
- IT 485-47-2, Ninhydrin
 RL: RCT (Reactant); RACT (Reactant or reagent)

- (preparation of rectangular and square ninhydrin-based cyclophanes as potential neutral receptors for quaternary ammonium cations)
- IT 246516-38-1P 786681-04-7P 786681-06-9P 786681-09-2P 786681-11-6P
 RL: RCT (Reactant); SPN (Synthetic preparation); PREP (Preparation); RACT (Reactant or reagent)
- (preparation of rectangular and square ninhydrin-based cyclophanes as potential neutral receptors for quaternary ammonium cations)
- IT 786681-05-8P 786681-07-0P 786681-10-5P 786681-12-7P
 RL: SPN (Synthetic preparation); PREP (Preparation)
- (preparation of rectangular and square ninhydrin-based cyclophanes as potential neutral receptors for quaternary ammonium cations)
- RE.CNT 33 THERE ARE 33 CITED REFERENCES AVAILABLE FOR THIS RECORD
- RE
- (1) An, H; Chem Rev 1992, V92, P543 CAPLUS
 - (2) Apel, S; J Chem Soc, Perkin Trans 2 2001, P1212 CAPLUS
 - (3) Arnecke, R; Tetrahedron 1997, V53, P4901 CAPLUS
 - (4) Atwood, J; Comprehensive Supramolecular Chemistry 1996, V1 CAPLUS
 - (5) Bartoli, S; J Org Chem 2003, V68, P8149 CAPLUS
 - (6) Bartsch, R; Tetrahedron Lett 2002, V43, P5017 CAPLUS
 - (7) Casnati, A; Tetrahedron 1995, V51, P591 CAPLUS
 - (8) Cattani, A; J Org Chem 1995, V60, P8313 CAPLUS
 - (9) Colquhoun, H; J Am Chem Soc 2002, V124, P13346 CAPLUS
 - (10) Cowart, M; J Am Chem Soc 1988, V110, P6204 CAPLUS
 - (11) Dalley, N; J Inclusion Phenom Mol Recognit Chem 1997, V29, P323 CAPLUS
 - (12) Diederich, F; J Am Chem Soc 1984, V106, P8037 CAPLUS
 - (13) Dvornikovs, V; J Org Chem 2002, V67, P2160 CAPLUS
 - (14) Garel, L; J Am Chem Soc 1993, V115, P11652 CAPLUS
 - (15) Inoue, M; J Chem Soc, Perkin Trans 2 1997, P2113 CAPLUS
 - (16) Izatt, R; Chem Rev 1995, V95, P2529 CAPLUS
 - (17) Izatt, R; J Chem Rev 1992, V92, P1261 CAPLUS
 - (18) Jorgensen, W; J Am Chem Soc 1992, V114, P4003 CAPLUS
 - (19) Kearney, P; J Am Chem Soc 1993, V115, P9907 CAPLUS
 - (20) Kim, B; J Am Chem Soc 1995, V117, P6390 CAPLUS
 - (21) Lukyanenko, N; Tetrahedron Lett 2003, V44, P7373 CAPLUS
 - (22) Ma, J; Chem Rev 1997, V97, P1303 CAPLUS
 - (23) Masci, B; Tetrahedron 1995, V51, P5459 CAPLUS
 - (24) Miller, S; J Am Chem Soc 1984, V106, P1492 CAPLUS
 - (25) Mordasini, D; J Am Chem Soc 1996, V118, P6044
 - (26) Murakami, Y; Chem Rev 1996, V96, P721 CAPLUS
 - (27) Nissinen, M; J Inclusion Phenom Mol Recognit Chem 2001, V39, P229 CAPLUS
 - (28) Ratilainen, J; Chem Eur J 1997, V3, P749 CAPLUS
 - (29) Roelens, S; J Am Chem Soc 1998, V120, P12443 CAPLUS
 - (30) Rudiger, V; Eur J Org Chem 1999, P1847 CAPLUS
 - (31) Saigo, K; J Am Chem Soc 1986, V108, P1996 CAPLUS
 - (32) Sarri, P; J Org Chem 2004, V69, P3654 CAPLUS
 - (33) Song, H; Synth Commun 1999, V29, P3303 CAPLUS

L3 ANSWER 7 OF 13 CAPLUS COPYRIGHT 2009 ACS on STN

AN 2003:767847 CAPLUS

DN 139:277693

ED Entered STN: 02 Oct 2003

TI Epoxy resins of good fluidity, their compositions, and their cured products having excellent water resistance

IN Akatsuka, Yasumasa; Nakayama, Koji

PA Nippon Kayaku Co., Ltd., Japan

10/585699

SO Jpn. Kokai Tokkyo Koho, 6 pp.
CODEN: JKXXAF
DT Patent
LA Japanese
IC ICM C08G059-06
ICS C08G059-24
CC 38-3 (Plastics Fabrication and Uses)
Section cross-reference(s): '76

FAN.CNT 1

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	JP 2003277468	A	20031002	JP 2002-79974	20020322
	JP 3992181	B2	20071017		
PRAI	JP 2002-79974		20020322		

CLASS

PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
JP 2003277468	ICM	C08G059-06
	ICS	C08G059-24
	IPCI	C08G0059-06 [I,A]; C08G0059-24 [I,A]; C08G0059-00 [I,C*]
	IPCR	C08G0059-06 [I,A]; C08G0059-00 [I,C*]; C08G0059-24 [I,A]

AB Epoxy resins prepared by alkali metal hydroxide-catalyzed reaction of epihalohydrins, 4,4'-bis(2-hydroxynaphthylmethyl)biphenyl (I), and phenols

excluding I are claimed. Compns. of the epoxy resins, their hardeners, (curing accelerators,) and inorg. fillers are also claimed. Thus, MEH 7851SS (biphenyl novolak), epichlorohydrin, and I were reacted in the presence of NaOH to give an epoxy resin of m.p. 105.4° and melt viscosity 0.0025 Pa-s, 14.5 parts of which was blended with phenol novolak 5.4, Ph3P 0.1, spherical SiO2 57.2, and crushed SiO2 22.8 parts

to give a composition showing spiral flow 103 cm and producing a cured product of water absorption 0.82%.

ST hydroxynaphthylmethylbiphenyl epoxy resin silica compn fluidity; water resistant phenolic epoxy resin naphthol derived

IT Phenolic resins, uses

RL: IMF (Industrial manufacture); POF (Polymer in formulation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses) (epoxy; naphthalene ring-containing epoxy resin compns. of high filler content and high fluidity for water-resistant products)

IT Water-resistant materials

(naphthalene ring-containing epoxy resin compns. of high filler content and high fluidity for water-resistant products)

IT Epoxy resins, uses

RL: IMF (Industrial manufacture); POF (Polymer in formulation); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses) (phenolic; naphthalene ring-containing epoxy resin compns. of high

filler

content and high fluidity for water-resistant products)

IT 603-35-0, Triphenylphosphine, uses

RL: CAT (Catalyst use); TEM (Technical or engineered material use); USES

(Uses)
 (curing accelerators; naphthalene ring-containing epoxy resin compns.
 of high filler content and high fluidity for water-resistant products)
 IT 7631-86-9, Silica, uses
 RL: TEM (Technical or engineered material use); USES (Uses)
 (fillers; naphthalene ring-containing epoxy resin compns. of high
 filler content and high fluidity for water-resistant products)
 IT 1310-73-2, Sodium hydroxide, uses
 RL: CAT (Catalyst use); USES (Uses)
 (naphthalene ring-containing epoxy resin compns. of high filler
 content and high fluidity for water-resistant products)
 IT 606968-62-1P, 4,4'-Bis(2-hydroxynaphthylmethyl)biphenyl-epichlorohydrin-
 formaldehyde-MEH 7851SS-phenol copolymer
 RL: IMF (Industrial manufacture); POF (Polymer in formulation); TEM
 (Technical or engineered material use); PREP (Preparation); USES (Uses)
 (naphthalene ring-containing epoxy resin compns. of high filler
 content and high fluidity for water-resistant products)
 IT 390401-83-9P
 RL: IMF (Industrial manufacture); RCT (Reactant); PREP (Preparation);
 RACT (Reactant or reagent)
 (naphthalene ring-containing epoxy resin compns. of high filler
 content and high fluidity for water-resistant products)
 IT 135-19-3, β -Naphthol, reactions 1667-10-3
 RL: RCT (Reactant); RACT (Reactant or reagent)
 (naphthalene ring-containing epoxy resin compns. of high filler
 content and high fluidity for water-resistant products)

L3 ANSWER 8 OF 13 CAPLUS COPYRIGHT 2009 ACS ON STN
 AN 2002:534031 CAPLUS
 DN 137:93597
 ED Entered STN: 17 Jul 2002
 TI Preparation and use of phenoxyalkylamino-linked dimers as sodium channel
 modulators
 IN Marquess, Daniel; Choi, Seok-ki; Beattie, David T.; Griffin, John H.;
 Armstrong, Scott; Church, Timothy J.; Jenkins, Thomas E.
 PA Advanced Medicine, Inc., USA
 SO U.S., 121 pp., Cont.-in-part of U. S. Ser. No. 325,563, abandoned.
 CODEN: USXXAM
 DT Patent
 LA English
 IC ICM C07D245-02
 ICS C07D211-70; C07D333-12; A61K031-33; A61K031-44
 INCL 514183000
 CC 25-9 (Benzene, Its Derivatives, and Condensed Benzenoid Compounds)
 Section cross-reference(s): 1, 28, 63

FAN.CNT 31

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
-----	----	-----	-----	-----

PI	US 6420354	B1	20020716	US 1999-458107	19991208
	CA 2318806	A1	19991216	CA 1999-2318806	19990607
	CA 2319142	A1	19991216	CA 1999-2319142	19990607
	CA 2319153	A1	19991216	CA 1999-2319153	19990607
	WO 9963984	A1	19991216	WO 1999-US11801	19990607
	W: AE, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, CA, CH, CN, CU, CZ, DE, DK, EE, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MD, MG, MK, MN, MW, MX, NO, NZ, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TJ, TM, TR, TT, UA, UG, US, UZ, VN, YU, ZA, ZW				
	RW: GH, GM, KE, LS, MW, SD, SL, SZ, UG, ZW, AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE, BF, BJ, CF, CG, CI, CM, GA, GN, GW, ML, MR, NE, SN, TD, TG				
	WO 9963932	A2	19991216	WO 1999-US12724	19990607
	WO 9963932	A3	20000203		
	W: AE, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, CA, CH, CN, CU, CZ, DE, DK, EE, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MD, MG, MK, MN, MW, MX, NO, NZ, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TJ, TM, TR, TT, UA, UG, US, UZ, VN, YU, ZA, ZW				
	RW: GH, GM, KE, LS, MW, SD, SL, SZ, UG, ZW, AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE, BF, BJ, CF, CG, CI, CM, GA, GN, GW, ML, MR, NE, SN, TD, TG				
	WO 9964045	A1	19991216	WO 1999-US12754	19990607
	W: AE, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, CA, CH, CN, CU, CZ, DE, DK, EE, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MD, MG, MK, MN, MW, MX, NO, NZ, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TJ, TM, TR, TT, UA, UG, US, UZ, VN, YU, ZA, ZW				
	RW: GH, GM, KE, LS, MW, SD, SL, SZ, UG, ZW, AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE, BF, BJ, CF, CG, CI, CM, GA, GN, GW, ML, MR, NE, SN, TD, TG				
	AU 9945511	A	19991230	AU 1999-45511	19990607
	AU 9946726	A	19991230	AU 1999-46726	19990607
	EP 1085879	A2	20010328	EP 1999-928442	19990607
	R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT, IE, FI				
	EP 1085890	A1	20010328	EP 1999-930122	19990607
	R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT, IE, FI				
	EP 1089749	A1	20010411	EP 1999-928447	19990607
	R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT, IE, FI				
	JP 2002517437	T	20020618	JP 2000-553053	19990607
	ZA 2000004562	A	20011130	ZA 2000-4562	20000831
	ZA 2000004563	A	20011130	ZA 2000-4563	20000831
	ZA 2000004564	A	20011130	ZA 2000-4564	20000831
	US 6479498	B1	20021112	US 2001-39699	20011109
	US 20030044845	A1	20030306	US 2002-75017	20020213
PRAI	US 1998-88465P	P	19980608		
	US 1998-93068P	P	19980716		
	US 1999-325563	B2	19990604		
	US 1999-327096	B1	19990607		
	WO 1999-US11801	W	19990607		
	WO 1999-US12724	W	19990607		

10/585699

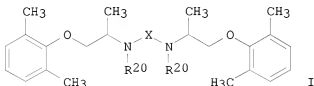
WO 1999-US12754	W	19990607
US 1999-458107	A1	19991208
US 2000-499176	B1	20000207
CLASS		
PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
US 6420354	ICM	C07D245-02
	ICS	C07D211-70; C07D333-12; A61K031-33; A61K031-44
	INCL	514183000
	IPCI	C07D0245-02 [ICM,7]; C07D0245-00 [ICM,7,C*]; C07D0211-70 [ICS,7]; C07D0211-00 [ICS,7,C*]; C07D0333-12 [ICS,7]; C07D0333-00 [ICS,7,C*]; A61K0031-33 [ICS,7]; A61K0031-44 [ICS,7]
	IPCR	A61K0047-48 [I,C*]; A61K0047-48 [I,A]; C07D0239-00 [I,C*]; C07D0239-48 [I,A]; G01N0033-68 [I,C*]; G01N0033-68 [I,A]
	NCL	514/183.000; 514/357.000; 514/438.000; 514/651.000; 540/470.000; 546/334.000; 549/075.000; 564/353.000
	ECLA	A61K047/48H4M; A61K047/48R4; C07D239/48B4;
G01N033/68F;		S01N
CA 2318806	IPCI	A61K0031-58 [ICM,6]; A61K0038-00 [ICS,6]; A61K0039-00 [ICS,6]; A61K0051-00 [ICS,6]; C07K0002-00 [ICS,6]; C07K0004-00 [ICS,6]; C07D0401-04 [ICS,6]; C07D0401-12 [ICS,6]; C07D0401-00 [ICS,6,C*]; A61K0039-395 [ICS,6]; G01N0033-53 [ICS,6]; G01N0033-543 [ICS,6];
G01N0033-566		[ICS,6]
	IPCR	G01N0033-50 [I,C*]; G01N0033-50 [I,A]; A61K0045-00 [I,C*]; A61K0045-00 [I,A]; A61K0047-48 [I,C*]; A61K0047-48 [I,A]; A61P0043-00 [I,C*]; A61P0043-00 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0217-00 [I,C*]; C07C0217-16 [I,A]; C07K0002-00 [I,C*]; C07K0002-00 [I,A]; C40B0020-00 [I,C*]; C40B0020-00 [I,A]; C40B0040-02 [I,C*]; C40B0040-02 [I,A]; C40B0050-06 [I,C*]; C40B0050-06 [I,A]; G01N0033-15 [I,C*]; G01N0033-15 [I,A]; G01N0033-566 [I,C*]; G01N0033-566 [I,A]; G01N0033-68 [I,C*]; G01N0033-68 [I,A]
	ECLA	A61K047/48H4M; A61K047/48R4; G01N033/68F
CA 2319142	IPCI	A61K0031-00 [ICM,6]; A61K0038-00 [ICS,6]; A61K0039-00 [ICS,6]; A61K0051-00 [ICS,6]; C07K0002-00 [ICS,6]; C07K0004-00 [ICS,6]; A61K0039-395 [ICS,6]; A61K0039-44 [ICS,6]; G01N0033-53 [ICS,6]; G01N0033-543 [ICS,6]; G01N0033-566 [ICS,6]
	IPCR	G01N0033-50 [I,C*]; G01N0033-50 [I,A]; A61K0045-00 [I,C*]; A61K0045-00 [I,A]; A61K0047-48 [I,C*]; A61K0047-48 [I,A]; A61P0043-00 [I,C*]; A61P0043-00 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0217-00 [I,C*]; C07C0217-16 [I,A]; C07K0002-00 [I,C*]; C07K0002-00 [I,A]; C40B0020-00 [I,C*]; C40B0020-00 [I,A]; C40B0040-02 [I,C*]; C40B0040-02 [I,A]; C40B0050-06 [I,C*]; C40B0050-06 [I,A]; G01N0033-15 [I,C*]; G01N0033-15 [I,A]; G01N0033-566 [I,C*]; G01N0033-566 [I,A]; G01N0033-68 [I,C*];

		G01N0033-68 [I,A]
	ECLA	A61K047/48H4M; A61K047/48R4; G01N033/68F
CA 2319153	IPCI	A61K0031-15 [ICM,6]; A61K0038-00 [ICS,6]; A61K0039-00 [ICS,6]; A61K0051-00 [ICS,6]; C07K0002-00 [ICS,6]; C07K0004-00 [ICS,6]; A61K0039-395 [ICS,6]; A61K0039-44 [ICS,6]; G01N0033-53 [ICS,6]; G01N0033-543 [ICS,6]; G01N0033-566 [ICS,6]
	IPCR	G01N0033-50 [I,C*]; G01N0033-50 [I,A]; A61K0045-00 [I,C*]; A61K0045-00 [I,A]; A61K0047-48 [I,C*]; A61K0047-48 [I,A]; A61P0043-00 [I,C*]; A61P0043-00 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0217-00 [I,C*]; C07C0217-16 [I,A]; C07K0002-00 [I,C*]; C07K0002-00 [I,A]; C40B0020-00 [I,C*]; C40B0020-00 [I,A]; C40B0040-02 [I,C*]; C40B0040-02 [I,A]; C40B0050-06 [I,C*]; C40B0050-06 [I,A]; G01N0033-15 [I,C*]; G01N0033-15 [I,A]; G01N0033-566 [I,C*]; G01N0033-566 [I,A]; G01N0033-68 [I,C*]; G01N0033-68 [I,A]
	ECLA	A61K047/48H4M; A61K047/48R4; G01N033/68F
WO 9963984	IPCI	A61K0031-15 [ICM]; A61K0038-00 [ICS]; A61K0039-00 [ICS]; A61K0039-44 [ICS]; A61K0039-395 [ICS]; A61K0051-00 [ICS]; C07K0002-00 [ICS]; C07K0004-00 [ICS]; G01N0033-53 [ICS]; G01N0033-543 [ICS]; G01N0033-566 [ICS]
	IPCR	G01N0033-50 [I,C*]; G01N0033-50 [I,A]; A61K0045-00 [I,C*]; A61K0045-00 [I,A]; A61K0047-48 [I,C*]; A61K0047-48 [I,A]; A61P0043-00 [I,C*]; A61P0043-00 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0217-00 [I,C*]; C07C0217-16 [I,A]; C07K0002-00 [I,C*]; C07K0002-00 [I,A]; C40B0020-00 [I,C*]; C40B0020-00 [I,A]; C40B0040-02 [I,C*]; C40B0040-02 [I,A]; C40B0050-06 [I,C*]; C40B0050-06 [I,A]; G01N0033-15 [I,C*]; G01N0033-15 [I,A]; G01N0033-566 [I,C*]; G01N0033-566 [I,A]; G01N0033-68 [I,C*]; G01N0033-68 [I,A]
	ECLA	A61K047/48H4M; A61K047/48R4; G01N033/68F; S01N
WO 9963932	IPCI	A61K [ICM]
	IPCR	G01N0033-50 [I,C*]; G01N0033-50 [I,A]; A61K0045-00 [I,C*]; A61K0045-00 [I,A]; A61K0047-48 [I,C*]; A61K0047-48 [I,A]; A61P0043-00 [I,C*]; A61P0043-00 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0217-00 [I,C*]; C07C0217-16 [I,A]; C07K0002-00 [I,C*]; C07K0002-00 [I,A]; G01N0033-15 [I,C*]; G01N0033-15 [I,A]; G01N0033-566 [I,C*]; G01N0033-566 [I,A]; G01N0033-68 [I,C*]; G01N0033-68 [I,A]
	ECLA	A61K047/48H4M; A61K047/48R4; G01N033/68F; S01N
WO 9964045	IPCI	A61K0038-00 [ICM]; A61K0039-00 [ICS]; A61K0039-44 [ICS]; A61K0039-395 [ICS]; A61K0051-00 [ICS]; C07K0002-00 [ICS]; C07K0004-00 [ICS]; G01N0033-53 [ICS]; G01N0033-543 [ICS]; G01N0033-566 [ICS]
	IPCR	G01N0033-50 [I,C*]; G01N0033-50 [I,A]; A61K0045-00 [I,C*]; A61K0045-00 [I,A]; A61K0047-48 [I,C*]; A61K0047-48 [I,A]; A61P0043-00 [I,C*]; A61P0043-00 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0217-00 [I,C*]; C07C0217-16 [I,A]; C07K0002-00

		[I,C*]; C07K0002-00 [I,A]; G01N0033-15 [I,C*]; G01N0033-15 [I,A]; G01N0033-566 [I,C*]; G01N0033-566 [I,A]; G01N0033-68 [I,C*]; G01N0033-68 [I,A]
AU 9945511	ECLA	A61K047/48H4M; A61K047/48R4; G01N033/68F; S01N
	IPCI	A61K0038-00 [ICM]; A61K0039-00 [ICS]; A61K0039-44 [ICS]; A61K0039-395 [ICS]; A61K0051-00 [ICS]; C07K0002-00 [ICS]; C07K0004-00 [ICS]; G01N0033-53 [ICS]; G01N0033-543 [ICS]; G01N0033-566 [ICS]
	IPCR	G01N0033-50 [I,C*]; G01N0033-50 [I,A]; A61K0045-00 [I,C*]; A61K0045-00 [I,A]; A61K0047-48 [I,C*]; A61K0047-48 [I,A]; A61P0043-00 [I,C*]; A61P0043-00 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0217-00 [I,C*]; C07C0217-16 [I,A]; C07K0002-00 [I,C*]; C07K0002-00 [I,A]; C40B0020-00 [I,C*]; C40B0020-00 [I,A]; C40B0040-02 [I,C*]; C40B0040-02 [I,A]; C40B0050-06 [I,C*]; C40B0050-06 [I,A]; G01N0033-15 [I,C*]; G01N0033-15 [I,A]; G01N0033-566 [I,C*]; G01N0033-566 [I,A]; G01N0033-68 [I,C*]; G01N0033-68 [I,A]
AU 9946726	ECLA	A61K047/48H4M; A61K047/48R4; G01N033/68F; S01N
	IPCI	A61K0031-15 [ICM]; A61K0038-00 [ICS]; A61K0039-00 [ICS]; A61K0039-44 [ICS]; A61K0039-395 [ICS]; A61K0051-00 [ICS]; C07K0002-00 [ICS]; C07K0004-00 [ICS]; G01N0033-53 [ICS]; G01N0033-543 [ICS]; G01N0033-566 [ICS]
	IPCR	G01N0033-50 [I,C*]; G01N0033-50 [I,A]; A61K0045-00 [I,C*]; A61K0045-00 [I,A]; A61K0047-48 [I,C*]; A61K0047-48 [I,A]; A61P0043-00 [I,C*]; A61P0043-00 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0217-00 [I,C*]; C07C0217-16 [I,A]; C07K0002-00 [I,C*]; C07K0002-00 [I,A]; C40B0020-00 [I,C*]; C40B0020-00 [I,A]; C40B0040-02 [I,C*]; C40B0040-02 [I,A]; C40B0050-06 [I,C*]; C40B0050-06 [I,A]; G01N0033-15 [I,C*]; G01N0033-15 [I,A]; G01N0033-566 [I,C*]; G01N0033-566 [I,A]; G01N0033-68 [I,C*]; G01N0033-68 [I,A]
EP 1085879	ECLA	A61K047/48H4M; A61K047/48R4; G01N033/68F; S01N
	IPCI	A61K0031-58 [ICM,6]; A61K0038-00 [ICS,6]; A61K0039-00 [ICS,6]; A61K0039-44 [ICS,6]; A61K0039-395 [ICS,6]; A61K0051-00 [ICS,6]; C07D0401-04 [ICS,6]; C07D0401-12 [ICS,6]; C07D0401-00 [ICS,6,C*]; C07K0002-00 [ICS,6]; C07K0004-00 [ICS,6]; G01N0033-53 [ICS,6]; G01N0033-543 [ICS,6]; G01N0033-566 [ICS,6]
	IPCR	G01N0033-50 [I,C*]; G01N0033-50 [I,A]; A61K0045-00 [I,C*]; A61K0045-00 [I,A]; A61K0047-48 [I,C*]; A61K0047-48 [I,A]; A61P0043-00 [I,C*]; A61P0043-00 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0217-00 [I,C*]; C07C0217-16 [I,A]; C07K0002-00 [I,C*]; C07K0002-00 [I,A]; C40B0020-00 [I,C*]; C40B0020-00 [I,A]; C40B0040-02 [I,C*]; C40B0040-02 [I,A]; C40B0050-06 [I,C*]; C40B0050-06 [I,A]; G01N0033-15 [I,C*]; G01N0033-15 [I,A]; G01N0033-566 [I,C*]; G01N0033-566 [I,A]; G01N0033-68 [I,C*]; G01N0033-68 [I,A]
	ECLA	A61K047/48H4M; A61K047/48R4; G01N033/68F; S01N

EP 1085890	IPCI	A61K0038-00 [ICM,6]; A61K0039-00 [ICS,6]; A61K0039-44 [ICS,6]; A61K0039-395 [ICS,6]; A61K0051-00 [ICS,6]; C07K0002-00 [ICS,6]; C07K0004-00 [ICS,6]; G01N0033-53 [ICS,6]; G01N0033-543 [ICS,6]; G01N0033-566 [ICS,6]; C07B0061-00 [ICS,6]; C07D0239-48 [ICS,6]; C07D0239-00 [ICS,6,C*]; C07D0241-20 [ICS,6]; C07D0241-00 [ICS,6,C*]; C07D0401-14 [ICS,6]; C07D0253-06 [ICS,6]; C07D0253-00 [ICS,6,C*]; C07D0273-00 [ICS,6]; C07D0211-22 [ICS,6]; C07D0211-00 [ICS,6,C*]; C07D0401-04 [ICS,6]; C07D0401-00 [ICS,6,C*]; C07C0217-16 [ICS,6]; C07C0217-00 [ICS,6,C*]
	IPCR	G01N0033-50 [I,C*]; G01N0033-50 [I,A]; A61K0045-00 [I,C*]; A61K0045-00 [I,A]; A61K0047-48 [I,C*]; A61K0047-48 [I,A]; A61P0043-00 [I,C*]; A61P0043-00 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0217-00 [I,C*]; C07C0217-16 [I,A]; C07K0002-00 [I,C*]; C07K0002-00 [I,A]; C40B0020-00 [I,C*]; C40B0020-00 [I,A]; C40B0040-02 [I,C*]; C40B0040-02 [I,A]; C40B0050-06 [I,C*]; C40B0050-06 [I,A]; G01N0033-15 [I,C*]; G01N0033-15 [I,A]; G01N0033-566 [I,C*]; G01N0033-566 [I,A]; G01N0033-68 [I,C*]; G01N0033-68 [I,A]
EP 1089749	ECLA	A61K047/48H4M; A61K047/48R4; G01N033/68F; S01N
	IPCI	A61K0038-00 [ICM,6]; A61K0039-00 [ICS,6]; A61K0039-44 [ICS,6]; A61K0039-395 [ICS,6]; A61K0051-00 [ICS,6]; C07K0002-00 [ICS,6]; C07K0004-00 [ICS,6]; G01N0033-53 [ICS,6]; G01N0033-543 [ICS,6]; G01N0033-566 [ICS,6]; C07B0061-00 [ICS,6]; C07D0239-48 [ICS,6]; C07D0239-00 [ICS,6,C*]; C07D0241-20 [ICS,6]; C07D0241-00 [ICS,6,C*]; C07D0401-14 [ICS,6]; C07D0253-06 [ICS,6]; C07D0253-00 [ICS,6,C*]; C07D0273-00 [ICS,6]; C07D0211-22 [ICS,6]; C07D0211-00 [ICS,6,C*]; C07D0401-04 [ICS,6]; C07D0401-00 [ICS,6,C*]; C07C0217-16 [ICS,6]; C07C0217-00 [ICS,6,C*]
	IPCR	G01N0033-50 [I,C*]; G01N0033-50 [I,A]; A61K0045-00 [I,C*]; A61K0045-00 [I,A]; A61K0047-48 [I,C*]; A61K0047-48 [I,A]; A61P0043-00 [I,C*]; A61P0043-00 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0217-00 [I,C*]; C07C0217-16 [I,A]; C07K0002-00 [I,C*]; C07K0002-00 [I,A]; C40B0020-00 [I,C*]; C40B0020-00 [I,A]; C40B0040-02 [I,C*]; C40B0040-02 [I,A]; C40B0050-06 [I,C*]; C40B0050-06 [I,A]; G01N0033-15 [I,C*]; G01N0033-15 [I,A]; G01N0033-566 [I,C*]; G01N0033-566 [I,A]; G01N0033-68 [I,C*]; G01N0033-68 [I,A]
JP 2002517437	ECLA	A61K047/48H4M; A61K047/48R4; G01N033/68F; S01N
	IPCI	C07C0217-16 [ICM,7]; C07C0217-00 [ICM,7,C*]; A61K0045-00 [ICS,7]; A61P0043-00 [ICS,7]; C07B0061-00 [ICS,7]; C07K0002-00 [ICS,7]; G01N0033-15 [ICS,7]; G01N0033-50 [ICS,7]; G01N0033-566 [ICS,7]
	IPCR	G01N0033-50 [I,C*]; G01N0033-50 [I,A]; A61K0045-00 [I,C*]; A61K0045-00 [I,A]; A61K0047-48 [I,C*]; A61K0047-48 [I,A]; A61P0043-00 [I,C*]; A61P0043-00 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0217-00 [I,C*]; C07C0217-16 [I,A]; C07K0002-00 [I,C*]; C07K0002-00 [I,A]

[I,C*]; C07K0002-00 [I,A]; C40B0020-00 [I,C*];
 C40B0020-00 [I,A]; C40B0040-02 [I,C*]; C40B0040-02
 [I,A]; C40B0050-06 [I,C*]; C40B0050-06 [I,A];
 G01N0033-15 [I,C*]; G01N0033-15 [I,A]; G01N0033-566
 [I,C*]; G01N0033-566 [I,A]; G01N0033-68 [I,C*];
 G01N0033-68 [I,A]
 ZA 2000004562 IPCI A61K [ICM,7]; C07K [ICS,7]; G01N [ICS,7]
 ZA 2000004563 IPCI A61K [ICM,7]; C07K [ICS,7]; G01N [ICS,7]
 ZA 2000004564 IPCI A61K [ICM,7]; C07K [ICS,7]; G01N [ICS,7]
 US 6479498 IPCI C07D0239-42 [ICM,7]; C07D0239-48 [ICS,7]; C07D0239-00
 [ICS,7,C*]; A61K0031-505 [ICS,7]
 IPCR C07D0239-00 [I,C*]; C07D0239-48 [I,A]
 NCL 514/256.000; 514/275.000; 544/325.000; 544/326.000;
 544/327.000; 544/329.000
 ECLA A61K047/48H4M; C07D239/48B4
 US 20030044845 IPCI G01N0033-53 [ICM,7]; C07D0041-02 [ICS,7]
 IPCR A61K0047-48 [I,C*]; A61K0047-48 [I,A]; G01N0033-68
 [I,C*]; G01N0033-68 [I,A]
 NCL 435/007.100; 546/140.000
 ECLA A61K047/48H4M; A61K047/48R4; G01N033/68F; S01N
 OS MARPAT 137:93597
 GI



AB Title compds. I [R20 = H, Me, ethyl; X = linker X'-Z-(Y'-Z)m-Y''-Z-X'; m
 =
 0-20; X' = O, S, NR, CO, CO2, CONR, CS, CSO, CSNR, covalent bond; Z =
 alkylene, cycloalkylene, alkenylene, alkynylene, cycloalkenylene,
 arylene,
 heteroarylene, heterocyclene, covalent bond; Y', Y'' = carboxamide,
 amido,
 ureido, amidino, etc., covalent bond; R, R', R'' = H, alkyl, cycloalkyl,
 alkenyl, cycloalkenyl, alkynyl, aryl, heteroaryl, heterocyclic] were
 prepared as sodium channel modulators. For instance, 2,6-dimethylphenol
 was
 alkylated with chloroacetone (DMF, K2CO3, KI, 80°), the product
 reacted with 1,8-diamino-3,6-dioxaoctane (EtOH, 12 h, 25°) and the
 resulting imine reduced (NaBH4, 2 h, 25°) to give I [R20 = H; X =
 (CH2)2-O-(CH2)2-O-(CH2)2]. I are useful in the treatment of pain.
 ST pain sodium channel modulator phenol aryether prepn
 IT Analgesics
 Human
 Pain
 (preparation and use of phenoxyalkylamino-linked dimers as sodium
 channel
 modulators)

IT Sodium channel

RL: BSU (Biological study, unclassified); BIOL (Biological study)
(preparation and use of phenoxyalkylamino-linked dimers as sodium
channel

modulators)

IT	130800-99-6	130801-05-7	1026191-95-6	1026400-10-1	1026613-97-7
	1026806-00-7	1026862-57-6	1026888-92-5	1027914-34-6	1098609-23-4
	1098609-24-5	1098609-25-6	1098609-26-7	1098609-27-8	1098609-28-9
	1098609-29-0	1098609-30-3	1098609-31-4	1098609-32-5	1098609-33-6
	1098609-34-7	1098609-35-8	1098609-36-9	1098609-37-0	1098609-38-1
	1098609-39-2	1098609-40-5	1098609-41-6	1098609-42-7	1098609-43-8
	1098609-44-9	1098609-45-0	1098609-46-1	1098609-47-2	1098609-48-3

RL: PRPH (Prophetic)

(Preparation and use of phenoxyalkylamino-linked dimers as sodium
channel modulators)

IT	442626-25-7P	442626-26-8P	442626-27-9P	442626-28-0P	442626-29-1P
	442626-30-4P	442626-31-5P	442626-32-6P	442626-33-7P	442626-34-8P
	442626-35-9P	442626-36-0P	442626-37-1P	442626-38-2P	442626-39-3P
	442626-40-6P	442626-41-7P	442626-42-8P	442626-43-9P	442626-44-0P
	442626-45-1P	442626-46-2P	442626-47-3P	442626-48-4P	442626-49-5P
	442626-50-8P	442626-51-9P	442626-52-0P	442626-53-1P	442626-54-2P
	442626-56-4P	442626-57-5P	442626-58-6P	442626-59-7P	442626-60-0P
	442626-61-1P	442626-62-2P	442626-63-3P	442626-64-4P	442626-65-5P
	442626-66-6P	442626-67-7P	442626-68-8P	442626-69-9P	442626-70-2P
	442626-71-3P	442626-72-4P	442626-73-5P	442626-74-6P	442626-75-7P
	442626-76-8P	442626-77-9P	442626-78-0P	442626-79-1P	442626-80-4P
	442626-81-5P	442626-82-6P	442626-83-7P	442626-84-8P	442626-85-9P
	442626-86-0P	442626-87-1P	442626-88-2P	442626-89-3P	442626-90-6P
	442626-91-7P	442626-92-8P	442626-94-0P	442626-96-2P	442626-97-3P
	442626-98-4P	442626-99-5P	442627-00-1P	442627-01-2P	442627-02-3P
	442627-03-4P	442627-04-5P	442627-05-6P	442627-06-7P	442627-07-8P
	442627-08-9P	442627-09-0P	442627-10-3P	442627-11-4P	442627-12-5P
	442627-14-7P	442627-16-9P	442627-18-1P	442627-20-5P	442627-22-7P
	442627-24-9P	442627-26-1P	442627-28-3P	442627-30-7P	442627-32-9P
	442627-34-1P	442627-36-3P	442627-38-5P	442627-40-9P	442627-42-1P
	442627-44-3P	442627-46-5P	442627-47-6P	442627-48-7P	442627-49-8P
	442627-50-1P	442627-51-2P	442627-52-3P	442627-53-4P	442627-54-5P
	442627-55-6P	442627-56-7P	442627-57-8P	442627-58-9P	442627-59-0P
	442627-60-3P	442627-61-4P	442627-62-5P	442627-63-6P	442627-64-7P
	442627-65-8P	442627-66-9P	442627-67-0P	442627-68-1P	442627-69-2P
	442627-70-5P	442627-71-6P	442627-72-7P	442627-73-8P	442627-74-9P
	442627-75-0P	442627-76-1P	442627-77-2P	442627-78-3P	442627-79-4P
	442627-80-7P	442627-81-8P	442627-82-9P	442627-83-0P	442627-84-1P
	442627-85-2P	442627-86-3P	442627-87-4P	442627-88-5P	442627-89-6P
	442627-90-9P	442627-91-0P	442627-92-1P	442627-93-2P	442627-94-3P
	442627-95-4P	442627-96-5P	442627-97-6P	442627-98-7P	442627-99-8P
	442628-00-4P	442628-01-5P	442628-02-6P	442628-03-7P	442628-04-8P
	442628-05-9P	442628-06-0P	442628-07-1P	442628-08-2P	442628-09-3P
	442628-10-6P	442628-11-7P	442628-12-8P	442628-13-9P	442628-14-0P
	442628-15-1P	442628-16-2P	442628-17-3P	442628-18-4P	442628-19-5P
	442628-20-8P	442628-21-9P	442628-22-0P	442628-23-1P	442628-24-2P
	442628-25-3P	442628-26-4P	442628-27-5P	442628-28-6P	442628-29-7P
	442628-30-0P	442628-31-1P	442628-32-2P	442628-33-3P	442628-34-4P
	442628-36-6P	442628-37-7P	442628-42-4P	442629-08-5P	

RL: PAC (Pharmacological activity); SPN (Synthetic preparation); THU

(Therapeutic use); BIOL (Biological study); PREP (Preparation); USES (Uses)

(drug; preparation and use of phenoxyalkylamino-linked dimers as sodium channel modulators)

IT 3218-45-9P 14279-79-9P 38594-42-2P, 2,3-Dichlorobenzyl alcohol
 53012-41-2P 61920-61-4P 130833-20-4P 154474-89-2P 188951-29-3P
 194027-20-8P 442628-35-5P 442628-39-9P 442628-40-2P 442628-43-5P
 442628-44-6P 442628-45-7P 442628-46-8P 442628-47-9P 442628-48-0P
 442628-49-1P 442628-50-4P 442628-51-5P 442628-52-6P 442628-53-7P
 442628-54-8P 442628-55-9P 442628-56-0P 442628-57-1P 442628-58-2P
 442628-59-3P 442628-61-7P 442628-62-8P 442628-63-9P 442628-64-0P
 442628-65-1P 442628-66-2P 442628-67-3P 442628-68-4P 442628-69-5P
 442628-70-8P 442628-71-9P 442628-72-0P 442628-73-1P 442628-74-2P
 442628-75-3P 442628-76-4P 442628-77-5P 442628-79-7P 442628-81-1P
 442628-83-3P 442628-84-4P 442628-86-6P 442628-88-8P 442628-90-2P
 442628-91-3P 442628-92-4P 442628-93-5P 442628-94-6P 442628-95-7P
 442628-96-8P 442628-97-9P 442628-98-0P 442628-99-1P 442629-00-7P
 442629-01-8P

RL: RCT (Reactant); SPN (Synthetic preparation); PREP (Preparation); RACT (Reactant or reagent)

(intermediate; preparation and use of phenoxyalkylamino-linked dimers

as

sodium channel modulators)

IT 78-95-5, Chloroacetone 96-13-9, 2,3-Dibromo-1-propanol 96-21-9,
 1,3-Dibromo-2-propanol 101-77-9, 4,4'-Diaminodiphenylmethane
 105-83-9,

N,N-Bis(3-aminopropyl)methylamine 107-15-3, 1,2-Diaminoethane,

reactions

109-76-2, 1,3-Diaminopropane 110-60-1, 1,4-Diaminobutane 110-85-0,
 Piperazine, reactions 111-91-1, Bis(2-chloroethoxymethane) 112-26-5,
 1,2-Bis(2-chloroethoxyethane) 124-09-4, 1,6-Diaminohexane, reactions
 373-44-4, 1,8-Diaminooctane 462-94-2, 1,5-Diaminopentane 525-64-4,
 2,7-Diaminofluorene 534-08-7, 1,3-Diiodo-2-propanol 539-48-0,
 α,α' -Diamino-p-xylene 576-26-1, 2,6-Dimethylphenol
 600-05-5, 2,3-Dibromopropionic acid 616-29-5, 1,3-Diamino-2-propanol
 623-24-5, α,α' -Dibromo-p-xylene 623-97-2, Carbonic acid
 bis(2-chloroethyl) ester 626-15-3, α,α' -Dibromo-m-xylene
 626-19-7, Isophthalaldehyde 627-31-6, 1,3-Diiodopropane 629-09-4,
 1,6-Diiodohexane 638-56-2, Bis[2-(2-chloroethoxy)ethyl]ether
 821-06-7,
 trans-1,4-Dibromo-2-butene 821-10-3, 1,4-Dichloro-2-butyne 871-76-1,
 2,2'-Thiobis(ethylamine) 929-59-9, 1,8-Diamino-3,6-dioxaoctane
 932-41-2, 2,3-Thiophenedicarboxaldehyde 932-95-6,
 2,5-Thiophenedicarboxaldehyde 1123-63-3, 4-Chloro-2,6-dimethylphenol
 1477-55-0, α,α' -Diamino-m-xylene 1667-10-3
 1871-57-4, 3-Chloro-2-chloromethyl-1-propene 2092-49-1 2157-24-6,
 Bis(3-aminopropyl)ether 2233-18-3, 3,5-Dimethyl-4-hydroxybenzaldehyde
 2417-04-1, 3,3',5,5'-Tetramethyl[1,1'-biphenyl]-4,4'-diol 2549-93-1,
 1,4-Cyclohexanebis-methylamine 2579-20-6,
 1,3-Cyclohexanebis(methylamine) 2615-25-0, trans-1,4-Diaminocyclohexane
 2716-10-1 2752-17-2, 1,5-Diamino-3-oxapentane 3138-86-1,
 2,3-Bis(bromomethyl)quinoxaline 3328-70-9, 5-Formylsalicylaldehyde
 3344-70-5, 1,12-Dibromododecane 3674-13-3, Ethyl 2,3-dibromopropionate
 3967-55-3, 4,5-Dichloro-1,3-dioxolan-2-one 4097-88-5,

N,N-Bis(2-aminoethyl)methylamine 4246-51-9,
 4,7,10-Trioxa-1,13-tridecanediamine 4338-95-8 4549-31-9,
 1,7-Dibromooheptane 4549-32-0, 1,8-Dibromooctane 4549-33-1,
 1,9-Dibromononane 5370-01-4, Mexiletine hydrochloride 5431-44-7,
 2,6-Pyridinedicarboxaldehyde 6065-82-3, Ethyl 2,2-diethoxyacetate
 6334-18-5, 2,3-Dichlorobenzaldehyde 6334-96-9, Bis(4-chlorobutyl)ether
 6941-69-1 7209-38-3, 1,4-Bis(3-aminopropyl)piperazine 7300-34-7
 7310-95-4, 2-Hydroxy-5-methylisophthalaldehyde 7328-91-8,
 2,2-Dimethyl-1,3-diaminopropane 7703-74-4, 2,6-Bis(bromomethyl)pyridine
 16355-92-3, 1,10-Diiododecane. 16696-65-4, 1,11-Dibromoundecane
 16813-43-7, N,N'-Bis(2-chloroethyl)oxamide 17954-12-0 21587-74-6,
 3,9-Bis(3-aminopropyl)-2,4,8,10-tetraoxaspiro[5,5]undecane 24613-65-8,
 1,9-Diiodononane 24772-63-2, 1,8-Diiodooctane 25513-64-8
 31828-71-4,
 Mexiletine 36839-55-1, 1,2-Bis(2-iodoethoxy)ethane 45223-18-5,
 1,16-Dibromohexadecane 49590-51-4, Bis(2-formylphenyl)ether
 52118-10-2
 58342-57-7 64028-78-0 64621-35-8 85275-45-2,
 N-Boc-3-hydroxypiperidine 87816-56-6, 1,5-Diamino-3-mercaptopentane
 89151-44-0, N-Boc-4-piperidinethanol 91452-27-6 103057-44-9,
 N-Boc-3-pyrrolidinol 118811-03-3, N-Boc-2-piperidineethanol
 146667-84-7, N-Boc-3-piperidineethanol 152120-54-2 442628-38-8
 442628-41-3 442628-60-6 442628-78-6 442628-80-0 442628-85-5
 442628-87-7 442628-89-9
 RL: RCT (Reactant); RACT (Reactant or reagent)
 (reactant; preparation and use of phenoxyalkylamino-linked dimers as
 sodium

channel modulators)
 RE.CNT 59 THERE ARE 59 CITED REFERENCES AVAILABLE FOR THIS RECORD
 RE

- (1) Aebischer; US 5011472 A 1991
- (2) Anon; DE 2300543 1974 CAPLUS
- (3) Anon; EP 372934 A2 1990 CAPLUS
- (4) Anon; EP 372934 B1 1990 CAPLUS
- (5) Anon; EP 0459829 A1 1991 CAPLUS
- (6) Anon; WO 9304048 1993 CAPLUS
- (7) Anon; WO 9306121 1993 CAPLUS
- (8) Anon; DE 4240981 1994 CAPLUS
- (9) Anon; WO 9620934 1996 CAPLUS
- (10) Anon; WO 9620935 1996 CAPLUS
- (11) Anon; WO 9709317 1997 CAPLUS
- (12) Anon; WO 9727169 1997 CAPLUS
- (13) Anon; EP 0869119 A1 1998 CAPLUS
- (14) Anon; CA 2240325 1998 CAPLUS
- (15) Anon; WO 9838174 1998 CAPLUS
- (16) Barberich; US 5571827 A 1996 CAPLUS
- (17) Barclay; US 4902514 A 1990 CAPLUS
- (18) Berger; US 5688830 A 1997 CAPLUS
- (19) Bernatowicz; Tetrahedron Letters 1993, V34(21), P3389
- (20) Bossert; Angew, Chem Int Ed 1981, V20, P762
- (21) Brenner; Proc Nat'l Acad Sci, USA 1992, V89, P5381 CAPLUS
- (22) Choi; J Neurosci 1987, V7(2), P357 CAPLUS
- (23) Choi; J Neurosci 1987, V7(2), P369 CAPLUS
- (24) Cole; Angew Chem Int'l Ed Engl 1996, V35(15), P1668 CAPLUS
- (25) Costall, B; Neuropharmacol 1987, V26, P195 CAPLUS

- (26) Dalby, N; Epilepsy Research 1997, V28, P63 CAPLUS
- (27) Davis; J Med Chem 1995, V38(22), P4363 CAPLUS
- (28) Denyer; Drug Discovery Today 1998, V3(7), P323 CAPLUS
- (29) Doggrell; Ion Channel Modulators as Potential Positive Inotropic Compounds for Treatment of Heart Failure: Clinical and Experimental Pharmacology and Physiology 1994, V21, P833 CAPLUS
- (30) Doig, M; J Chrom 1991, V554(1/02), P181
- (31) Dubuisson, D; Pain 1977, V4, P161 CAPLUS
- (32) Fesik; US 5891643 A 1999 CAPLUS
- (33) Gallop; US 5846839 A 1998 CAPLUS
- (34) Gee; J Biol Chem 1994, V273(34), P21980
- (35) Geoghegan; US 5616345 A 1997 CAPLUS
- (36) Goldin; US 5686495 A 1997 CAPLUS
- (37) Heuttner, J; J Neurosci 1986, V6, P3044
- (38) Hodges; US 5738996 A 1998 CAPLUS
- (39) Hsieh; US 5023252 A 1991 CAPLUS
- (40) Hunter, J; Current Opinion in CPNS Investigational Drugs 1999, V1(1), P72 CAPLUS
- (41) Hunter, J; Eur J Pharmacol 1997, V324(153)
- (42) Kuo; Br J Pharm 1997, V121, P1231 CAPLUS
- (43) Kuo; Mol Pharmacology 1998, V54, P712 CAPLUS
- (44) Lawter; US 4992445 A 1991 CAPLUS
- (45) Lawter; US 5001139 A 1991 CAPLUS
- (46) Liang; Science 1996, V274, P1520 CAPLUS
- (47) Loughhead; J Org Chem 1999, V64, P3373 CAPLUS
- (48) Melchiorre, C; Trends Pharmacol Sci 1989, V10(Suppl), P55
- (49) Menger; J Org Chem 1995, V60, P6666 CAPLUS
- (50) O'Neill, M; Eur J Pharmacol 1997, V332, P121 CAPLUS
- (51) Portuguese, P; J Med Chem 1992, V35(11), P1927
- (52) Shephard, S; Neuropharmacology V34(3), P255 CAPLUS
- (53) Shuker; Science 1996, V274, P1531 CAPLUS
- (54) Southam, E; Eur J Pharmacol 1998, V358, P19 CAPLUS
- (55) Swanson; US 4326525 A 1982
- (56) Theeuwes; US 3845770 A 1974 CAPLUS
- (57) Ther, L; Dtsh Apoth Zig 1963, V103, P514 CAPLUS
- (58) Whalley; PACE 1995, V18(Part I), P1686
- (59) Zeitlin; US 5985933 A 1999 CAPLUS

L3 ANSWER 9 OF 13 CAPLUS COPYRIGHT 2009 ACS on STN

AN 1998:307266 CAPLUS

DN 129:54744

OREF 129:11413a,11416a

ED Entered STN: 25 May 1998

TI Bis(aryloxymethyl)arenes, their preparation, and manufacture of novolaks therefrom

IN Hasegawa, Ryoichi; Akatsuka, Yasumasa; Watanabe, Eiko

PA Nippon Kayaku Co., Ltd., Japan

SO Jpn. Kokai Tokkyo Koho, 6 pp.

CODEN: JKXXAF

DT Patent

LA Japanese

IC ICM C07C043-20

ICS B01J031-02; C07C041-01; C07C043-257; C08G010-02; C07B061-00

CC 35-5 (Chemistry of Synthetic High Polymers)

FAN.CNT 1

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	JP 10130186	A	19980519	JP 1996-300879	19961028
PRAI	JP 1996-300879		19961028		

	PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
JP	10130186	ICM	C07C043-20
		ICS	B01J031-02; C07C041-01; C07C043-257; C08G010-02; C07B061-00
		IPCI	C07C0043-20 [ICM,6]; B01J0031-02 [ICS,6]; C07C0041-01 [ICS,6]; C07C0043-257 [ICS,6]; C08G0010-02 [ICS,6]; C07B0061-00 [ICS,6]
		IPCR	B01J0031-02 [I,C*]; B01J0031-02 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0041-00 [I,C*]; C07C0041-01 [I,A]; C07C0043-00 [I,C*]; C07C0043-20 [I,A]; C07C0043-257 [I,A]; C08G0010-00 [I,C*]; C08G0010-02 [I,A]

OS MARPAT 129:54744

AB R10CH2R2CH2OR3 [R2 = (un)substituted C6H4, C6H4XC6H4, C10H6; R1, R2 = (un)substituted Ph, C6H4XPh, C10H7; the substituents are alkyl, alkenyl, aryl, halo, aralkyl; X = O, CH2, direct link] are prepared by reacting bis(halomethyl)arenes with aromatic hydroxy compds. in the presence of alkaline substances. R5CH2R2CH2(R4CH2R2CH2)mR6 (R2, R4 defined as R2 above having ≥ 1 OH substituent; R5, R6 defined as R1 above having ≥ 1 OH substituent; m = 0-10) are prepared via the above diethers without formation of byproducts and gelation. Thus, 4,4'-bis(chloromethyl)biphenyl was gradually added to a mixture of DMSO, K2CO3, and PhOH at 75° over 0.5 h, and the reaction mixture was further stirred at 85° for 2 h to give 4,4'-bis(phenoxyethyl)biphenyl. This further reacted with PhOH and MeSO3H at 150° for 1 h to give 4,4'-bis(hydroxybenzyl)biphenyl showing softening point 102° and melt viscosity 1.0 P at 150°.

ST aryloxymethylarene prepn material novolak; arene bisaryloxymethyl prep material novolak; halomethylarene dehydrohalogenation phenol

IT Poly(arylenealkylenes)
 RL: IMF (Industrial manufacture); PREP (Preparation)
 (hydroxy-containing; preparation of bis(aryloxymethyl)arenes and novolaks therefrom)

IT Phenolic resins, preparation
 RL: IMF (Industrial manufacture); PREP (Preparation)
 (novolak; preparation of bis(aryloxymethyl)arenes and novolaks therefrom)

IT 208254-04-0P
 RL: IMF (Industrial manufacture); PREP (Preparation)
 (novolak; preparation of bis(aryloxymethyl)arenes and novolaks therefrom)

IT 208518-22-3P 208534-89-8P
 RL: IMF (Industrial manufacture); PREP (Preparation)
 (preparation of bis(aryloxymethyl)arenes and novolaks therefrom)

IT 10403-79-9P, 1,4-Bis(phenoxyethyl)benzene 63405-62-9P,
 4,4'-Bis(phenoxyethyl)biphenyl

RL: IMF (Industrial manufacture); RCT (Reactant); PREP (Preparation);
 RACT

(Reactant or reagent)
 (preparation of bis(aryloxymethyl)arenes and novolaks therefrom)

IT 108-95-2, Phenol, reactions 623-25-6,
 1,4-Bis(chloromethyl)benzene 1667-10-3,
 4,4'-Bis(chloromethyl)biphenyl

RL: RCT (Reactant); RACT (Reactant or reagent)
 (preparation of bis(aryloxymethyl)arenes and novolaks therefrom)

L3 ANSWER 10 OF 13 CAPLUS COPYRIGHT 2009 ACS on STN

AN 1989:7865 CAPLUS

DN 110:7865

OREF 110:1435a,1438a

ED Entered STN: 06 Jan 1989

TI process for the preparation of aromatic or heteroaromatic diacetic acid
 esters as monomers

IN Kobayashi, Toshiaki; Abe, Fujiro; Tanaka, Masato

PA Agency of Industrial Sciences and Technology, Japan

SO Jpn. Kokai Tokkyo Koho, 6 pp.

CODEN: JKXXAF

DT Patent

LA Japanese

IC ICM C07C069-612

ICS B01J031-22; C07C067-36; C07D333-24

CC 25-18 (Benzene, Its Derivatives, and Condensed Benzenoid Compounds)
 Section cross-reference(s): 35

FAN.CNT 1

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
JP 63119441	A	19880524	JP 1986-263265	19861105
JP 06011733	B	19940216		
PRAI JP 1986-263265		19861105		

CLASS

PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
JP 63119441	ICM	C07C069-612
	ICS	B01J031-22; C07C067-36; C07D333-24
	IPCI	C07C0069-612 [ICM,4]; C07C0069-00 [ICM,4,C*]; B01J0031-22 [ICS,4]; B01J0031-16 [ICS,4,C*]; C07C0067-36 [ICS,4]; C07C0067-00 [ICS,4,C*]; C07D0333-24 [ICS,4]; C07D0333-00 [ICS,4,C*]
	IPCR	C07D0333-00 [I,C*]; C07D0333-24 [I,A]; B01J0031-00 [I,C*]; B01J0031-00 [I,A]; B01J0031-16 [I,C*]; B01J0031-18 [I,A]; B01J0031-22 [I,A]; C07B0061-00 [I,C*]; C07B0061-00 [I,A]; C07C0067-00 [I,C*]; C07C0067-36 [I,A]; C07C0069-00 [I,C*]; C07C0069-612 [I,A]

OS MARPAT 110:7865

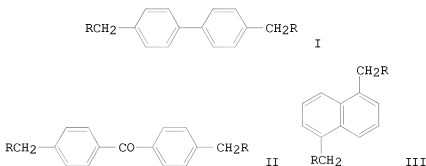
AB Z(CH2CO2R)2 (R = C1-10 alkyl, cycloalkyl, aralkyl, aryl; Z = divalent
 aromatic or heteroarom. ring which may have inert substituents and/or are
 polycyclic or condensed ring), useful as monomers, are prepared by
 treatment

of Z(CH2X)2 (X = halo) with ROH and CO in the presence of basic compds.
 and Pd-containing catalysts. A mixture of p-C6H4(CH2Cl)2, MeOH,

- dicyclohexylmethylamine, and PdCl₂(PPh₃)₂ was autoclaved at 80° under 20 atm CO for 4 h to give 88.8% p-C₆H₄(CH₂CO₂Me)₂.
- ST arom acetate ester prepn monomer; heteroarom diacetic acid ester monomer; halomethylarene alkoxy carbonylation palladium catalyst; arene bishalomethyl alkoxy carbonylation palladium catalyst
- IT Bases, uses and miscellaneous
RL: USES (Uses)
(organic, (alkoxy or aryloxy) carbonylation of aromatic or heteroarom. dihalides in presence of)
- IT 121-44-8, Triethylamine, uses and miscellaneous
RL: USES (Uses)
(alkoxy or aryloxy) carbonylation of aromatic or heteroarom. dihalides in presence of)
- IT 102-82-9, Tributylamine 918-02-5, tert-Butyldimethylamine 4567-22-0, 2,2,5,5-Tetramethylpyrrolidine 7087-68-5, Diisopropylethylamine 7560-83-0
RL: RCT (Reactant); RACT (Reactant or reagent)
(alkoxy or aryloxy) carbonylation of aromatic or heteroarom. dihalides in presence of)
- IT 623-24-5, α, α' -Dibromo-p-xylene 1667-10-3, 4,4'-Bis(chloromethyl)biphenyl 1733-76-2, 1,5-Bis(chloromethyl)naphthalene 2362-18-7, 4,4'-Bis(chloromethyl)diphenyl ether 14568-83-3 23063-36-7, α, α' -Dichloro-p-xylene 28569-48-4, 2,5-Bis(chloromethyl)thiophene 31315-55-6, Bis(4-chloromethylphenyl) ketone
RL: RCT (Reactant); RACT (Reactant or reagent)
(alkoxy or aryloxy) carbonylation of, catalysts for)
- IT 64-17-5, Ethanol, reactions 67-56-1, Methanol, reactions 67-63-0, Isopropanol, reactions 75-65-0, tert-Butanol, reactions 108-95-2, Phenol, reactions
RL: RCT (Reactant); RACT (Reactant or reagent)
(alkoxy or aryloxy) carbonylation with, of aromatic or heteroarom. dihalides, catalysts for)
- IT 13965-03-2 14221-01-3 29934-17-6 29964-62-3 54081-37-7 57457-62-2 72287-26-4
RL: CAT (Catalyst use); USES (Uses)
(catalyst, for (alkoxy or aryloxy) carbonylation of aromatic or heteroarom. dihalides)
- IT 5633-26-1P 7487-16-3P 36076-25-2P 57186-87-5P 115414-88-5P 115414-90-9P 115414-91-0P
RL: SPN (Synthetic preparation); PREP (Preparation)
(preparation of)
- L3 ANSWER 11 OF 13 CAPLUS COPYRIGHT 2009 ACS on STN
AN 1988:454438 CAPLUS
DN 109:54438
OREF 109:9167a,9170a
ED Entered STN: 19 Aug 1988
TI Palladium complex-catalyzed carboalkoxylation of bis(chloromethyl)arenes
AU Kobayashi, Toshiaki; Abe, Fujio; Tanaka, Masato
CS Natl. Chem. Lab. Ind., Yatabe, 305, Japan

10/585699

SO Journal of Molecular Catalysis (1988), 45(1), 91-109
CODEN: JMCADS; ISSN: 0304-5102
DT Journal
LA English
CC 25-18 (Benzene, Its Derivatives, and Condensed Benzenoid Compounds)
OS CASREACT 109:54438
GI



AB Carboalkoxylation of 4-ClCH₂C₆H₄CH₂Cl with ROH (R = Me, Et, Me₂CH, Me₃C, Ph) and CO in the presence of PdCl₂(PPh₃)₂ and N,N-dicyclohexylmethylamine gave diesters 4-RO₂CCH₂C₆H₄CH₂CO₂R as the major products. A similar reaction of 8 other bis(chloromethyl)arenes, e.g. I, II, and III (R = Cl), with MeOH and CO gave the corresponding diesters I, II, and III (R = CO₂Me). Reaction parameters, such as auxiliary base, palladium complex catalyst, and solvent, were found to significantly affect the selectivity for diester formation.

ST carboalkoxylation bischloromethylarene alc carbon monoxide; alkoxy carbonylation bischloromethylarene alc; alkoxy carbonylmethylarene; arene bisalkoxy carbonylmethyl; palladium complex alkoxy carbonylation catalyst bischloromethylarene

IT Alkoxy carbonylation (of bis(chloromethyl)arene by carbon monoxide and alcs.)

IT Alkoxy carbonylation catalysts (palladium complexes, for bis(chloromethyl)arenes with carbon monoxide and alcs.)

IT 67-56-1, Methanol, reactions
RL: RCT (Reactant); RACT (Reactant or reagent)
(alkoxy carbonylation by, of bis(chloromethyl)arenes)

IT 64-17-5, Ethanol, reactions 67-63-0, 2-Propanol, reactions 75-65-0, reactions 108-95-2, Phenol, reactions
RL: RCT (Reactant); RACT (Reactant or reagent)
(alkoxy carbonylation by, of bis(chloromethyl)benzene)

IT 623-24-5 623-25-6, 1,4-Bis(chloromethyl)benzene 1667-10-3
1733-76-2 2362-18-7 10387-13-0 14568-83-3 31315-55-6
115414-79-4
RL: RCT (Reactant); RACT (Reactant or reagent)

(alkoxycarbonylation of, by carbon monoxide and alcs.)
 IT 630-08-0, Carbon monoxide, reactions
 RL: RCT (Reactant); RACT (Reactant or reagent)
 (alkoxycarbonylation with alcs., of bis(chloromethyl)arenes)
 IT 13965-03-2 14126-26-2 14221-01-3 19978-61-1 29934-17-6
 54081-37-7 72287-26-4 79500-51-9
 RL: CAT (Catalyst use); USES (Uses)
 (catalyst, for alkoxycarbonylation of bis(chloromethyl)arenes by
 carbon
 monoxide and alc.)
 IT 57457-62-2P 58465-93-3P
 RL: SPN (Synthetic preparation); PREP (Preparation)
 (preparation and catalyst, for alkoxycarbonylation of
 bis(chloromethyl)arenes by carbon monoxide and alcs.)
 IT 2509-26-4P 5633-26-1P 6770-38-3P 10519-66-1P 23786-13-2P
 36076-25-2P 36076-26-3P 52889-83-5P 57186-87-5P 72770-09-3P
 94549-58-3P 115414-80-7P 115414-81-8P 115414-82-9P 115414-83-0P
 115414-84-1P 115414-85-2P 115414-86-3P 115414-87-4P 115414-88-5P
 115414-89-6P 115414-90-9P 115414-91-0P
 RL: SPN (Synthetic preparation); PREP (Preparation)
 (preparation of)
 IT 1159-54-2, Tris(p-chlorophenyl)phosphine 13991-08-7
 RL: RCT (Reactant); RACT (Reactant or reagent)
 (reaction of, with dichlorobis(benzonitrile)palladium)
 IT 14220-64-5, Dichlorobis(benzonitrile)palladium
 RL: RCT (Reactant); RACT (Reactant or reagent)
 (reaction of, with phosphines)
 L3 ANSWER 12 OF 13 CAPLUS COPYRIGHT 2009 ACS on STN
 AN 1979:492531 CAPLUS
 DN 91:92531
 OREF 91:14959a,14962a
 ED Entered STN: 12 May 1984
 TI Crosslinked epoxide resin compositions having flame-retardant properties
 IN Randell, Donald Richard; Hyde, Thomas Gerald; Lamb, Frank; Clubley, Brian
 George; Dobinson, Bryan; Bagga, Madan Mohan
 PA Ciba-Geigy A.-G., Switz.
 SO S. African, 50 pp.
 CODEN: SFXAXB
 DT Patent
 LA English
 IC C08G059-00
 CC 36-6 (Plastics Manufacture and Processing)
 FAN.CNT 1

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
	-----	---	-----	-----	-----
PI	ZA 7802445	A	19790425	ZA 1978-2445	19780428
PRAI	GB 1977-18201	A	19770430		

CLASS

PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
-----	---	-----
ZA 7802445	IC	C08G059-00
	IPCI	C08G0059-00
	IPCR	C08G0059-00 [I,C*]; C08G0059-00 [I,A]
AB	Epoxy resins with	improved flame resistance contain organic P compds. and

synergistic amts. of $Z(CH_2X)_n$ (Z = aromatic or heterocyclic ring, $n \geq 2$; X = a leaving group). Thus, bisphenol A-epichlorohydrin copolymer [25068-38-6] 100, (PhO)3PO [115-86-6] 50, and 4,4'-bis(methoxymethyl)biphenyl (I) [3753-18-2] 10 parts give a molding with Limiting O Index 53, compared with 27 in the absence of I, and 26.5 in the absence of (PhO)3PO.

ST epoxy resin fireproofing; phosphate ester fireproofing agent; methoxymethylbiphenyl fireproofing agent; biphenyl bismethoxymethyl fireproofing

IT Polyesters, uses and miscellaneous
RL: USES (Uses)
(fire retardants, for epoxy resins)

IT Epoxy resins, uses and miscellaneous
RL: POF (Polymer in formulation); USES (Uses)
(fireproofing agents for, phosphate esters and benzyl alc. derivs. as)

IT Fireproofing agents
(phosphorus compds. and benzyl alc. derivs., for epoxy resins)

IT 71229-81-7
RL: RCT (Reactant); RACT (Reactant or reagent)
(bromination of)

IT 10055-56-8 21646-18-4 63426-82-4
RL: USES (Uses)
(fire retardants, for epoxy resins)

IT 25068-38-6 27103-66-8 28906-98-1 31305-94-9
RL: POF (Polymer in formulation); USES (Uses)
(fireproofing agents for, phosphorus compds. containing synergistic agents as)

IT 91-04-3 589-29-7 1667-10-3 1667-12-5 2203-14-7 2509-47-9
3753-18-2 3883-85-0 4780-79-4 27610-47-5 34899-13-3 54835-54-0
57322-45-9 63043-46-9 63390-96-5 63391-94-6 63405-61-8
63438-89-1 71134-98-0 71134-99-1 71137-73-0 71229-80-6
RL: USES (Uses)
(fireproofing agents, for epoxy resins)

IT 115-86-6 680-31-9, uses and miscellaneous 791-28-6
RL: USES (Uses)
(flame retardants, for epoxy resins, synergists for)

IT 2425-79-8
RL: RCT (Reactant); RACT (Reactant or reagent)
(reaction of, with (hydroxymethyl)phenol)

IT 90-01-7
RL: RCT (Reactant); RACT (Reactant or reagent)
(reaction of, with butanediol diglycidyl ether)

L3 ANSWER 13 OF 13 CAPLUS COPYRIGHT 2009 ACS on STN
AN 1962:469722 CAPLUS
DN 57:69722
OREF 57:13916b-d
ED Entered STN: 22 Apr 2001
TI Novolak
IN Massengale, John T.; Bender, Frederick C.
PA American Viscose Corp.
SO 4 pp.
DT Patent
LA Unavailable

10/585699

CC	43 (Organic Coatings, Inks, and Related Products)				
PATENT NO.	KIND	DATE	APPLICATION NO.	DATE	
PI	US 3042655	19620703	US 1960-4009	19600122	

CLASS	PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
US	3042655	IPCR	C08G0008-00 [I,C*]; C08G0008-00 [I,A]

		NCL	525/503.000; 525/508.000; 528/137.000; 528/140.000; 528/141.000; 528/143.000; 528/144.000; 528/145.000; 528/212.000; 528/217.000
--	--	-----	--

AB A novolak which differs from the conventional Bakelite type has the formula I in which n is 4-10. The substance is made by treating phenol dissolved in an organic solvent with 4,4'-bis(chloromethyl)biphenyl dissolved in the same solvent in the presence of a metal halide catalyst, preferably ZnCl₂. HCl is evolved; after washing with H₂O and distilling the solvent, the novolak is obtained as a residue. For a molding or coating, thermosetting resin, the novolak (in powder form) is mixed with an aldehyde in an organic solvent, and a curing agent solution is slowly added. On heat-drying of the reaction mixture, a solid, brittle resin is obtained. This resin is suitable for molding; fillers, a molding catalyst, and a lubricant may be added. The molded thermoset products compare favorably with a Bakelite phenol-HCHO resin with respect to resistance to chemical attack.

IT Coating(s)
(from phenol condensation products, with 4,4'-bis(chloromethyl)biphenyl, chemical- and heat-resistant)

IT Phenol condensation products
(novolaks, with α,α' -dichloro-p,p'-bitolyl and chemical-and heat-resistant molded products therefrom)

IT 1667-10-3, p,p'-Bitolyl, α,α' -dichloro-
(reaction product with phenol)

=> d his

(FILE 'HOME' ENTERED AT 15:07:06 ON 10 FEB 2009)

FILE 'CAPLUS' ENTERED AT 15:07:23 ON 10 FEB 2009

L1 1 S US3042655/PN

FILE 'REGISTRY' ENTERED AT 15:07:53 ON 10 FEB 2009

L2 1 S 1667-10-3/RN
SET NOTICE 1 DISPLAY
SET NOTICE LOGIN DISPLAY

FILE 'CAPLUS' ENTERED AT 15:08:34 ON 10 FEB 2009

L3 13 S L2 AND PHENOL

=> log y

COST IN U.S. DOLLARS

SINCE FILE

TOTAL

10/585699

FULL ESTIMATED COST	ENTRY 46.68	SESSION 55.55
DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)	SINCE FILE	TOTAL
CA SUBSCRIBER PRICE	ENTRY -10.66	SESSION -11.48

STN INTERNATIONAL LOGOFF AT 15:09:23 ON 10 FEB 2009

Connecting via Winsock to STN

Welcome to STN International! Enter x:x

LOGINID:sssptau156cxh

PASSWORD:

TERMINAL (ENTER 1, 2, 3, OR ?):2

* * * * * Welcome to STN International * * * * *

NEWS 1 Web Page for STN Seminar Schedule - N. America
NEWS 2 NOV 21 CAS patent coverage to include exemplified prophetic
substances identified in English-, French-, German-,
and Japanese-language basic patents from 2004-present
NEWS 3 NOV 26 MARPAT enhanced with FSORT command
NEWS 4 NOV 26 CHEMSAFE now available on STN Easy
NEWS 5 NOV 26 Two new SET commands increase convenience of STN
searching
NEWS 6 DEC 01 ChemPort single article sales feature unavailable
NEWS 7 DEC 12 GBFULL now offers single source for full-text
coverage of complete UK patent families
NEWS 8 DEC 17 Fifty-one pharmaceutical ingredients added to PS
NEWS 9 JAN 06 The retention policy for unread STNmail messages
will change in 2009 for STN-Columbus and STN-Tokyo
NEWS 10 JAN 07 WPIDS, WPINDEX, and WPIX enhanced Japanese Patent
Classification Data
NEWS 11 FEB 02 Simultaneous left and right truncation (SLART) added
for CERAB, COMPUAB, ELCOM, and SOLIDSTATE
NEWS 12 FEB 02 GENBANK enhanced with SET PLURALS and SET SPELLING
NEWS 13 FEB 06 Patent sequence location (PSL) data added to USGENE
NEWS 14 FEB 10 COMPENDEX reloaded and enhanced
NEWS 15 FEB 11 WTEXTILES reloaded and enhanced
NEWS 16 FEB 19 New patent-examiner citations in 300,000 CA/CAPLUS
patent records provide insights into related prior
art
NEWS 17 FEB 19 Increase the precision of your patent queries -- use
terms from the IPC Thesaurus, Version 2009.01

NEWS EXPRESS JUNE 27 08 CURRENT WINDOWS VERSION IS V8.3,

10/585699

AND CURRENT DISCOVER FILE IS DATED 23 JUNE 2008.

NEWS HOURS STN Operating Hours Plus Help Desk Availability
NEWS LOGIN Welcome Banner and News Items
NEWS IPC8 For general information regarding STN implementation of IPC 8

Enter NEWS followed by the item number or name to see news on that specific topic.

All use of STN is subject to the provisions of the STN Customer agreement. Please note that this agreement limits use to scientific research. Use for software development or design or implementation of commercial gateways or other similar uses is prohibited and may result in loss of user privileges and other penalties.

* * * * * STN Columbus * * * * *

FILE 'HOME' ENTERED AT 12:41:50 ON 22 FEB 2009

=> file caplus		
COST IN U.S. DOLLARS	SINCE FILE	TOTAL
	ENTRY	SESSION
FULL ESTIMATED COST	0.22	0.22

FILE 'CAPLUS' ENTERED AT 12:42:08 ON 22 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 AMERICAN CHEMICAL SOCIETY (ACS)

Copyright of the articles to which records in this database refer is held by the publishers listed in the PUBLISHER (PB) field (available for records published or updated in Chemical Abstracts after December 26, 1996), unless otherwise indicated in the original publications. The CA Lexicon is the copyrighted intellectual property of the American Chemical Society and is provided to assist you in searching databases on STN. Any dissemination, distribution, copying, or storing of this information, without the prior written consent of CAS, is strictly prohibited.

FILE COVERS 1907 - 22 Feb 2009 VOL 150 ISS 9
FILE LAST UPDATED: 20 Feb 2009 (20090220/ED)

Caplus now includes complete International Patent Classification (IPC) reclassification data for the third quarter of 2008.

CAS Information Use Policies apply and are available at:

<http://www.cas.org/legal/infopolicy.html>

This file contains CAS Registry Numbers for easy and accurate substance identification.

=> s jp09211860/pn
L1 1 JP09211860/PN

=> d all

L1 ANSWER 1 OF 1 CAPLUS COPYRIGHT 2009 ACS on STN
 AN 1997:557769 CAPLUS
 DN 127:270481
 OREF 127:52657a,52660a
 ED Entered STN: 01 Sep 1997
 TI Epoxy acrylate-based resin compositions, resist ink compositions therefrom, and their cured products
 IN Yokoshima, Minoru; Okubo, Tetsuo; Sasahara, Kazunori
 PA Nippon Kayaku Co., Ltd., Japan
 SO Jpn. Kokai Tokkyo Koho, 10 pp.
 CODEN: JKXXAF
 DT Patent
 LA Japanese
 IC ICM G03F007-027
 ICS C08F299-02; C08G059-14; C08G059-42; C09D011-10; H05K003-28
 CC 74-5 (Radiation Chemistry, Photochemistry, and Photographic and Other Reprographic Processes)
 Section cross-reference(s): 38, 76

FAN.CNT 1

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	JP 09211860	A	19970815	JP 1996-42233	19960206

<--

	JP 3657049	B2	20050608		
PRAI	JP 1996-42233		19960206		

CLASS

PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
JP 09211860	ICM	G03F007-027
	ICS	C08F299-02; C08G059-14; C08G059-42; C09D011-10; H05K003-28
	IPCI	G03F0007-027 [ICM,6]; C08F0299-02 [ICS,6]; C08G0059-14 [ICS,6]; C08G0059-42 [ICS,6]; C09D0011-10 [ICS,6]; H05K0003-28 [ICS,6]
	IPCR	G03F0007-027 [I,C*]; G03F0007-027 [I,A]; C08F0290-00 [I,C*]; C08F0290-00 [I,A]; C08F0299-00 [I,C*]; C08F0299-02 [I,A]; C08G0059-00 [I,C*]; C08G0059-14 [I,A]; C08G0059-16 [I,A]; C08G0059-42 [I,A]; C09D0011-10 [I,C*]; C09D0011-10 [I,A]; H05K0003-28 [I,C*]; H05K0003-28 [I,A]

AB Title (resist ink) compns. contain unsatd. polycarboxylic acid-based resins prepared by successive reactions of epoxy resins Q1CH2(B1CH2Q1)nCH2B1CH2Q1 [n = 0-10; Q1 = (un)substituted glycidoxyphenyl(ene); B1 = (un)substituted biphenylene] with unsatd. monocarboxylic acids and then with polybasic carboxylic acid anhydrides. Cured products of above compns., showing excellent bending and solvent resistance, are also claimed.

ST resist ink polycarboxylic epoxy acrylate; printed circuit board resist patterning reliability; solvent resistant wiring photoresist epoxy acrylate; bending resistant wiring photoresist epoxy acrylate

IT Epoxy resins, preparation

RL: PNU (Preparation, unclassified); TEM (Technical or engineered material)

use); PREP (Preparation); USES (Uses)
 (acrylic; unsatd. polycarboxylic acid-based resist ink compns. for crack-free wirings in printed circuit boards)

IT Photoresists
 (epoxy acrylate unsatd. polycarboxylic acid-based resist ink compns. for crack-free wirings in printed circuit boards)

IT Printed circuit boards
 (unsatd. polycarboxylic acid-based resist ink compns. for crack-free wirings in printed circuit boards)

IT Light-sensitive materials
 RL: PNU (Preparation, unclassified); TEM (Technical or engineered material)

use); PREP (Preparation); USES (Uses)
 (unsatd. polycarboxylic acid-based resist ink compns. for crack-free wirings in printed circuit boards)

IT 195888-19-8P, Bis(methoxymethyl)biphenyl-epichlorohydrin-phenol copolymer acrylate-tetrahydrophthalic anhydride copolymer 195888-21-2P, Bis(methoxymethyl)biphenyl-o-cresol-epichlorohydrin copolymer acrylate-succinic anhydride copolymer 195888-22-3P, Bis(methoxymethyl)biphenyl-epichlorohydrin-phenol copolymer acrylate-Kayarad DPHA-tetrahydrophthalic anhydride copolymer 195888-23-4P, Aronix M 325-bis(methoxymethyl)biphenyl-o-cresol-epichlorohydrin copolymer acrylate-succinic anhydride-U 200AX copolymer 195888-24-5P, Aronix M 325-bis(methoxymethyl)biphenyl-o-cresol-epichlorohydrin copolymer acrylate-bis(methoxymethyl)biphenyl-epichlorohydrin-phenol copolymer acrylate-succinic anhydride-tetrahydrophthalic anhydride-U 200AX copolymer
 RL: PNU (Preparation, unclassified); TEM (Technical or engineered material)

use); PREP (Preparation); USES (Uses)
 (unsatd. polycarboxylic acid-based resist ink compns. for crack-free wirings in printed circuit boards)

=> file reg

COST IN U.S. DOLLARS

SINCE FILE	TOTAL
ENTRY	SESSION
6.62	6.84

FULL ESTIMATED COST

DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)

SINCE FILE	TOTAL
ENTRY	SESSION
-0.82	-0.82

CA SUBSCRIBER PRICE

FILE 'REGISTRY' ENTERED AT 12:43:06 ON 22 FEB 2009
 USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
 PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
 COPYRIGHT (C) 2009 American Chemical Society (ACS)

Property values tagged with IC are from the ZIC/VINITI data file provided by InfoChem.

STRUCTURE FILE UPDATES: 20 FEB 2009 HIGHEST RN 1109311-46-7
 DICTIONARY FILE UPDATES: 20 FEB 2009 HIGHEST RN 1109311-46-7

New CAS Information Use Policies, enter HELP USAGETERMS for details.

TSCA INFORMATION NOW CURRENT THROUGH January 9, 2009.

Please note that search-term pricing does apply when conducting SmartSELECT searches.

REGISTRY includes numerically searchable data for experimental and predicted properties as well as tags indicating availability of experimental property data in the original document. For information on property searching in REGISTRY, refer to:

<http://www.cas.org/support/stngen/stdoc/properties.html>

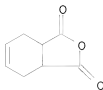
```
=> s 195888-19-8; d;s s 195888-21-2; d; s 195888-22-3; d; s 195888-23-4; d;
s 195888-24-5; d
L2      1 195888-19-8
        (195888-19-8/RN)
```

```
L2  ANSWER 1 OF 1  REGISTRY  COPYRIGHT 2009 ACS on STN
RN  195888-19-8  REGISTRY
ED  Entered STN: 23 Oct 1997
CN  1,3-Isobenzofurandione, 3a,4,7,7a-tetrahydro-, polymer with
    ar,ar'-bis(methoxymethyl)-1,1'-biphenyl polymer with
    (chloromethyl)oxirane
    and phenol 2-propenoate (9CI) (CA INDEX NAME)
OTHER CA INDEX NAMES:
CN  1,1'-Biphenyl, ar,ar'-bis(methoxymethyl)-, polymer with
    (chloromethyl)oxirane and phenol, 2-propenoate, polymer with
    3a,4,7,7a-tetrahydro-1,3-isobenzofurandione (9CI)
CN  Oxirane, (chloromethyl)-, polymer with
    ar,ar'-bis(methoxymethyl)-1,1'-biphenyl and phenol, 2-propenoate, polymer
    with 3a,4,7,7a-tetrahydro-1,3-isobenzofurandione (9CI)
CN  Phenol, polymer with ar,ar'-bis(methoxymethyl)-1,1'-biphenyl and
    (chloromethyl)oxirane, 2-propenoate, polymer with
    3a,4,7,7a-tetrahydro-1,3-isobenzofurandione (9CI)
OTHER NAMES:
CN  Bis(methoxymethyl)biphenyl-epichlorohydrin-phenol copolymer
    acrylate-tetrahydrophthalic anhydride copolymer
MF  ((C16 H18 O2 . C6 H6 O . C3 H5 Cl O)x . C8 H8 O3 . x C3 H4 O2)x
CI  PMS
PCT Polyacrylic, Polyester, Polyester formed, Polyether, Polyether formed,
    Polyether
SR  CA
LC  STN Files:  CA, CAPLUS

CM  1

CRN  85-43-8
CMF  C8 H8 O3
```

10/585699



CM 2

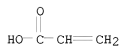
CRN 195888-18-7

CMF (C16 H18 O2 . C6 H6 O . C3 H5 Cl O)x . x C3 H4 O2

CM 3

CRN 79-10-7

CMF C3 H4 O2



CM 4

CRN 195812-11-4

CMF (C16 H18 O2 . C6 H6 O . C3 H5 Cl O)x

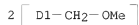
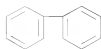
CCI PMS

CM 5

CRN 41376-21-0

CMF C16 H18 O2

CCI IDS



CM 6

CRN 108-95-2

CMF C6 H6 O

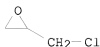
10/585699



CM 7

CRN 106-89-8

CMF C3 H5 Cl O



1 REFERENCES IN FILE CA (1907 TO DATE)

1 REFERENCES IN FILE CAPLUS (1907 TO DATE)

PROXIMITY OPERATOR LEVEL NOT CONSISTENT WITH

FIELD CODE - 'AND' OPERATOR ASSUMED 'S(W)195888-21-'

2706056 S

1 195888-21-2

(195888-21-2/RN)

L3

0 S 195888-21-2

(S(W)195888-21-2)

L3 HAS NO ANSWERS

L3 0 SEA FILE=REGISTRY S 195888-21-2

L4 1 195888-22-3

(195888-22-3/RN)

L4 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN

RN 195888-22-3 REGISTRY

ED Entered STN: 23 Oct 1997

CN 1,3-Isobenzofurandione, 3a,4,7,7a-tetrahydro-, polymer with

ar,ar'-bis(methoxymethyl)-1,1'-biphenyl polymer with

(chloromethyl)oxirane

and phenol 2-propenoate, and

2,2'-[oxybis(methylene)]bis[2-(hydroxymethyl)-

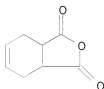
1,3-propanediol] 2-propenoate (9CI) (CA INDEX NAME)

OTHER CA INDEX NAMES:

CN 1,1'-Biphenyl, ar,ar'-bis(methoxymethyl)-, polymer with

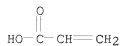
10/585699

(chloromethyl)oxirane and phenol, 2-propenoate, polymer with
2,2'-[oxybis(methylene)]bis[2-(hydroxymethyl)-1,3-propanediol]
2-propenoate, and 3a,4,7,7a-tetrahydro-1,3-isobenzofurandione (9CI)
CN 2-Propenoic acid, ester with
2,2'-[oxybis(methylene)]bis[2-(hydroxymethyl)-
1,3-propanediol], polymer with ar,ar'-bis(methoxymethyl)-1,1'-biphenyl
polymer with (chloromethyl)oxirane and phenol 2-propenoate, and
3a,4,7,7a-tetrahydro-1,3-isobenzofurandione (9CI)
CN Oxirane, (chloromethyl)-, polymer with
ar,ar'-bis(methoxymethyl)-1,1'-biphenyl and phenol, 2-propenoate, polymer
with 2,2'-[oxybis(methylene)]bis[2-(hydroxymethyl)-1,3-propanediol]
2-propenoate, and 3a,4,7,7a-tetrahydro-1,3-isobenzofurandione (9CI)
CN Phenol, polymer with ar,ar'-bis(methoxymethyl)-1,1'-biphenyl and
(chloromethyl)oxirane, 2-propenoate, polymer with
2,2'-[oxybis(methylene)]bis[2-(hydroxymethyl)-1,3-propanediol]
2-propenoate, and 3a,4,7,7a-tetrahydro-1,3-isobenzofurandione (9CI)
OTHER NAMES:
CN Bis(methoxymethyl)biphenyl-epichlorohydrin-phenol copolymer
acrylate-Kayard DPFA-tetrahydrophthalic anhydride copolymer
MF ((C16 H18 O2 . C6 H6 O . C3 H5 Cl O)x . C10 H22 O7 . C8 H8 O3 . x C3 H4
O2
O2
CI . x C3 H4 O2)x
PMS
PCT Epoxy resin, Polyacrylic, Polyester, Polyester formed, Polyether,
Polyether formed, Polyether
SR CA
LC STN Files: CA, CAPLUS



CM 2
CRN 195888-18-7
CMF (C16 H18 O2 . C6 H6 O . C3 H5 Cl O)x . x C3 H4 O2
CM 3
CRN 79-10-7
CMF C3 H4 O2

10/585699



CM 4

CRN 195812-11-4

CMF (C16 H18 O2 . C6 H6 O . C3 H5 Cl O)x

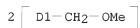
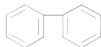
CCI PMS

CM 5

CRN 41376-21-0

CMF C16 H18 O2

CCI IDS



CM 6

CRN 108-95-2

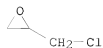
CMF C6 H6 O



CM 7

CRN 106-89-8

CMF C3 H5 Cl O



10/585699

CM 8

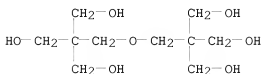
CRN 77641-99-7

CMF C10 H22 O7 . x C3 H4 O2

CM 9

CRN 126-58-9

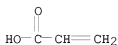
CMF C10 H22 O7



CM 10

CRN 79-10-7

CMF C3 H4 O2



1 REFERENCES IN FILE CA (1907 TO DATE)

1 REFERENCES IN FILE CAPLUS (1907 TO DATE)

L5 1 195888-23-4
(195888-23-4/RN)

L5 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN

RN 195888-23-4 REGISTRY

ED Entered STN: 23 Oct 1997

CN Hexanoic acid, 6-[(1-oxo-2-propenyl)oxy]-,
2-[tetrahydro-2,4,6-trioxo-3,5-bis[2-[(1-oxo-2-propenyl)oxy]ethyl]-1,3,5-
triazin-1(2H)-yl]ethyl ester, polymer with
ar,ar'-bis(methoxymethyl)-1,1'-biphenyl polymer with
(chloromethyl)oxirane
and 2-methylphenol 2-propenoate, dihydro-2,5-furandione and NK Oligo U
200AX (9CI) (CA INDEX NAME)

OTHER CA INDEX NAMES:

CN 1,1'-Biphenyl, ar,ar'-bis(methoxymethyl)-, polymer with
(chloromethyl)oxirane and 2-methylphenol, 2-propenoate, polymer with
dihydro-2,5-furandione, 2-[tetrahydro-2,4,6-trioxo-3,5-bis[2-[(1-oxo-2-

10/585699

propenyl)oxy]ethyl]-1,3,5-triazin-1(2H)-yl]ethyl
6-[(1-oxo-2-propenyl)oxy]hexanoate and U 200AX (9CI)
CN 2,5-Furandione, dihydro-, polymer with
ar,ar'-bis(methoxymethyl)-1,1'-biphenyl polymer with
(chloromethyl)oxirane
and 2-methylphenol 2-propenoate,
2-[tetrahydro-2,4,6-trioxo-3,5-bis[2-[(1-
oxo-2-propenyl)oxy]ethyl]-1,3,5-triazin-1(2H)-yl]ethyl
6-[(1-oxo-2-propenyl)oxy]hexanoate and U 200AX (9CI)
CN Oxirane, (chloromethyl)-, polymer with
ar,ar'-bis(methoxymethyl)-1,1'-biphenyl and 2-methylphenol, 2-propenoate,
polymer with dihydro-2,5-furandione,
2-[tetrahydro-2,4,6-trioxo-3,5-bis[2-[(1-oxo-2-propenyl)oxy]ethyl]-1,3,5-
triazin-1(2H)-yl]ethyl 6-[(1-oxo-2-propenyl)oxy]hexanoate and U 200AX
(9CI)
CN Phenol, 2-methyl-, polymer with ar,ar'-bis(methoxymethyl)-1,1'-biphenyl
and (chloromethyl)oxirane, 2-propenoate, polymer with
dihydro-2,5-furandione, 2-[tetrahydro-2,4,6-trioxo-3,5-bis[2-[(1-oxo-2-
propenyl)oxy]ethyl]-1,3,5-triazin-1(2H)-yl]ethyl
6-[(1-oxo-2-propenyl)oxy]hexanoate and U 200AX (9CI)
CN U 200AX, polymer with ar,ar'-bis(methoxymethyl)-1,1'-biphenyl polymer
with
(chloromethyl)oxirane and 2-methylphenol 2-propenoate,
dihydro-2,5-furandione and
2-[tetrahydro-2,4,6-trioxo-3,5-bis[2-[(1-oxo-2-
propenyl)oxy]ethyl]-1,3,5-triazin-1(2H)-yl]ethyl
6-[(1-oxo-2-propenyl)oxy]hexanoate (9CI)
OTHER NAMES:
CN Aronix M 325-bis(methoxymethyl)biphenyl-o-cresol-epichlorohydrin
copolymer
acrylate-succinic anhydride-U 200AX copolymer
MF (C24 H31 N3 O11 . (C16 H18 O2 . C7 H8 O . C3 H5 Cl O)x . C4 H4 O3 . x C3
H4 O2 . Unspecified)x
CI PMS
PCT Manual component, Polyacrylic, Polyester, Polyester formed, Polyether,
Polyether formed, Polyother
SR CA
LC STN Files: CA, CAPLUS

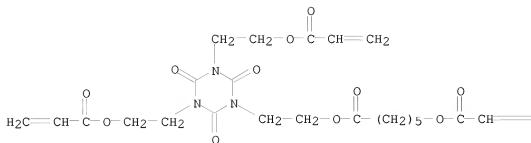
CM 1

CRN 163184-04-1
CMF Unspecified
CCI PMS, MAN

*** STRUCTURE DIAGRAM IS NOT AVAILABLE ***

CM 2

CRN 106556-00-7
CMF C24 H31 N3 O11

=CH₂

CM 3

CRN 108-30-5

CMF C4 H4 O3



CM 4

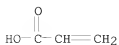
CRN 195888-20-1

CMF (C16 H18 O2 . C7 H8 O . C3 H5 Cl O)x . x C3 H4 O2

CM 5

CRN 79-10-7

CMF C3 H4 O2



10/585699

CM 6

CRN 195812-12-5

CMF (C16 H18 O2 . C7 H8 O . C3 H5 Cl O) x

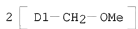
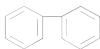
CCI PMS

CM 7

CRN 41376-21-0

CMF C16 H18 O2

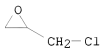
CCI IDS



CM 8

CRN 106-89-8

CMF C3 H5 Cl O



CM 9

CRN 95-48-7

CMF C7 H8 O



1 REFERENCES IN FILE CA (1907 TO DATE)

1 REFERENCES IN FILE CAPLUS (1907 TO DATE)

10/585699

L6 1 195888-24-5
(195888-24-5/RN)

L6 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN

RN 195888-24-5 REGISTRY

ED Entered STN: 23 Oct 1997

CN Hexanoic acid, 6-[(1-oxo-2-propenyl)oxy]-,
2-[tetrahydro-2,4,6-trioxo-3,5-bis[2-[(1-oxo-2-propenyl)oxy]ethyl]-1,3,5-
triazin-1(2H)-yl]ethyl ester, polymer with
ar,ar'-bis(methoxymethyl)-1,1'-biphenyl polymer with
(chloromethyl)oxirane
and 2-methylphenol 2-propenoate, ar,ar'-bis(methoxymethyl)-1,1'-biphenyl
polymer with (chloromethyl)oxirane and phenol 2-propenoate,
dihydro-2,5-furandione, NK Oligo U 200AX and
3a,4,7,7a-tetrahydro-1,3-isobenzofurandione (9CI) (CA INDEX NAME)

OTHER CA INDEX NAMES:

CN 1,1'-Biphenyl, ar,ar'-bis(methoxymethyl)-, polymer with
(chloromethyl)oxirane and 2-methylphenol, 2-propenoate, polymer contg.
(9CI)

CN 1,1'-Biphenyl, ar,ar'-bis(methoxymethyl)-, polymer with
(chloromethyl)oxirane and phenol, 2-propenoate, polymer contg. (9CI)

CN 1,3-Isobenzofurandione, 3a,4,7,7a-tetrahydro-, polymer contg. (9CI)

CN 2,5-Furandione, dihydro-, polymer contg. (9CI)

CN Oxirane, (chloromethyl)-, polymer with
ar,ar'-bis(methoxymethyl)-1,1'-biphenyl and 2-methylphenol, 2-propenoate,
polymer contg. (9CI)

CN Oxirane, (chloromethyl)-, polymer with
ar,ar'-bis(methoxymethyl)-1,1'-biphenyl and phenol, 2-propenoate, polymer
contg. (9CI)

CN Phenol, 2-methyl-, polymer with ar,ar'-bis(methoxymethyl)-1,1'-biphenyl
and (chloromethyl)oxirane, 2-propenoate, polymer contg. (9CI)

CN Phenol, polymer with ar,ar'-bis(methoxymethyl)-1,1'-biphenyl and
(chloromethyl)oxirane, 2-propenoate, polymer contg. (9CI)

CN U 200AX, polymer contg. (9CI)

OTHER NAMES:

CN Aronix M 325-bis(methoxymethyl)biphenyl-o-cresol-epichlorohydrin
copolymer

acrylate-bis(methoxymethyl)biphenyl-epichlorohydrin-phenol copolymer
acrylate-succinic anhydride-tetrahydrophthalic anhydride-U 200AX

copolymer

MF (C24 H31 N3 O11 . (C16 H18 O2 . C7 H8 O . C3 H5 Cl O)x . (C16 H18 O2 . C6
H6 O . C3 H5 Cl O)x . C8 H8 O3 . C4 H4 O3 . x C3 H4 O2 . x C3 H4 O2 .
Unspecified)x

CI PMS

PCT Manual component, Polyacrylic, Polyester, Polyester formed, Polyether,
Polyether formed, Polyether

SR CA

LC STN Files: CA, CAPLUS

CM 1

CRN 163184-04-1

CMF Unspecified

10/585699

CCI PMS, MAN

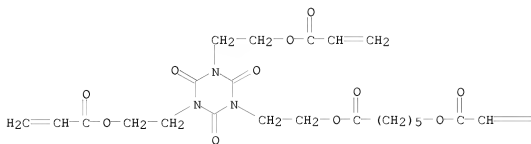
*** STRUCTURE DIAGRAM IS NOT AVAILABLE ***

CM 2

CRN 106556-00-7

CMF C24 H31 N3 O11

PAGE 1-A



PAGE 1-B

$=\text{CH}_2$

CM 3

CRN 108-30-5

CMF C4 H4 O3

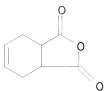


CM 4

CRN 85-43-8

CMF C8 H8 O3

10/585699



CM 5

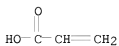
CRN 195888-20-1

CMF (C16 H18 O2 . C7 H8 O . C3 H5 Cl O)x . x C3 H4 O2

CM 6

CRN 79-10-7

CMF C3 H4 O2



CM 7

CRN 195812-12-5

CMF (C16 H18 O2 . C7 H8 O . C3 H5 Cl O)x

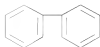
CCI PMS

CM 8

CRN 41376-21-0

CMF C16 H18 O2

CCI IDS



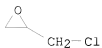
2 [D1-CH2-OMe]

CM 9

CRN 106-89-8

CMF C3 H5 Cl O

10/585699



CM 10

CRN 95-48-7

CMF C7 H8 O



CM 11

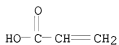
CRN 195888-18-7

CMF (C16 H18 O2 . C6 H6 O . C3 H5 Cl O)x . x C3 H4 O2

CM 12

CRN 79-10-7

CMF C3 H4 O2



CM 13

CRN 195812-11-4

CMF (C16 H18 O2 . C6 H6 O . C3 H5 Cl O)x

CCI PMS

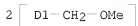
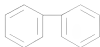
CM 14

CRN 41376-21-0

CMF C16 H18 O2

CCI IDS

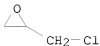
10/585699



CM 15
CRN 108-95-2
CMF C6 H6 O



CM 16
CRN 106-89-8
CMF C3 H5 Cl O



1 REFERENCES IN FILE CA (1907 TO DATE)
1 REFERENCES IN FILE CAPLUS (1907 TO DATE)

=> log y

COST IN U.S. DOLLARS	SINCE FILE	TOTAL
	ENTRY	SESSION
FULL ESTIMATED COST	16.43	23.27
DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)	SINCE FILE	TOTAL
	ENTRY	SESSION
CA SUBSCRIBER PRICE	0.00	-0.82

STN INTERNATIONAL LOGOFF AT 12:46:29 ON 22 FEB 2009

Connecting via Winsock to STN

Welcome to STN International! Enter x:x

LOGINID:sssptaul56cxh

PASSWORD:

TERMINAL (ENTER 1, 2, 3, OR ?):2

* * * * * Welcome to STN International * * * * *

NEWS	1		Web Page for STN Seminar Schedule - N. America
NEWS	2	NOV 21	CAS patent coverage to include exemplified prophetic substances identified in English-, French-, German-, and Japanese-language basic patents from 2004-present
NEWS	3	NOV 26	MARPAT enhanced with FSORT command
NEWS	4	NOV 26	CHEMSAFE now available on STN Easy
NEWS	5	NOV 26	Two new SET commands increase convenience of STN searching
NEWS	6	DEC 01	ChemPort single article sales feature unavailable
NEWS	7	DEC 12	GBFULL now offers single source for full-text coverage of complete UK patent families
NEWS	8	DEC 17	Fifty-one pharmaceutical ingredients added to PS
NEWS	9	JAN 06	The retention policy for unread STNmail messages will change in 2009 for STN-Columbus and STN-Tokyo
NEWS	10	JAN 07	WPIDS, WPINDEX, and WPIX enhanced Japanese Patent Classification Data
NEWS	11	FEB 02	Simultaneous left and right truncation (SLART) added for CERAB, COMPUAB, ELCOM, and SOLIDSTATE
NEWS	12	FEB 02	GENBANK enhanced with SET PLURALS and SET SPELLING
NEWS	13	FEB 06	Patent sequence location (PSL) data added to USGENE
NEWS	14	FEB 10	COMPENDEX reloaded and enhanced
NEWS	15	FEB 11	WTEXTILES reloaded and enhanced
NEWS	16	FEB 19	New patent-examiner citations in 300,000 CA/CAplus patent records provide insights into related prior art
NEWS	17	FEB 19	Increase the precision of your patent queries -- use terms from the IPC Thesaurus, Version 2009.01
NEWS EXPRESS	JUNE 27 08	CURRENT WINDOWS VERSION IS V8.3,	
		AND CURRENT DISCOVER FILE IS DATED 23 JUNE 2008.	
NEWS HOURS	STN Operating Hours Plus Help Desk Availability		
NEWS LOGIN	Welcome Banner and News Items		
NEWS IPC8	For general information regarding STN implementation of IPC 8		

Enter NEWS followed by the item number or name to see news on that specific topic.

All use of STN is subject to the provisions of the STN Customer agreement. Please note that this agreement limits use to scientific research. Use for software development or design or implementation of commercial gateways or other similar uses is prohibited and may

10/585699

result in loss of user privileges and other penalties.

* * * * * STN Columbus * * * * *

FILE 'HOME' ENTERED AT 15:37:47 ON 22 FEB 2009

=> file caplus

COST IN U.S. DOLLARS

SINCE FILE

TOTAL

ENTRY

SESSION

FULL ESTIMATED COST

0.22

0.22

FILE 'CAPLUS' ENTERED AT 15:37:56 ON 22 FEB 2009

USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.

PLEASE SEE "HELP USAGETERMS" FOR DETAILS.

COPYRIGHT (C) 2009 AMERICAN CHEMICAL SOCIETY (ACS)

Copyright of the articles to which records in this database refer is held by the publishers listed in the PUBLISHER (PB) field (available for records published or updated in Chemical Abstracts after December 26, 1996), unless otherwise indicated in the original publications. The CA Lexicon is the copyrighted intellectual property of the American Chemical Society and is provided to assist you in searching databases on STN. Any dissemination, distribution, copying, or storing of this information, without the prior written consent of CAS, is strictly prohibited.

FILE COVERS 1907 - 22 Feb 2009 VOL 150 ISS 9

FILE LAST UPDATED: 20 Feb 2009 (20090220/ED)

Caplus now includes complete International Patent Classification (IPC) reclassification data for the third quarter of 2008.

CAS Information Use Policies apply and are available at:

<http://www.cas.org/legal/infopolicy.html>

This file contains CAS Registry Numbers for easy and accurate substance identification.

=> s jp11140144/pn

L1 1 JP11140144/PN

=> d all

L1 ANSWER 1 OF 1 CAPLUS COPYRIGHT 2009 ACS on STN

AN 1999:331367 CAPLUS

DN 131:26725

ED Entered STN: 28 May 1999

TI Epoxy resin (meth)acrylate compositions, their cured products, and printed

circuit boards therewith

IN Yokoshima, Minoru; Ohkubo, Tetsuo; Sasahara, Kazunori

PA Nippon Kayaku Co., Ltd., Japan

SO Jpn. Kokai Tokkyo Koho, 8 pp.

10/585699

CODEN: JKXXAF
 DT Patent
 LA Japanese
 IC ICM C08F290-06
 ICS C08F020-30; C08F299-02; C08G059-14; C08G059-17; G03F007-027;
 G03F007-038; H05K003-18; H05K003-28
 CC 76-14 (Electric Phenomena)
 Section cross-reference(s): 38, 74

FAN.CNT 1

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	JP 11140144	A	19990525	JP 1997-316649	19971104

<--

PRAI JP 1997-316649 19971104

CLASS

PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
JP 11140144	ICM	C08F290-06
	ICS	C08F020-30; C08F299-02; C08G059-14; C08G059-17; G03F007-027; G03F007-038; H05K003-18; H05K003-28
	IPCI	C08F0290-06 [ICM,6]; C08F0020-30 [ICS,6]; C08F0299-02 [ICS,6]; C08G0059-14 [ICS,6]; C08G0059-17 [ICS,6]; G03F0007-027 [ICS,6]; G03F0007-038 [ICS,6];

H05K0003-18

[ICS,6]; H05K0003-28 [ICS,6]
 IPCR C08F0020-00 [I,C*]; C08F0020-30 [I,A]; C08F0290-00
 [I,C*]; C08F0290-06 [I,A]; C08F0299-00 [I,C*];
 C08F0299-02 [I,A]; C08G0059-00 [I,C*]; C08G0059-14
 [I,A]; C08G0059-17 [I,A]; G03F0007-027 [I,A];
 G03F0007-027 [I,C*]; G03F0007-038 [I,A]; G03F0007-038
 [I,C*]; H05K0003-18 [I,A]; H05K0003-18 [I,C*];
 H05K0003-28 [I,A]; H05K0003-28 [I,C*]

AB Claimed compns., showing excellent heat, solvent, and solder resistance
 and useful for permanent resists, comprise (A) epoxy resin
 (meth)acrylates

prepared from GC6H4(CH2Q2CH2C6H3G)nCH2Q2C6H4G (I; G = glycidioxy; Q =
 phenylene; n ≥ 0) and unsatd. monocarboxylic acids and (B)
 dilutants. Also claimed are compns. comprising (A') carboxy-containing

epoxy

resin (meth)acrylates prepared from A and polybasic acid anhydrides and
 (B).

Thus, a composition of 10:10 (equiv) NC 3000P (I) acrylate 154, propylene
 glycol monomethyl ether acetate 20, Kayarad DPFA (dipentaerythritol
 acrylate) 5, EOCN 104S (cresol novolak) 20, benzyl di-Me ketal 3, Aerosil
 380 (SiO2) 3, 2,4-diethylthioxanthone 0.5, melamine 3, dicyandiamide 2,
 and SiO2 35 parts was applied on a laminated board, exposed via a
 photomask, developed with an aqueous Na2CO3 solution, exposed with UV,
 annealed

at 150°, and immersed in an electroless Cu plating solution to give a
 printed circuit board showing excellent pattern resolution, good solder
 resistance (JIS C 6481), and no blistering nor peeling by 20-min

immersion

in Me2CO.

ST epoxy resin acrylate printed circuit resist; permanent resist
 developability epoxy resin acrylate; hydrophthalic anhydride epoxy

10/585699

acrylate permanent resist
IT Epoxy resins, uses
RL: DEV (Device component use); PNU (Preparation, unclassified); PREP (Preparation); USES (Uses)
(acrylic; epoxy resin (meth)acrylates with biphenylene structure for permanent resists with good solder and heat resistance)
IT Heat-resistant materials
Heat-resistant materials
(chemical resistant; epoxy resin (meth)acrylates with biphenylene structure for permanent resists with good solder and heat resistance)
IT Photoimaging materials
Photoresists
Printed circuit boards
(epoxy resin (meth)acrylates with biphenylene structure for permanent resists with good solder and heat resistance)
IT Phenolic resins, uses
RL: RCT (Reactant); TEM (Technical or engineered material use); RACT (Reactant or reagent); USES (Uses)
(epoxy, novolak; epoxy resin (meth)acrylates with biphenylene structure for permanent resists with good solder and heat resistance)
IT Chemically resistant materials
Chemically resistant materials
(heat-resistant; epoxy resin (meth)acrylates with biphenylene structure for permanent resists with good solder and heat resistance)
IT Epoxy resins, uses
RL: RCT (Reactant); TEM (Technical or engineered material use); RACT (Reactant or reagent); USES (Uses)
(phenolic, novolak; epoxy resin (meth)acrylates with biphenylene structure for permanent resists with good solder and heat resistance)
IT 84540-57-8, Propylene glycol monomethyl ether acetate
RL: TEM (Technical or engineered material use); USES (Uses)
(dilutants; epoxy resin (meth)acrylates with biphenylene structure for permanent resists with good solder and heat resistance)
IT 226083-26-7P, NC 3000P acrylate polymer with tetrahydrophthalic anhydride
RL: PNU (Preparation, unclassified); RCT (Reactant); TEM (Technical or engineered material use); PREP (Preparation); RACT (Reactant or reagent); USES (Uses)
(epoxy resin (meth)acrylates with biphenylene structure for permanent resists with good solder and heat resistance)
IT 77641-99-7, Kayarad DPHA 85305-70-0, EOCN 104S
RL: RCT (Reactant); TEM (Technical or engineered material use); RACT (Reactant or reagent); USES (Uses)
(epoxy resin (meth)acrylates with biphenylene structure for permanent resists with good solder and heat resistance)

=> FIL REGISTRY

COST IN U.S. DOLLARS	SINCE FILE	TOTAL
FULL ESTIMATED COST	ENTRY	SESSION
	6.12	6.34
DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)	SINCE FILE	TOTAL

10/585699

CA SUBSCRIBER PRICE

ENTRY SESSION
-0.82 -0.82

FILE 'REGISTRY' ENTERED AT 15:38:40 ON 22 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 American Chemical Society (ACS)

Property values tagged with IC are from the ZIC/VINITI data file
provided by InfoChem.

STRUCTURE FILE UPDATES: 20 FEB 2009 HIGHEST RN 1109311-46-7
DICTIONARY FILE UPDATES: 20 FEB 2009 HIGHEST RN 1109311-46-7

New CAS Information Use Policies, enter HELP USAGETERMS for details.

TSCA INFORMATION NOW CURRENT THROUGH January 9, 2009.

Please note that search-term pricing does apply when
conducting SmartSELECT searches.

REGISTRY includes numerically searchable data for experimental and
predicted properties as well as tags indicating availability of
experimental property data in the original document. For information
on property searching in REGISTRY, refer to:

<http://www.cas.org/support/stngen/stndoc/properties.html>

=> S 226083-26-7/RN

L2 1 226083-26-7/RN

=> SET NOTICE 1 DISPLAY

NOTICE SET TO 1 U.S. DOLLAR FOR DISPLAY COMMAND
SET COMMAND COMPLETED

=> D L2 SQIDE 1-

YOU HAVE REQUESTED DATA FROM 1 ANSWERS - CONTINUE? Y/(N):y
THE ESTIMATED COST FOR THIS REQUEST IS 6.85 U.S. DOLLARS
DO YOU WANT TO CONTINUE WITH THIS REQUEST? (Y)/N:y

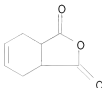
L2 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 226083-26-7 REGISTRY
CN 1,3-Isobenzofurandione, 3a,4,7,7a-tetrahydro-, polymer with NC 3000P
 2-propenoate (9CI) (CA INDEX NAME)
OTHER CA INDEX NAMES:
CN NC 3000P, 2-propenoate, polymer with
 3a,4,7,7a-tetrahydro-1,3-isobenzofurandione (9CI)
OTHER NAMES:
CN NC 3000P acrylate polymer with tetrahydrophthalic anhydride
MF (C8 H8 O3 . C3 H4 O2 . x Unspecified)x
CI PMS
PCT Manual component, Polyacrylic, Polyether

10/585699

SR CA
LC STN Files: CA, CAPLUS
DT.CA Caplus document type: Patent
RL.P Roles from patents: PREP (Preparation); RACT (Reactant or reagent);
USES (Uses)

CM 1

CRN 85-43-8
CMF C8 H8 O3



CM 2

CRN 226083-25-6
CMF C3 H4 O2 . x Unspecified

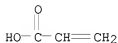
CM 3

CRN 225919-17-5
CMF Unspecified
CCI PMS, MAN

*** STRUCTURE DIAGRAM IS NOT AVAILABLE ***

CM 4

CRN 79-10-7
CMF C3 H4 O2



2 REFERENCES IN FILE CA (1907 TO DATE)
2 REFERENCES IN FILE CAPLUS (1907 TO DATE)

=> SET NOTICE LOGIN DISPLAY

NOTICE SET TO OFF FOR DISPLAY COMMAND
SET COMMAND COMPLETED

=>

10/585699

```
=> log y
COST IN U.S. DOLLARS                SINCE FILE      TOTAL
                                     ENTRY      SESSION
FULL ESTIMATED COST                2.53      8.87

DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)  SINCE FILE      TOTAL
                                               ENTRY      SESSION
CA SUBSCRIBER PRICE                  0.00     -0.82

STN INTERNATIONAL LOGOFF AT 15:39:00 ON 22 FEB 2009
```

Connecting via Winsock to STN

Welcome to STN International! Enter x:x

LOGINID:sssptaul56cxh

PASSWORD:

TERMINAL (ENTER 1, 2, 3, OR ?):2

* * * * * Welcome to STN International * * * * *

```
NEWS 1      Web Page for STN Seminar Schedule - N. America
NEWS 2 NOV 21 CAS patent coverage to include exemplified prophetic
              substances identified in English-, French-, German-,
              and Japanese-language basic patents from 2004-present
NEWS 3 NOV 26 MARPAT enhanced with FSORT command
NEWS 4 NOV 26 CHEMSAFE now available on STN Easy
NEWS 5 NOV 26 Two new SET commands increase convenience of STN
              searching
NEWS 6 DEC 01 ChemPort single article sales feature unavailable
NEWS 7 DEC 12 GBFULL now offers single source for full-text
              coverage of complete UK patent families
NEWS 8 DEC 17 Fifty-one pharmaceutical ingredients added to PS
NEWS 9 JAN 06 The retention policy for unread STNmail messages
              will change in 2009 for STN-Columbus and STN-Tokyo
NEWS 10 JAN 07 WPIDS, WPINDEX, and WPIX enhanced Japanese Patent
              Classification Data
NEWS 11 FEB 02 Simultaneous left and right truncation (SLART) added
              for CERAB, COMPUAB, ELCOM, and SOLIDSTATE
NEWS 12 FEB 02 GENBANK enhanced with SET PLURALS and SET SPELLING
NEWS 13 FEB 06 Patent sequence location (PSL) data added to USGENE
NEWS 14 FEB 10 COMPENDEX reloaded and enhanced
NEWS 15 FEB 11 WTEXTILES reloaded and enhanced
NEWS 16 FEB 19 New patent-examiner citations in 300,000 CA/CAplus
              patent records provide insights into related prior
              art
NEWS 17 FEB 19 Increase the precision of your patent queries -- use
```

terms from the IPC Thesaurus, Version 2009.01

NEWS EXPRESS JUNE 27 08 CURRENT WINDOWS VERSION IS V8.3,
AND CURRENT DISCOVER FILE IS DATED 23 JUNE 2008.

NEWS HOURS STN Operating Hours Plus Help Desk Availability
NEWS LOGIN Welcome Banner and News Items
NEWS IPC8 For general information regarding STN implementation of IPC 8

Enter NEWS followed by the item number or name to see news on that specific topic.

All use of STN is subject to the provisions of the STN Customer agreement. Please note that this agreement limits use to scientific research. Use for software development or design or implementation of commercial gateways or other similar uses is prohibited and may result in loss of user privileges and other penalties.

* * * * * STN Columbus * * * * *

FILE 'HOME' ENTERED AT 16:30:54 ON 22 FEB 2009

=> file caplus

COST IN U.S. DOLLARS	SINCE FILE ENTRY	TOTAL SESSION
FULL ESTIMATED COST	0.22	0.22

FILE 'CAPLUS' ENTERED AT 16:31:09 ON 22 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 AMERICAN CHEMICAL SOCIETY (ACS)

Copyright of the articles to which records in this database refer is held by the publishers listed in the PUBLISHER (PB) field (available for records published or updated in Chemical Abstracts after December 26, 1996), unless otherwise indicated in the original publications. The CA Lexicon is the copyrighted intellectual property of the American Chemical Society and is provided to assist you in searching databases on STN. Any dissemination, distribution, copying, or storing of this information, without the prior written consent of CAS, is strictly prohibited.

FILE COVERS 1907 - 22 Feb 2009 VOL 150 ISS 9
FILE LAST UPDATED: 20 Feb 2009 (20090220/ED)

Caplus now includes complete International Patent Classification (IPC) reclassification data for the third quarter of 2008.

CAS Information Use Policies apply and are available at:

<http://www.cas.org/legal/infopolicy.html>

This file contains CAS Registry Numbers for easy and accurate substance identification.

10/585699

=> s jp2002128865
L1 0 JP2002128865

=> s jp2002128865/pn
L2 1 JP2002128865/PN

=> d all

L2 ANSWER 1 OF 1 CAPLUS COPYRIGHT 2009 ACS on STN
AN 2002:347414 CAPLUS
DN 136:361823
ED Entered STN: 09 May 2002
TI Photoresist compositions with excellent alkali developability
IN Otani, Kazuo; Saito, Takeshi
PA Showa Highpolymer Co., Ltd., Japan
SO Jpn. Kokai Tokkyo Koho, 14 pp.
CODEN: JKXXAF
DT Patent
LA Japanese
IC ICM C08G059-42
ICS G03F007-027; H05K003-28; H05K003-46
CC 74-5 (Radiation Chemistry, Photochemistry, and Photographic and Other
Reprographic Processes)
Section cross-reference(s): 38, 76

FAN.CNT 1
PATENT NO. KIND DATE APPLICATION NO. DATE

PI JP 2002128865 A 20020509 JP 2000-331658 20001031

<--
PRAI JP 2000-331658 20001031

CLASS
PATENT NO. CLASS PATENT FAMILY CLASSIFICATION CODES

JP 2002128865 ICM C08G059-42
ICS G03F007-027; H05K003-28; H05K003-46
IPCI C08G0059-42 [ICM,7]; C08G0059-00 [ICM,7,C*];
G03F0007-027 [ICS,7]; H05K0003-28 [ICS,7]; H05K0003-46
[ICS,7]
IPCR G03F0007-027 [I,C*]; G03F0007-027 [I,A]; C08G0059-00
[I,C*]; C08G0059-42 [I,A]; H05K0003-28 [I,C*];
H05K0003-28 [I,A]; H05K0003-46 [I,C*]; H05K0003-46
[I,A]

AB The compns., useful for solder resists for printed circuit boards,
contain
curable polymers (A) prepared by reaction of phenolic resins, compds.
having
radically polymerizable unsatd. groups and epoxy groups, and compds.
having alc. OH groups and further reaction of the products with saturated
and/or unsatd. polybasic acid anhydrides, polymers (B) prepared by
polymerization
of radically polymerizable unsatd. compds. and reaction (optional) of the
resulting polymers with saturated and/or unsatd. polybasic acid
anhydrides,
epoxy resins (C), photopolymn. initiators (D), and polymerizable unsatd.

- comps. and/or solvents. Their cured products show good adhesion to substrates, flexibility, and solder heat resistance.
- ST photoresist phenolic resin modification alkali development; solder photoresist flexibility printed circuit board; curing solder resist ink heat resistance
- IT Printed circuit boards
(photoresist compns. with good alkali developability for printed circuit boards)
- IT Epoxy resins, uses
RL: TEM (Technical or engineered material use); USES (Uses)
(photoresist compns. with good alkali developability for printed circuit boards)
- IT Solder resists
(photoresists; photoresist compns. with good alkali developability for printed circuit boards)
- IT Phenolic resins, preparation
RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)
(reaction products with glycidyl methacrylate, glycidol, and tetrahydrophthalic anhydride; photoresist compns. with good alkali developability for printed circuit boards)
- IT Photoresists
(solder; photoresist compns. with good alkali developability for printed circuit boards)
- IT 15625-89-5, Light Acrylate TMP-A
RL: TEM (Technical or engineered material use); USES (Uses)
(diluent; photoresist compns. with good alkali developability for printed circuit boards)
- IT 85-43-8DP, Tetrahydrophthalic anhydride, reaction products with phenolic resins 106-91-2DP, Glycidyl methacrylate, reaction products with phenolic resin 556-52-5DP, Glycidol, reaction products with phenolic resin 25053-96-7DP, Shonol CRG 951, reaction products with glycidyl methacrylate, glycidol, and tetrahydrophthalic anhydride 54140-67-9DP, Denacol EX 145, reaction products with phenolic resin 88528-24-9P, 2-Ethylhexyl methacrylate-methacrylic acid-styrene copolymer ester with glycidyl methacrylate 180980-07-8P, Butyl methacrylate-glycidyl methacrylate-styrene copolymer acrylate 421557-24-6P, Butyl methacrylate-2-hydroxyethyl methacrylate-styrene copolymer ester with tetrahydrophthalic anhydride 421557-25-7P, 2-Ethylhexyl acrylate-glycidyl methacrylate-styrene copolymer ester with acrylic acid and tetrahydrophthalic anhydride 421557-26-8P, Butyl acrylate-2-hydroxyethyl methacrylate-styrene copolymer, carbamate with isocyanatoethyl methacrylate, ester with tetrahydrophthalic anhydride
RL: IMF (Industrial manufacture); TEM (Technical or engineered material use); PREP (Preparation); USES (Uses)
(photoresist compns. with good alkali developability for printed circuit boards)
- IT 28825-96-9, Tetric S
RL: TEM (Technical or engineered material use); USES (Uses)
(photoresist compns. with good alkali developability for printed circuit boards)

=> FIL REGISTRY

10/585699

COST IN U.S. DOLLARS	SINCE FILE	TOTAL
FULL ESTIMATED COST	ENTRY	SESSION
	8.86	9.08
DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)	SINCE FILE	TOTAL
CA SUBSCRIBER PRICE	ENTRY	SESSION
	-0.82	-0.82

FILE 'REGISTRY' ENTERED AT 16:32:03 ON 22 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 American Chemical Society (ACS)

Property values tagged with IC are from the ZIC/VINITI data file
provided by InfoChem.

STRUCTURE FILE UPDATES: 20 FEB 2009 HIGHEST RN 1109311-46-7
DICTIONARY FILE UPDATES: 20 FEB 2009 HIGHEST RN 1109311-46-7

New CAS Information Use Policies, enter HELP USAGETERMS for details.

TSCA INFORMATION NOW CURRENT THROUGH January 9, 2009.

Please note that search-term pricing does apply when
conducting SmartSELECT searches.

REGISTRY includes numerically searchable data for experimental and
predicted properties as well as tags indicating availability of
experimental property data in the original document. For information
on property searching in REGISTRY, refer to:

<http://www.cas.org/support/stngen/stdoc/properties.html>

=> S 28825-96-9/RN

L3 1 28825-96-9/RN

=> SET NOTICE 1 DISPLAY

NOTICE SET TO 1 U.S. DOLLAR FOR DISPLAY COMMAND
SET COMMAND COMPLETED

=> D L3 SQIDE 1-

YOU HAVE REQUESTED DATA FROM 1 ANSWERS - CONTINUE? Y/(N):y
THE ESTIMATED COST FOR THIS REQUEST IS 6.85 U.S. DOLLARS
DO YOU WANT TO CONTINUE WITH THIS REQUEST? (Y)/N:y

L3 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 28825-96-9 REGISTRY
CN 1,3,5-Triazine-2,4,6(1H,3H,5H)-trione, 1,3,5-tris(2-oxiranylmethyl)-,
homopolymer (CA INDEX NAME)
OTHER CA INDEX NAMES:
CN 1,3,5-Triazine-2,4,6(1H,3H,5H)-trione, 1,3,5-tris(oxiranylmethyl)-,
homopolymer (9CI)

CN s-Triazine-2,4,6(1H,3H,5H)-trione, 1,3,5-tris(2,3-epoxypropyl)-, polymers (8CI)

OTHER NAMES:

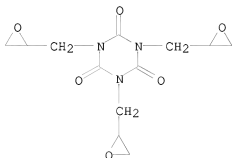
CN Araldite 710
 CN Araldite 813
 CN Araldite PT 810
 CN Araldite PT 816
 CN Araldite TGIC
 CN Epikote RXE 15
 CN ETs
 CN ETs (cyanuric acid derivative)
 CN Glycidyl isocyanurate polymer
 CN Metallon E 5010
 CN Poly(glycidyl isocyanurate)
 CN PP 9210D
 CN PPT 12544D
 CN PT 710
 CN PT 810
 CN T 1005
 CN T 810
 CN T 810 (hardener)
 CN TEPIC
 CN TEPIC-G
 CN TEPIC-H
 CN TEPIC-L
 CN TEPIC-P
 CN TEPIC-S
 CN TEPIC-SP
 CN TGI X
 CN TGIC
 CN Triglycidyl isocyanurate homopolymer
 CN Triglycidyl isocyanurate polymer
 CN Vestagon BF 1430
 CN XB 2615
 DR 919110-41-1, 919110-70-6, 521264-86-8, 57608-83-0, 97397-21-2,
 94699-45-3,
 84683-95-4
 MF (C12 H15 N3 O6)x
 CI PMS, COM
 PCT Epoxy resin, Polyisocyanurate
 LC STN Files: AGRICOLA, BIOSIS, CA, CAPLUS, CIN, IFICDB, IFIPAT, IFIUDB,
 PIRA, PROMT, TOXCENTER, USPAT2, USPATFULL, USPATOLD
 DT.CA Caplus document type: Conference; Journal; Patent; Report
 RL.P Roles from patents: PREP (Preparation); PROC (Process); PRP
 (Properties); RACT (Reactant or reagent); USES (Uses)
 RLD.P Roles for non-specific derivatives from patents: BIOL (Biological
 study); PREP (Preparation); PROC (Process); PRP (Properties); RACT
 (Reactant or reagent); USES (Uses)
 RL.NP Roles from non-patents: ANST (Analytical study); BIOL (Biological
 study); CMBI (Combinatorial study); OCCU (Occurrence); PREP
 (Preparation); PROC (Process); PRP (Properties); RACT (Reactant or
 reagent); USES (Uses)
 RLD.NP Roles for non-specific derivatives from non-patents: PREP
 (Preparation); PRP (Properties); USES (Uses)

10/585699

CM 1

CRN 2451-62-9

CMF C12 H15 N3 O6



PROPERTY DATA AVAILABLE IN THE 'PROP' FORMAT

438 REFERENCES IN FILE CA (1907 TO DATE)

64 REFERENCES TO NON-SPECIFIC DERIVATIVES IN FILE CA

438 REFERENCES IN FILE CAPLUS (1907 TO DATE)

=> SET NOTICE LOGIN DISPLAY

NOTICE SET TO OFF FOR DISPLAY COMMAND

SET COMMAND COMPLETED

=>

=> file reg

COST IN U.S. DOLLARS

SINCE FILE

TOTAL

ENTRY

SESSION

FULL ESTIMATED COST

2.53

11.61

DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)

SINCE FILE

TOTAL

ENTRY

SESSION

CA SUBSCRIBER PRICE

0.00

-0.82

FILE 'REGISTRY' ENTERED AT 16:32:43 ON 22 FEB 2009

USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.

PLEASE SEE "HELP USAGETERMS" FOR DETAILS.

COPYRIGHT (C) 2009 American Chemical Society (ACS)

Property values tagged with IC are from the ZIC/VINITI data file
provided by InfoChem.

STRUCTURE FILE UPDATES: 20 FEB 2009 HIGHEST RN 1109311-46-7

DICTIONARY FILE UPDATES: 20 FEB 2009 HIGHEST RN 1109311-46-7

New CAS Information Use Policies, enter HELP USAGETERMS for details.

TSCA INFORMATION NOW CURRENT THROUGH January 9, 2009.

Please note that search-term pricing does apply when conducting SmartSELECT searches.

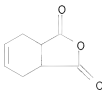
REGISTRY includes numerically searchable data for experimental and predicted properties as well as tags indicating availability of experimental property data in the original document. For information on property searching in REGISTRY, refer to:

<http://www.cas.org/support/stngen/stdoc/properties.html>

```
=> s 85-43-8; d; s 106-91-2; d ; s 556-52-5; d; s 25053-96-7; d; s
54140-67-9; d; s 88528-24-9; d ; s 180980-07-8;d; s 421557-24-6; d
L4      1 85-43-8
        (85-43-8/RN)
```

```
L4  ANSWER 1 OF 1  REGISTRY  COPYRIGHT 2009 ACS on STN
RN  85-43-8  REGISTRY
ED  Entered STN: 16 Nov 1984
CN  1,3-Isobenzofurandione, 3a,4,7,7a-tetrahydro- (CA INDEX NAME)
OTHER CA INDEX NAMES:
CN  4-Cyclohexene-1,2-dicarboxylic anhydride (8CI)
OTHER NAMES:
CN  A4-Tetrahydrophthalic anhydride
CN  1,2,3,6-Tetrahydrophthalic acid anhydride
CN  1,2,3,6-Tetrahydrophthalic anhydride
CN  3a,4,7,7a-Tetrahydro-1,3-isobenzofurandione
CN  4-Cyclohexene-1,2-dicarboxylic acid anhydride
CN  Cyclohexene-4,5-dicarboxylic anhydride
CN  Maleic anhydride-butadiene adduct
CN  NSC 82642
CN  Rikacid TH
CN  Rikacid THPA
CN  Tetrahydrophthalic acid anhydride
CN  Tetrahydrophthalic anhydride
DR  57570-09-9, 27936-16-9
MF  C8 H8 O3
CI  COM
LC  STN Files:  AGRICOLA, AQUIRE, BEILSTEIN*, BIOSIS, CA, CAPLUS, CASREACT,
      CHEMCATS, CHEMINFORMRX, CHEMLIST, CIN, CSChem, CSNB, EMBASE, GMELIN*,
      HSDB*, IFCDB, IFIPAT, IFIUDB, MSDS-OHS, PROMT, RTECS*, SPECINFO,
      TOXCENTER, ULIDAT, USPAT2, USPATFULL, USPATOLD
      (*File contains numerically searchable property data)
Other Sources:  DSL**, EINECS**, TSCA**
      (**Enter CHEMLIST File for up-to-date regulatory information)
```

10/585699



PROPERTY DATA AVAILABLE IN THE 'PROP' FORMAT

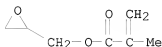
1719 REFERENCES IN FILE CA (1907 TO DATE)
737 REFERENCES TO NON-SPECIFIC DERIVATIVES IN FILE CA
1721 REFERENCES IN FILE CAPLUS (1907 TO DATE)

L5 1 106-91-2
(106-91-2/RN)

L5 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 106-91-2 REGISTRY
ED Entered STN: 16 Nov 1984
CN 2-Propenoic acid, 2-methyl-, 2-oxiranylmethyl ester (CA INDEX NAME)
OTHER CA INDEX NAMES:
CN 2-Propenoic acid, 2-methyl-, oxiranylmethyl ester (9CI)
CN Methacrylic acid, 2,3-epoxypropyl ester (6CI, 7CI, 8CI)
OTHER NAMES:
CN (±)-Glycidyl methacrylate
CN 2,3-Epoxypropyl methacrylate
CN 2-Methylacrylic acid oxiranylmethyl ester
CN 2-[(Methacryloyloxy)methyl]oxirane
CN 3-Methacryloyloxy-1,2-epoxypropane
CN Acryester G
CN Blemmer G
CN Blemmer GH-LC
CN Blemmer GMA
CN Blemmer GP
CN Blemmer GS
CN Epoxypropyl methacrylate
CN Glycidol methacrylate
CN Glycidyl α-methylacrylate
CN Glycidyl methacrylate
CN Light Ester G
CN Methacryloyloxymethyloxirane
CN NSC 24156
CN NSC 67195
CN Sartomer 379
CN SR 379
CN SY-Monomer G
DR 865699-83-8, 122785-80-2, 126872-19-3, 55279-88-4, 96778-02-8,
98104-93-9,

10/585699

89678-75-1, 117955-24-5, 169957-95-3, 201732-55-0, 203300-26-9,
210093-72-4
MF C7 H10 O3
CI COM
LC STN Files: AGRICOLA, ANABSTR, BEILSTEIN*, BIOSIS, BIOTECHNO, CA,
CAPLUS,
CASREACT, CBNB, CHEMCATS, CHEMINFORMRX, CHEMLIST, CIN, CSCHEM, CSNB,
DETERM*, EMBASE, ENCOMPLIT, ENCOMPLIT2, ENCOMPPAT, ENCOMPPAT2, HSDB*,
IFICDB, IFIPAT, IFIUDB, IPA, MEDLINE, MSDS-OHS, PIRA, PROMT, RTECS*,
SPECINFO, TOXCENTER, ULIDAT, USPAT2, USPATFULL, USPATOLD
(*File contains numerically searchable property data)
Other Sources: DSL**, EINECS**, TSCA**
(**Enter CHEMLIST File for up-to-date regulatory information)



****PROPERTY DATA AVAILABLE IN THE 'PROP' FORMAT****

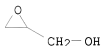
6026 REFERENCES IN FILE CA (1907 TO DATE)
2975 REFERENCES TO NON-SPECIFIC DERIVATIVES IN FILE CA
6034 REFERENCES IN FILE CAPLUS (1907 TO DATE)

L6 1 556-52-5
(556-52-5/RN)

L6 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 556-52-5 REGISTRY
ED Entered STN: 16 Nov 1984
CN 2-Oxiranemethanol (CA INDEX NAME)
OTHER CA INDEX NAMES:
CN 1-Propanol, 2,3-epoxy- (7CI, 8CI)
CN Glycidol (6CI)
CN Oxiranemethanol (9CI)
OTHER NAMES:
CN (±)-2,3-Epoxy-1-propanol
CN (±)-Glycidol
CN (RS)-Glycidol
CN 1,2-Epoxy-3-hydroxypropane
CN 1-Hydroxy-2,3-epoxypropane
CN 2,3-Epoxy-1-propanol
CN 2-(Hydroxymethyl)oxirane
CN 3-Hydroxy-1,2-epoxypropane
CN 3-Hydroxypropylene oxide
CN Allyl alcohol oxide
CN dl-Glycidol
CN Epihydrin alcohol

10/585699

CN Epiol OH
CN Glycide
CN Glycidyl alcohol
CN NSC 46096
CN Oxiran-2-ylmethanol
CN Oxiranylmethanol
CN Racemic glycidol
DR 98913-54-3, 61915-27-3
MF C3 H6 O2
CI COM
LC STN Files: AGRICOLA, ANABSTR, AQUIRE, BEILSTEIN*, BIOSIS, BIOTECHNO,
CA, CAPLUS, CASREACT, CHEMCATS, CHEMINFORMRX, CHEMLIST, CHEMSAFE, CIN,
CSCHEM, CSNB, DDFU, DETHERM*, DRUGU, EMBASE, ENCOMPLIT, ENCOMPLIT2,
ENCOMPPAT, ENCOMPPAT2, GMELIN*, HSDB*, IFICDB, IFIPAT, IFIUDB, IPA,
MEDLINE, MRCK*, MSDS-OHS, PIRA, PROMI, PS, RTECS*, SPECINFO, SYNTHLINE,
TOXCENTER, TULSA, ULIDAT, USPAT2, USPATFULL
(*File contains numerically searchable property data)
Other Sources: DSL**, EINECS**, TSCA**
(**Enter CHEMLIST File for up-to-date regulatory information)



PROPERTY DATA AVAILABLE IN THE 'PROP' FORMAT

3796 REFERENCES IN FILE CA (1907 TO DATE)
912 REFERENCES TO NON-SPECIFIC DERIVATIVES IN FILE CA
3805 REFERENCES IN FILE CAPLUS (1907 TO DATE)

L7 1 25053-96-7
(25053-96-7/RN)

L7 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 25053-96-7 REGISTRY
ED Entered STN: 16 Nov 1984
CN Formaldehyde, polymer with 2-methylphenol (CA INDEX NAME)
OTHER CA INDEX NAMES:
CN o-Cresol, polymer with formaldehyde (8CI)
CN Phenol, 2-methyl-, polymer with formaldehyde (9CI)
OTHER NAMES:
CN AG-O 2
CN AI-O 2
CN Bakelite EPR 680
CN BTB 28
CN CRG 951
CN CRJ 406

10/585699

CN D 5
CN D 5 (phenolic resin)
CN Durite SD 423A
CN Formaldehyde-2-methylphenol copolymer
CN Formaldehyde-o-cresol copolymer
CN Formaldehyde-o-cresol polymer
CN Formaldehyde-o-cresol resin
CN H 1
CN H 1 (phenolic resin)
CN KA 1165
CN KA 1174
CN KCE-F 2104
CN KP 7516
CN KP 7516 (phenolic resin)
CN KP 757G
CN o-Cresol-formaldehyde copolymer
CN o-Cresol-formaldehyde polymer
CN o-Cresol-paraformaldehyde copolymer
CN OCN
CN OCN 100
CN OCN 120
CN OCN 130
CN Phenolite KA 1174
CN Phenolite TD 2697
CN Plyophen KA 1162
CN Plyophen ZA 1165
CN Resitop PS 6909
CN Resitop PS 6937
CN SD 423A
CN Shonol CRG 951
CN SKO 1
CN Varcum 29-801
DR 126039-30-3, 125004-50-4, 63284-42-4, 102324-87-8, 99280-32-7,
192464-40-7, 374107-90-1, 467219-46-1, 682333-39-7
MF (C7 H8 O . C H2 O)x
CI PMS, COM
PCT Phenolic resin
LC STN Files: AGRICOLA, CA, CAPLUS, CHEMLIST, IFICDB, IFIPAT, IFIUDB,
MSDS-OHS, TOXCENTER, USPAT2, USPATFULL, USPATOLD
Other Sources: DSL**, TSCA**
(**Enter CHEMLIST File for up-to-date regulatory information)

CM 1

CRN 95-48-7
CMF C7 H8 O



10/585699

CM 2

CRN 50-00-0

CMF C H2 O

H₂C=O

PROPERTY DATA AVAILABLE IN THE 'PROP' FORMAT

1003 REFERENCES IN FILE CA (1907 TO DATE)

707 REFERENCES TO NON-SPECIFIC DERIVATIVES IN FILE CA

1003 REFERENCES IN FILE CAPLUS (1907 TO DATE)

L8 1 54140-67-9
(54140-67-9/RN)

L8 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN

RN 54140-67-9 REGISTRY

ED Entered STN: 16 Nov 1984

CN Poly(oxy-1,2-ethanediyl), α -(2-oxiranylmethyl)- ω -phenoxy- (CA INDEX NAME)

OTHER CA INDEX NAMES:

CN Poly(oxy-1,2-ethanediyl), α -(oxiranylmethyl)- ω -phenoxy- (9CI)

OTHER NAMES:

CN Denacol EX 145

CN EX 145

CN Polyethylene glycol phenyl glycidyl ether

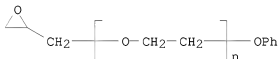
DR 705265-20-9, 125370-59-4, 134247-91-9, 114732-91-1, 111426-68-7,
153651-22-0, 143256-18-2

MF (C2 H4 O)_n C9 H10 O2

CI PMS, COM

PCT Polyether

LC STN Files: CA, CAPLUS, CHEMLIST, TOXCENTER, USPAT2, USPATFULL



68 REFERENCES IN FILE CA (1907 TO DATE)

21 REFERENCES TO NON-SPECIFIC DERIVATIVES IN FILE CA

68 REFERENCES IN FILE CAPLUS (1907 TO DATE)

L9 1 88528-24-9

10/585699

(88528-24-9/RN)

L9 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 88528-24-9 REGISTRY
ED Entered STN: 16 Nov 1984
CN 2-Propenoic acid, 2-methyl-, polymer with ethenylbenzene and 2-ethylhexyl
2-propenoate, 2-hydroxy-3-[(2-methyl-1-oxo-2-propenyl)oxy]propyl ester
(9CI) (CA INDEX NAME)

OTHER CA INDEX NAMES:

CN 2-Propenoic acid, 2-ethylhexyl ester, polymer with ethenylbenzene and
2-methyl-2-propenoic acid, 2-hydroxy-3-[(2-methyl-1-oxo-2-
propenyl)oxy]propyl ester (9CI)
CN Benzene, ethenyl-, polymer with 2-ethylhexyl 2-propenoate and
2-methyl-2-propenoic acid, 2-hydroxy-3-[(2-methyl-1-oxo-2-
propenyl)oxy]propyl ester (9CI)

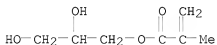
OTHER NAMES:

CN 2-Ethylhexyl methacrylate-methacrylic acid-styrene copolymer ester with
glycidyl methacrylate
MF (C11 H20 O2 . C8 H8 . C4 H6 O2)x . x C7 H12 O4
PCT Polyacrylic, Polystyrene
LC STN Files: CA, CAPLUS

CM 1

CRN 5919-74-4

CMF C7 H12 O4



CM 2

CRN 26636-08-8

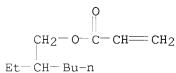
CMF (C11 H20 O2 . C8 H8 . C4 H6 O2)x

CCI PMS

CM 3

CRN 103-11-7

CMF C11 H20 O2



10/585699

CM 4

CRN 100-42-5

CMF C8 H8

$\text{H}_2\text{C}=\text{CH}-\text{Ph}$

CM 5

CRN 79-41-4

CMF C4 H6 O2



2 REFERENCES IN FILE CA (1907 TO DATE)

2 REFERENCES IN FILE CAPLUS (1907 TO DATE)

L10 1 180980-07-8
(180980-07-8/RN)

L10 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN

RN 180980-07-8 REGISTRY

ED Entered STN: 19 Sep 1996

CN 2-Propenoic acid, 2-methyl-, butyl ester, polymer with ethenylbenzene and oxiranylmethyl 2-methyl-2-propenoate, 2-propenoate (9CI) (CA INDEX NAME)

OTHER CA INDEX NAMES:

CN 2-Propenoic acid, 2-methyl-, oxiranylmethyl ester, polymer with butyl 2-methyl-2-propenoate and ethenylbenzene, 2-propenoate (9CI)

CN Benzene, ethenyl-, polymer with butyl 2-methyl-2-propenoate and oxiranylmethyl 2-methyl-2-propenoate, 2-propenoate (9CI)

OTHER NAMES:

CN Butyl methacrylate-glycidyl methacrylate-styrene copolymer acrylate

MF (C8 H14 O2 . C8 H8 . C7 H10 O3)x . x C3 H4 O2

CI COM

PCT Polyacrylic, Polystyrene

SR CA

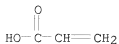
LC STN Files: CA, CAPLUS, USPATFULL

CM 1

CRN 79-10-7

CMF C3 H4 O2

10/585699



CM 2

CRN 55492-07-4

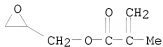
CMF (C8 H14 O2 . C8 H8 . C7 H10 O3)x

CCI PMS

CM 3

CRN 106-91-2

CMF C7 H10 O3



CM 4

CRN 100-42-5

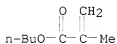
CMF C8 H8



CM 5

CRN 97-88-1

CMF C8 H14 O2



2 REFERENCES IN FILE CA (1907 TO DATE)

2 REFERENCES IN FILE CAPLUS (1907 TO DATE)

L11 1 421557-24-6
(421557-24-6/RN)

10/585699

L11 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 421557-24-6 REGISTRY
ED Entered STN: 24 May 2002
CN 2-Propenoic acid, 2-methyl-, butyl ester, polymer with ethenylbenzene and
2-hydroxyethyl 2-methyl-2-propenoate, hydrogen
4-cyclohexene-1,2-dicarboxylate (9CI) (CA INDEX NAME)

OTHER NAMES:

CN Butyl methacrylate-2-hydroxyethyl methacrylate-styrene copolymer ester
with tetrahydrophthalic anhydride
MF (C8 H14 O2 . C8 H8 . C6 H10 O3)x . x C8 H10 O4
PCT Polyacrylic, Polystyrene
SR CA
LC STN Files: CA, CAPLUS

CM 1

CRN 88-98-2
CMF C8 H10 O4

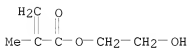


CM 2

CRN 31423-16-2
CMF (C8 H14 O2 . C8 H8 . C6 H10 O3)x
CCI PMS

CM 3

CRN 868-77-9
CMF C6 H10 O3



CM 4

CRN 100-42-5
CMF C8 H8

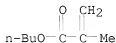


10/585699

CM 5

CRN 97-88-1

CMF C8 H14 O2



1 REFERENCES IN FILE CA (1907 TO DATE)

1 REFERENCES IN FILE CAPLUS (1907 TO DATE)

=> s 421557-25-7; d; s 421557-26-8; d

L12 1 421557-25-7

(421557-25-7/RN)

L12 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN

RN 421557-25-7 REGISTRY

ED Entered STN: 24 May 2002

CN 2-Propenoic acid, 2-methyl-, oxiranylmethyl ester, polymer with
ethenylbenzene and 2-ethylhexyl 2-propenoate, hydrogen
4-cyclohexene-1,2-dicarboxylate 2-propenoate (9CI) (CA INDEX NAME)

OTHER NAMES:

CN 2-Ethylhexyl acrylate-glycidyl methacrylate-styrene copolymer ester with
acrylic acid and tetrahydrophthalic anhydride

MF (C11 H20 O2 . C8 H8 . C7 H10 O3)x . x C8 H10 O4 . x C3 H4 O2

PCT Polyacrylic, Polystyrene

SR CA

LC STN Files: CA, CAPLUS

CM 1

CRN 88-98-2

CMF C8 H10 O4

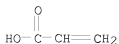


CM 2

CRN 79-10-7

CMF C3 H4 O2

10/585699



CM 3

CRN 30814-77-8

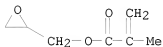
CMF (C11 H20 O2 , C8 H8 , C7 H10 O3)x

CCI FMS

CM 4

CRN 106-91-2

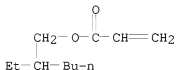
CMF C7 H10 O3



CM 5

CRN 103-11-7

CMF C11 H20 O2



CM 6

CRN 100-42-5

CMF C8 H8



1 REFERENCES IN FILE CA (1907 TO DATE)

1 REFERENCES IN FILE CAPLUS (1907 TO DATE)

L13

1 421557-26-8

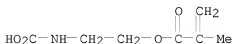
(421557-26-8/RN)

10/585699

L13 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 421557-26-8 REGISTRY
ED Entered STN: 24 May 2002
CN 2-Propenoic acid, 2-methyl-, 2-hydroxyethyl ester, polymer with butyl
2-propenoate and ethenylbenzene, hydrogen 4-cyclohexene-1,2-dicarboxylate
[2-[(2-methyl-1-oxo-2-propenyl)oxy]ethyl]carbamate (9CI) (CA INDEX NAME)
OTHER NAMES:
CN Butyl acrylate-2-hydroxyethyl methacrylate-styrene copolymer, carbamate
with isocyanatoethyl methacrylate, ester with tetrahydrophthalic
anhydride
MF C8 H10 O4 . x (C8 H8 . C7 H12 O2 . C6 H10 O3)x . x C7 H11 N O4
PCT Polyacrylic, Polystyrene
SR CA
LC STN Files: CA, CAPLUS

CM 1

CRN 96571-20-9
CMF C7 H11 N O4



CM 2

CRN 88-98-2
CMF C8 H10 O4



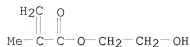
CM 3

CRN 26916-03-0
CMF (C8 H8 . C7 H12 O2 . C6 H10 O3)x
CCI PMS

CM 4

CRN 868-77-9
CMF C6 H10 O3

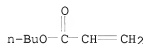
10/585699



CM 5

CRN 141-32-2

CMF C7 H12 O2



CM 6

CRN 100-42-5

CMF C8 H8



2 REFERENCES IN FILE CA (1907 TO DATE)

2 REFERENCES IN FILE CAPLUS (1907 TO DATE)

=> d his

(FILE 'HOME' ENTERED AT 16:30:54 ON 22 FEB 2009)

FILE 'CAPLUS' ENTERED AT 16:31:09 ON 22 FEB 2009

L1 0 S JP2002128865

L2 1 S JP2002128865/PN

FILE 'REGISTRY' ENTERED AT 16:32:03 ON 22 FEB 2009

L3 1 S 28825-96-9/RN

SET NOTICE 1 DISPLAY

SET NOTICE LOGIN DISPLAY

FILE 'REGISTRY' ENTERED AT 16:32:43 ON 22 FEB 2009

L4 1 S 85-43-8

L5 1 S 106-91-2

L6 1 S 556-52-5

L7 1 S 25053-96-7

L8 1 S 54140-67-9

L9 1 S 88528-24-9

L10 1 S 180980-07-8

L11 1 S 421557-24-6

L12 1 S 421557-25-7

10/585699

L13 1 S 421557-26-8

=> log y

COST IN U.S. DOLLARS	SINCE FILE ENTRY	TOTAL SESSION
FULL ESTIMATED COST	24.34	35.95
DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)	SINCE FILE ENTRY	TOTAL SESSION
CA SUBSCRIBER PRICE	0.00	-0.82

STN INTERNATIONAL LOGOFF AT 16:37:36 ON 22 FEB 2009

Connecting via Winsock to STN

Welcome to STN International! Enter x:x

LOGINID:sssptaul56cxh

PASSWORD:

TERMINAL (ENTER 1, 2, 3, OR ?):2

* * * * * Welcome to STN International * * * * *

NEWS 1 Web Page for STN Seminar Schedule - N. America
NEWS 2 NOV 21 CAS patent coverage to include exemplified prophetic substances identified in English-, French-, German-, and Japanese-language basic patents from 2004-present
NEWS 3 NOV 26 MARPAT enhanced with FSORT command
NEWS 4 NOV 26 CHEMSAFE now available on STN Easy
NEWS 5 NOV 26 Two new SET commands increase convenience of STN searching
NEWS 6 DEC 01 ChemPort single article sales feature unavailable
NEWS 7 DEC 12 GBFULL now offers single source for full-text coverage of complete UK patent families
NEWS 8 DEC 17 Fifty-one pharmaceutical ingredients added to PS
NEWS 9 JAN 06 The retention policy for unread STNmail messages will change in 2009 for STN-Columbus and STN-Tokyo
NEWS 10 JAN 07 WPIDS, WPINDEX, and WPIX enhanced Japanese Patent Classification Data
NEWS 11 FEB 02 Simultaneous left and right truncation (SLART) added for CERAB, COMPUAB, ELCOM, and SOLIDSTATE
NEWS 12 FEB 02 GENBANK enhanced with SET PLURALS and SET SPELLING
NEWS 13 FEB 06 Patent sequence location (PSL) data added to USGENE
NEWS 14 FEB 10 COMPEDEX reloaded and enhanced
NEWS 15 FEB 11 WTEXTILES reloaded and enhanced
NEWS 16 FEB 19 New patent-examiner citations in 300,000 CA/CAplus patent records provide insights into related prior art

10/585699

NEWS 17 FEB 19 Increase the precision of your patent queries -- use
terms from the IPC Thesaurus, Version 2009.01

NEWS EXPRESS JUNE 27 08 CURRENT WINDOWS VERSION IS V8.3,
AND CURRENT DISCOVER FILE IS DATED 23 JUNE 2008.

NEWS HOURS STN Operating Hours Plus Help Desk Availability
NEWS LOGIN Welcome Banner and News Items
NEWS IPC8 For general information regarding STN implementation of IPC 8

Enter NEWS followed by the item number or name to see news on that
specific topic.

All use of STN is subject to the provisions of the STN Customer
agreement. Please note that this agreement limits use to scientific
research. Use for software development or design or implementation
of commercial gateways or other similar uses is prohibited and may
result in loss of user privileges and other penalties.

* * * * * STN Columbus * * * * *

FILE 'HOME' ENTERED AT 17:13:41 ON 22 FEB 2009

=> file caplus		
COST IN U.S. DOLLARS	SINCE FILE	TOTAL
	ENTRY	SESSION
FULL ESTIMATED COST	0.22	0.22

FILE 'CAPLUS' ENTERED AT 17:13:51 ON 22 FEB 2009
USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
COPYRIGHT (C) 2009 AMERICAN CHEMICAL SOCIETY (ACS)

Copyright of the articles to which records in this database refer is
held by the publishers listed in the PUBLISHER (PB) field (available
for records published or updated in Chemical Abstracts after December
26, 1996), unless otherwise indicated in the original publications.
The CA Lexicon is the copyrighted intellectual property of the
American Chemical Society and is provided to assist you in searching
databases on STN. Any dissemination, distribution, copying, or storing
of this information, without the prior written consent of CAS, is
strictly prohibited.

FILE COVERS 1907 - 22 Feb 2009 VOL 150 ISS 9
FILE LAST UPDATED: 20 Feb 2009 (20090220/ED)

Caplus now includes complete International Patent Classification (IPC)
reclassification data for the third quarter of 2008.

CAS Information Use Policies apply and are available at:

<http://www.cas.org/legal/infopolicy.html>

This file contains CAS Registry Numbers for easy and accurate

10/585699

substance identification.

=> s jp2003082067/pn

L1 1 JP2003082067/PN

=> d all

L1 ANSWER 1 OF 1 CAPLUS COPYRIGHT 2009 ACS on STN

AN 2003:216981 CAPLUS

DN 138:245611

ED Entered STN: 20 Mar 2003

TI Acrylic resin compositions for solder resists or interlayer dielectrics, their cured articles, and products with the cured layers

IN Koyanagi, Takao; Yokoshima, Minoru

PA Nippon Kayaku Co., Ltd., Japan

SO Jpn. Kokai Tokkyo Koho, 9 pp.

CODEN: JKXXAF

DT Patent

LA Japanese

IC ICM C08G059-62

ICS C08G059-24; H05K003-28

CC 74-5 (Radiation Chemistry, Photochemistry, and Photographic and Other Reprographic Processes)

Section cross-reference(s): 38

FAN.CNT 1

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	JP 2003082067	A	20030319	JP 2001-277588	20010913

<--

PRAI JP 2001-277588 20010913

CLASS

PATENT NO.	CLASS	PATENT FAMILY CLASSIFICATION CODES
JP 2003082067	ICM	C08G059-62
	ICS	C08G059-24; H05K003-28
	IPCI	C08G0059-62 [ICM,7]; C08G0059-24 [ICS,7]; C08G0059-00 [ICS,7,C*]; H05K0003-28 [ICS,7]
	IPCR	C08G0059-00 [I,C*]; C08G0059-62 [I,A]; C08G0059-24 [I,A]; H05K0003-28 [I,C*]; H05K0003-28 [I,A]

AB The resin compns. contain (A) oligomers prep'd by reacting (a) phenolic OH-containing compds. bearing biphenyl backbones and phenol backbones with (b) compds. bearing 1 epoxy group and 1 (meth)acrylate group, (B) (meth)acrylate compds. other than A, and as desired (C) epoxy resins and (D) photopolym. initiators. The compns. have good developability and give cured articles having good flexibility, solder resistance, and electroless plating resistance, and are useful for solder resists and interlayer dielects for printed circuit boards.

ST solder resist compn acrylic polymer; interlayer dielec acrylic polymer compn; printed circuit solder resist acrylic compn

IT Dielectric films

Solder resists

(acrylic resin compns. with good developability for solder resists or interlayer dielects.)

IT Printed circuit boards

(acrylic resin compns. with good developability for solder resists or interlayer dielects. for)

IT 71868-10-5, Irgacure 907 82799-44-8, Kayacure DETX-S
 RL: CAT (Catalyst use); USES (Uses)
 (acrylic resin compns. with good developability for solder resists or interlayer dielects.)

IT 106-89-8DP, Epichlorohydrin, ether with bisphenol F epoxy resin
 58421-55-9DP, glycidyl ether
 RL: IMF (Industrial manufacture); POF (Polymer in formulation); TEM
 (Technical or engineered material use); PREP (Preparation); USES (Uses)
 (acrylic resin compns. with good developability for solder resists or interlayer dielects.)

IT 77641-99-7, Kayarad DPHA 263363-71-9, Kayarad ZFR 1122
 RL: TEM (Technical or engineered material use); USES (Uses)
 (acrylic resin compns. with good developability for solder resists or interlayer dielects.)

IT 106-91-2DP, Glycidyl methacrylate, reaction products with Kayahard HBP
 497835-19-5DP, Kayahard HBP, reaction products with glycidyl methacrylate
 RL: IMF (Industrial manufacture); POF (Polymer in formulation); TEM
 (Technical or engineered material use); PREP (Preparation); USES (Uses)
 (oligomeric; acrylic resin compns. with good developability for solder resists or interlayer dielects.)

=> FIL REGISTRY

COST IN U.S. DOLLARS	SINCE FILE ENTRY	TOTAL SESSION
FULL ESTIMATED COST	6.12	6.34
DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)	SINCE FILE ENTRY	TOTAL SESSION
CA SUBSCRIBER PRICE	-0.82	-0.82

FILE 'REGISTRY' ENTERED AT 17:14:30 ON 22 FEB 2009
 USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT.
 PLEASE SEE "HELP USAGETERMS" FOR DETAILS.
 COPYRIGHT (C) 2009 American Chemical Society (ACS)

Property values tagged with IC are from the ZIC/VINITI data file provided by InfoChem.

STRUCTURE FILE UPDATES: 20 FEB 2009 HIGHEST RN 1109311-46-7
 DICTIONARY FILE UPDATES: 20 FEB 2009 HIGHEST RN 1109311-46-7

New CAS Information Use Policies, enter HELP USAGETERMS for details.

TSCA INFORMATION NOW CURRENT THROUGH January 9, 2009.

Please note that search-term pricing does apply when conducting SmartSELECT searches.

REGISTRY includes numerically searchable data for experimental and predicted properties as well as tags indicating availability of

10/585699

experimental property data in the original document. For information on property searching in REGISTRY, refer to:

<http://www.cas.org/support/stngen/stdoc/properties.html>

=> S 497835-19-5/RN

L2 1 497835-19-5/RN

=> SET NOTICE 1 DISPLAY

NOTICE SET TO 1 U.S. DOLLAR FOR DISPLAY COMMAND
SET COMMAND COMPLETED

=> D L2 SQIDE 1-

YOU HAVE REQUESTED DATA FROM 1 ANSWERS - CONTINUE? Y/(N):y
THE ESTIMATED COST FOR THIS REQUEST IS 6.85 U.S. DOLLARS
DO YOU WANT TO CONTINUE WITH THIS REQUEST? (Y)/N:y

L2 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 497835-19-5 REGISTRY
CN Kayahard HBPN (9CI) (CA INDEX NAME)
ENTE A biphenyl-containing phenolic resin (Nippon Kayaku Co., Ltd.)
MF Unspecified
CI PMS, MAN
PCT Manual registration
SR CA
LC STN Files: CA, CAPLUS
DT.CA Caplus document type: Patent
RLD.P Roles for non-specific derivatives from patents: PREP (Preparation);
PRP (Properties); USES (Uses)

*** STRUCTURE DIAGRAM IS NOT AVAILABLE ***
3 REFERENCES IN FILE CA (1907 TO DATE)
3 REFERENCES TO NON-SPECIFIC DERIVATIVES IN FILE CA
3 REFERENCES IN FILE CAPLUS (1907 TO DATE)

=> SET NOTICE LOGIN DISPLAY

NOTICE SET TO OFF FOR DISPLAY COMMAND
SET COMMAND COMPLETED

=>

=> d all 1-3

L2 ANSWER 1 OF 1 REGISTRY COPYRIGHT 2009 ACS on STN
RN 497835-19-5 REGISTRY
ED Entered STN: 11 Mar 2003
CN Kayahard HBPN (9CI) (CA INDEX NAME)
ENTE A biphenyl-containing phenolic resin (Nippon Kayaku Co., Ltd.)
MF Unspecified
CI PMS, MAN

10/585699

PCT Manual registration
SR CA
LC STN Files: CA, CAPLUS
DT.CA Caplus document type: Patent
RLD.P Roles for non-specific derivatives from patents: PREP (Preparation);
PRP (Properties); USES (Uses)

*** STRUCTURE DIAGRAM IS NOT AVAILABLE ***

3 REFERENCES IN FILE CA (1907 TO DATE)
3 REFERENCES TO NON-SPECIFIC DERIVATIVES IN FILE CA
3 REFERENCES IN FILE CAPLUS (1907 TO DATE)

REFERENCE 1

AN 138:245611 CA
TI Acrylic resin compositions for solder resists or interlayer dielectrics,
their cured articles, and products with the cured layers
IN Koyanagi, Takao; Yokoshima, Minoru
PA Nippon Kayaku Co., Ltd., Japan
SO Jpn. Kokai Tokkyo Koho, 9 pp.
CODEN: JKXXAF
DT Patent
LA Japanese
IC ICM C08G059-62
ICS C08G059-24; H05K003-28
CC 74-5 (Radiation Chemistry, Photochemistry, and Photographic and Other
Reprographic Processes)
Section cross-reference(s): 38

FAN.CNT 1

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	JP 2003082067	A	20030319	JP 2001-277588	20010913
PRAI	JP 2001-277588	20010913			
AB	The resin compns. contain (A) oligomers prepd by reacting (a) phenolic OH-containing compds. bearing biphenyl backbones and phenol backbones with (b) compds. bearing 1 epoxy group and 1 (meth)acrylate group, (B) (meth)acrylate compds. other than A, and as desired (C) epoxy resins and (D) photopolymn. initiators. The compns. have good developability and give cured articles having good flexibility, solder resistance, and electroless plating resistance, and are useful for solder resists and interlayer dielects for printed circuit boards.				
ST	solder resist compn acrylic polymer; interlayer dielec acrylic polymer compn; printed circuit solder resist acrylic compn				
IT	Dielectric films Solder resists (acrylic resin compns. with good developability for solder resists or interlayer dielects.)				
IT	Printed circuit boards (acrylic resin compns. with good developability for solder resists or interlayer dielects. for)				
IT	71868-10-5, Irgacure 907 82799-44-8, Kayacure DETX-S RL: CAT (Catalyst use); USES (Uses) (acrylic resin compns. with good developability for solder resists or interlayer dielects.)				

IT 106-89-8DP, Epichlorohydrin, ether with bisphenol F epoxy resin
58421-55-9DP, glycidyl ether
RL: IMF (Industrial manufacture); POF (Polymer in formulation); TEM
(Technical or engineered material use); PREP (Preparation); USES (Uses)
(acrylic resin compns. with good developability for solder resists or
interlayer dielects.)

IT 77641-99-7, Kayarad DPHA 263363-71-9, Kayarad ZFR 1122
RL: TEM (Technical or engineered material use); USES (Uses)
(acrylic resin compns. with good developability for solder resists or
interlayer dielects.)

IT 106-91-2DP, Glycidyl methacrylate, reaction products with Kayahard HBP
497835-19-5DP, Kayahard HBP, reaction products with glycidyl
methacrylate
RL: IMF (Industrial manufacture); POF (Polymer in formulation); TEM
(Technical or engineered material use); PREP (Preparation); USES (Uses)
(oligomeric; acrylic resin compns. with good developability for solder
resists or interlayer dielects.)

REFERENCE 2

AN 138:222372 CA
TI Resin composition for solder resists and interlayer dielects for printed
circuit boards and their and cured products
IN Koyanagi, Takao; Yokoshima, Minoru
PA Nippon Kayaku Co., Ltd., Japan
SO Jpn. Kokai Tokkyo Koho, 9 pp.
CODEN: JKXXAF

DT Patent
LA Japanese
IC ICM C08F020-10
ICS C08F002-44; C08F299-02; C08G059-62; G03F007-004; G03F007-027;
H05K003-18; H05K003-28; H05K003-46
CC 37-6 (Plastics Manufacture and Processing)
Section cross-reference(s): 38, 74

FAN.CNT 1

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
JP 2003082025	A	20030319	JP 2001-277555	20010913
JP 2001-277555		20010913		

AB The compns. comprise (A) phenolic OH-containing compds. having biphenyl
backbones and phenol backbones (e.g., Kayahard HBP), (B) (meth)acrylate
compds. [Kayarad DPHA (mixture of dipentaerythritol acrylate)] and (C)
epoxy
resins (e.g., bisphenol F-epichlorohydrin copolymer). The compns. have
good developability, flexibility, solder resistance, and electroless
plating resistance.

ST methacrylic polymer solder resist compn; hydroxy polybenzyl epoxy resin
interlayer dielec; printed circuit board solder resist interlayer
insulator

IT Epoxy resins, preparation
RL: IMF (Industrial manufacture); POF (Polymer in formulation); TEM
(Technical or engineered material use); PREP (Preparation); USES (Uses)
(acrylic, hydroxy-containing polybenzyl; resin composition for solder
resists
and interlayer dielects for printed circuit boards and their and cured

products)
 IT Polybenzyls
 RL: IMF (Industrial manufacture); POF (Polymer in formulation); TEM
 (Technical or engineered material use); PREP (Preparation); USES (Uses)
 (epoxy, hydroxy-containing, acrylic-; resin composition for solder
 resists and
 interlayer dielects for printed circuit boards and their and cured
 products)
 IT Epoxy resins, preparation
 RL: IMF (Industrial manufacture); POF (Polymer in formulation); TEM
 (Technical or engineered material use); PREP (Preparation); USES (Uses)
 (polybenzyl-, hydroxy-containing, acrylic-; resin composition for
 solder resists
 and interlayer dielects for printed circuit boards and their and cured
 products)
 IT Electric insulators
 Printed circuit boards
 Solder resists
 (resin composition for solder resists and interlayer dielects for
 printed
 circuit boards and their and cured products)
 IT 106-89-8DP, Epichlorohydrin, polymers with bisphenol F, acrylic compds.
 and hydroxy-containing polybenzyls 1333-16-0DP, Bisphenol F, polymers
 with
 epichlorohydrin, acrylic compds. and hydroxy-containing polybenzyls
 77641-99-7DP, Kayarad DPHA, polymers with epoxy resins and
 hydroxy-containing
 polybenzyls 217792-29-5DP, polymers with epoxy resins and acrylic
 compds. 263363-71-9DP, Kayarad ZFR 1122, polymers with epoxy resins and
 hydroxy-containing polybenzyls 497835-19-5DP, Kayahard HBPN, polymers
 with
 epoxy resins and acrylic compds.
 RL: IMF (Industrial manufacture); POF (Polymer in formulation); TEM
 (Technical or engineered material use); PREP (Preparation); USES (Uses)
 (resin composition for solder resists and interlayer dielects for
 printed
 circuit boards and their and cured products)

REFERENCE 3

AN 138:188701 CA
 TI Epoxy resin compositions for optical materials and their cured products
 IN Akatsuka, Yasumasa; Oshimi, Katsuhiko
 PA Nippon Kayaku Co., Ltd., Japan
 SO Jpn. Kokai Tokkyo Koho, 5 pp.
 CODEN: JKXXAF
 DT Patent
 LA Japanese
 IC ICM C08G059-20
 ICS C08G059-62; C08J005-18; G02B001-04; G02C007-02; C08L063-00
 CC 37-6 (Plastics Manufacture and Processing)
 Section cross-reference(s): 73
 FAN.CNT 1

PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
-----	----	-----	-----	-----

10/585699

PI JP 2003055437 A 20030226 JP 2001-244322 20010810
PRAI JP 2001-244322 20010810
AB The comps. comprise biphenyl epoxy resins GOC6H4(CH2C6H4C6H4CH2C6H3OG)nH
(I; G = glycidyl) and crosslinking agents. Thus, a composition
containing NC 3000S
(I) 28, Kayahard HBPB [HOC6H4(CH2C6H4C6H4CH2C6H3OH)nH] 24.2,
triphenylphosphine 0.28, and MEK 52.5 parts was applied on a PET film,
dried, and cured to give a film with Tg 161°, refractive index
1.655, and good flexibility.
ST biphenyl novolak epoxy resin flexible film optical
IT Crosslinking agents
Optical films
Plastic films
(epoxy resin comps. for optical materials)
IT Polybenzyls
RL: IMF (Industrial manufacture); PRP (Properties); TEM (Technical or
engineered material use); PREP (Preparation); USES (Uses)
(epoxy, hydroxy-containing; epoxy resin comps. for optical materials)
IT Phenolic resins, preparation
RL: IMF (Industrial manufacture); PRP (Properties); TEM (Technical or
engineered material use); PREP (Preparation); USES (Uses)
(epoxy; epoxy resin comps. for optical materials)
IT Epoxy resins, preparation
RL: IMF (Industrial manufacture); PRP (Properties); TEM (Technical or
engineered material use); PREP (Preparation); USES (Uses)
(phenolic; epoxy resin comps. for optical materials)
IT Epoxy resins, preparation
RL: IMF (Industrial manufacture); PRP (Properties); TEM (Technical or
engineered material use); PREP (Preparation); USES (Uses)
(polybenzyl-, hydroxy-containing; epoxy resin comps. for optical
materials)
IT 217792-29-5DP, reaction products with epoxy resins 450336-22-8DP, NC
3000S, reaction products with phenol resins 497835-19-5DP, Kayahard
HBPB
, reaction products with epoxy resins 497917-00-7DP, reaction products
with phenol resins
RL: IMF (Industrial manufacture); PRP (Properties); TEM (Technical or
engineered material use); PREP (Preparation); USES (Uses)
(epoxy resin comps. for optical materials)

=> d his

(FILE 'HOME' ENTERED AT 17:13:41 ON 22 FEB 2009)

FILE 'CAPLUS' ENTERED AT 17:13:51 ON 22 FEB 2009
L1 1 S JP2003082067/PN

FILE 'REGISTRY' ENTERED AT 17:14:30 ON 22 FEB 2009
L2 1 S 497835-19-5/RN
SET NOTICE 1 DISPLAY
SET NOTICE LOGIN DISPLAY

=> log y
COST IN U.S. DOLLARS SINCE FILE TOTAL

10/585699

FULL ESTIMATED COST	ENTRY 8.76	SESSION 15.10
DISCOUNT AMOUNTS (FOR QUALIFYING ACCOUNTS)	SINCE FILE ENTRY	TOTAL SESSION
CA SUBSCRIBER PRICE	-0.78	-1.60

STN INTERNATIONAL LOGOFF AT 17:16:14 ON 22 FEB 2009